1. S3C1840

DESCRIPTION

S3C1840, a 4-bit single-chip CMOS microcontroller, consists of the reliable SMCS-51 CPU core with on-chip ROM and RAM. Eight input pins and 11 output pins provide the flexibility for various I/O requirements. Auto reset circuit generates reset pulse every certain period, and every halt mode termination time. The S3C1840 microcontroller has been designed for use in small system control applications that require a low-power, cost - sensitive design solution. In addition, the S3C1840 has been optimized for remote control transmitter.

FEATURES

ROM Size

- 1,024 bytes

RAM Size

- 32 nibbles

Instruction Set

- 39 instructions

Instruction Cycle Time

- 13.2 μsec at fxx = 455 kHz

Input Ports

- Two 4-bit ports (24 pins)/one 4-bit port, one 2-bit ports (20 pins)

Output Ports

- One 4-bit port, seven 1-bit ports (24 pins)/one 4-bit port, five1-bit ports (20 pins)

Built-in Oscillator

- Crystal/ceramic resonator

Built-in Reset Circuit

- Built-in Power-on reset and auto reset circuit for generating reset pulse every 131072/fxx (288 ms at fxx = 455 kHz)

Four Transmission Frequencies

- fxx/12 (1/4 duty), fxx/12 (1/3 duty), fxx/8 (1/2 duty), and no-carrier frequency

Supply Voltage

- 1.8 V-3.6 V (250 kHz $\leq f_{OSC} \leq$ 3.9 MHz)
  2.2 V-3.6 V (3.9 MHz $< f_{OSC} \leq$ 6 MHz)

Power Consumption

- Halt mode: 1 μA (maxium)
- Normal mode: 0.5 mA (typical)

Operating temperature

- $-20\ °C$ to $85\ °C$

Package Type

- 24 SOP, 20 DIP, 20 SOP

Oscillator Frequency divide select

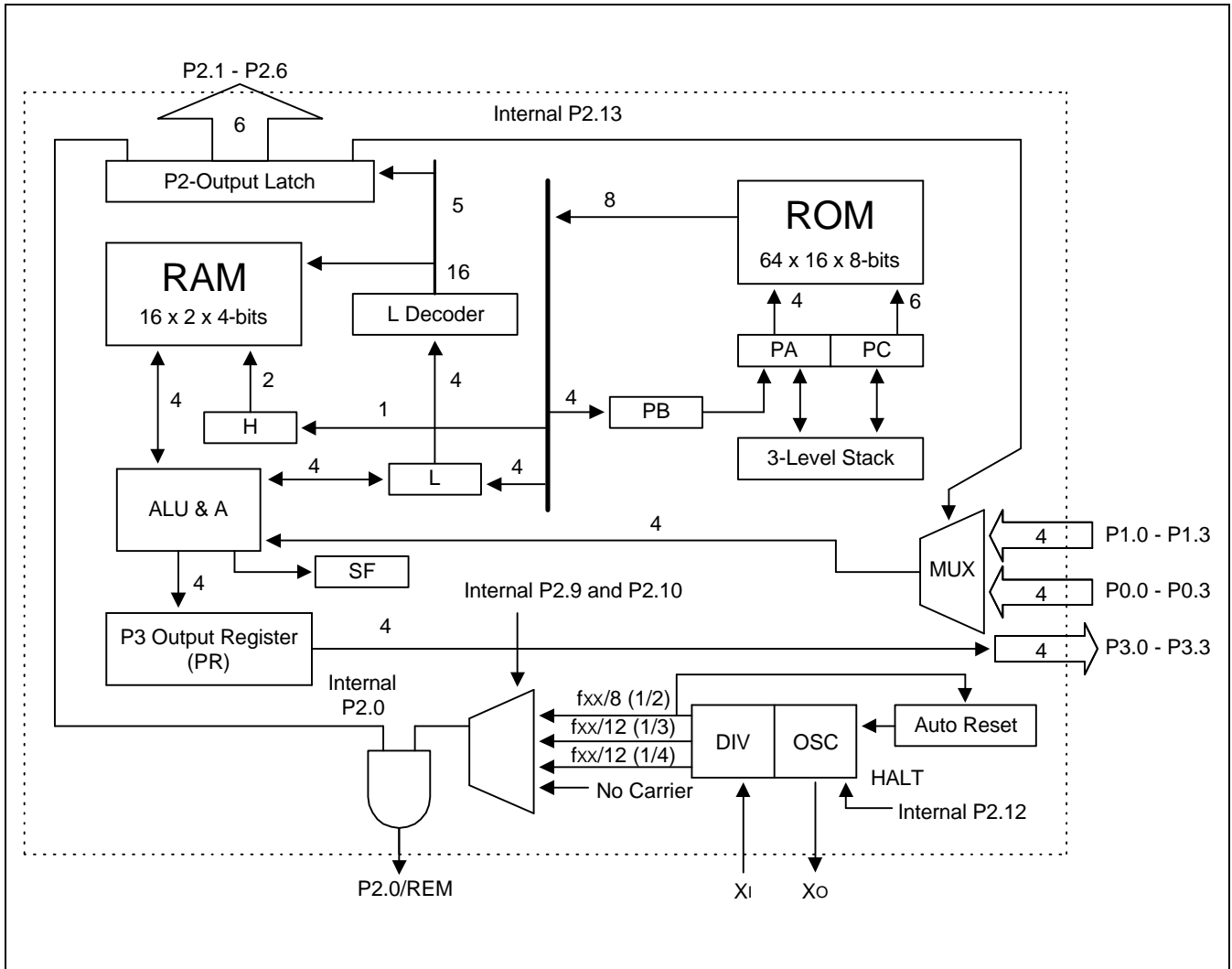- Mask Option: fxx = f_{OSC} or $f_{OSC}/8$

BLOCK DIAGRAM

Figure 1-1. Block diagram
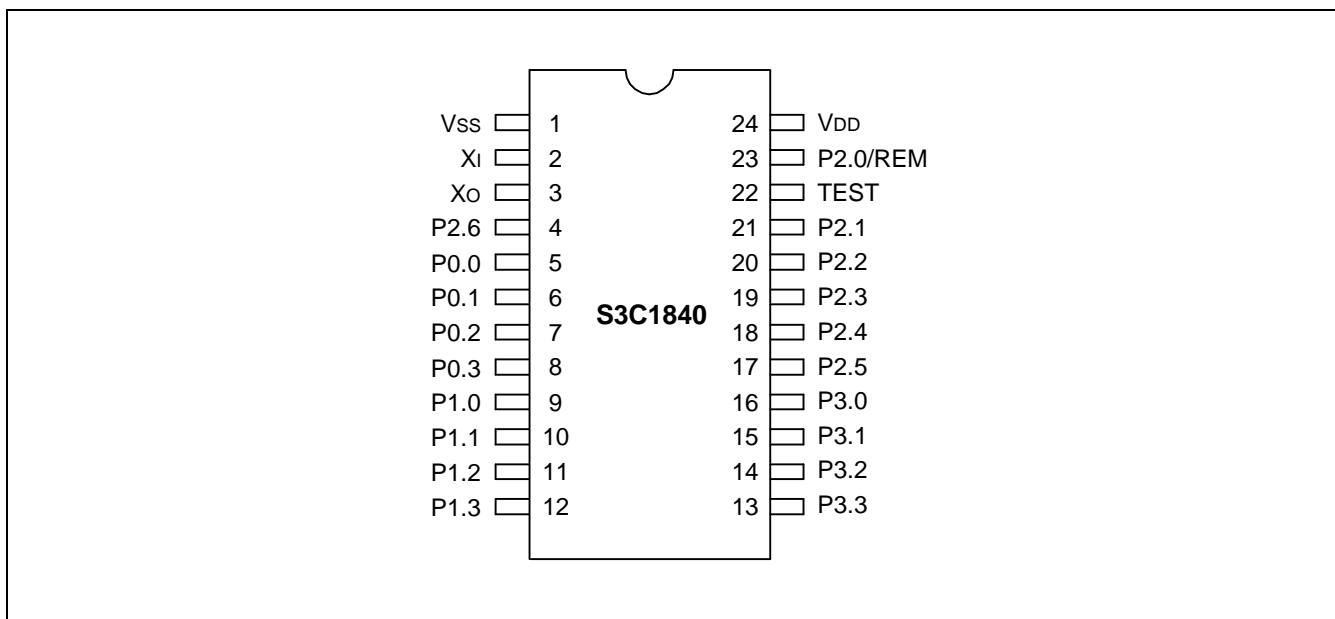
PIN CONFIGURATION (24 SOP)

Figure 1-2. Pin Configuration (24 SOP)

Table 1-1. PIN Description for 24 PINS

Pin Name	Pin Number	Pin Type	Description	I/O Circuit Type
P0.0-P0.3	5, 6, 7, 8	Input	4-bit input port when P2.13 is low	A
P1.0-P1.3	9, 10, 11, 12	Input	4-bit input port when P2.13 is high	A
P2.0 REM	23	Output	1-bit individual output for remote carrier frequency [1]	B
P2.2-P2.5	20, 19, 18, 17	Output	1-bit individual output port	C
P2.1, P2.6	21, 4			D
P3.0-P3.3	16, 15, 14, 13	Output	4-bit parallel output port	C
TEST	22	Input	Input pin for test (Normally connected to V_{SS})	–
X_I	2	Input	Oscillation clock input	–
X_O	3	Output	Oscillation clock output	–
V_{DD}	24	–	Power supply	–
V_{SS}	1	–	Ground	–

NOTES:
1. The carrier can be selected by software as fxx/12 (1/3 duty), fxx/12 (1/4 duty), fxx/8 (1/2 duty), or no-carrier frequency.
2. Package type can be selected as 24 SOP in the ordering sheet.
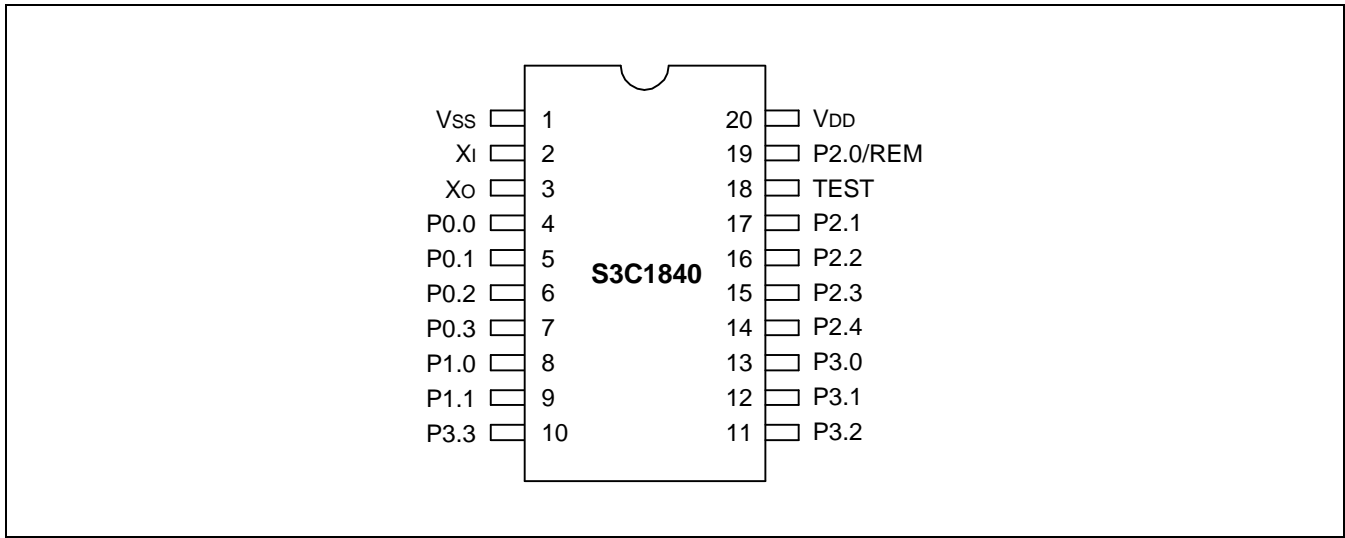
PIN CONFIGURATION (20 DIP, 20 SOP)

Figure 1-3. Pin Configuration (20 DIP, 20 SOP)

Table 1-2. Pin Description for 20 Pins

Pin Name	Pin Number	Pin Type	Description	I/O Circuit Type
P0.0-P0.3	4, 5, 6, 7	Input	4-bit input port when P2.13 is low	A
P1.0-P1.1	8, 9	Input	2-bit input port when P2.13 is high	A
P2.0/REM	19	Output	1-bit individual output for remote carrier frequency [1]	B
P2.2-P2.4	16, 15, 14	Output	1-bit individual output port	C
P2.1	17			D
P3.0-P3.3	13, 12, 11, 10	Output	4-bit parallel output port	C
TEST	18	Input	Input pin for test (Normally connected to V_{SS})	–
X_I	2	Input	Oscillation clock input	–
X_O	3	Output	Oscillation clock output	–
V_{DD}	20	–	Power supply	–
V_{SS}	1	–	Ground	–

NOTES:
1. The carrier can be selected by software as fxx/12 (1/3 duty), fxx/12 (1/4 duty), fxx/8 (1/2 duty), or no-carrier frequency.
2 Package type can be selected as 20 DIP, or 20 SOP in the ordering sheet.

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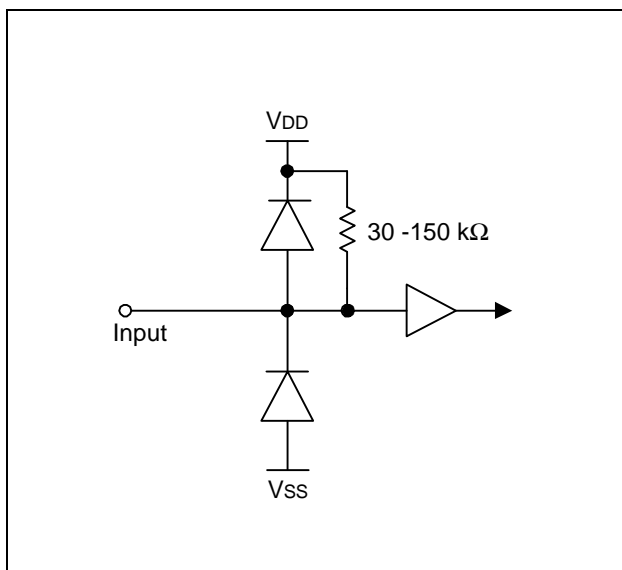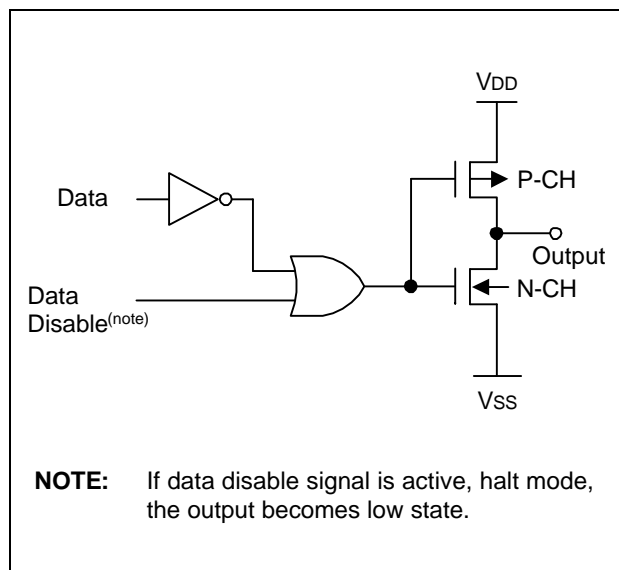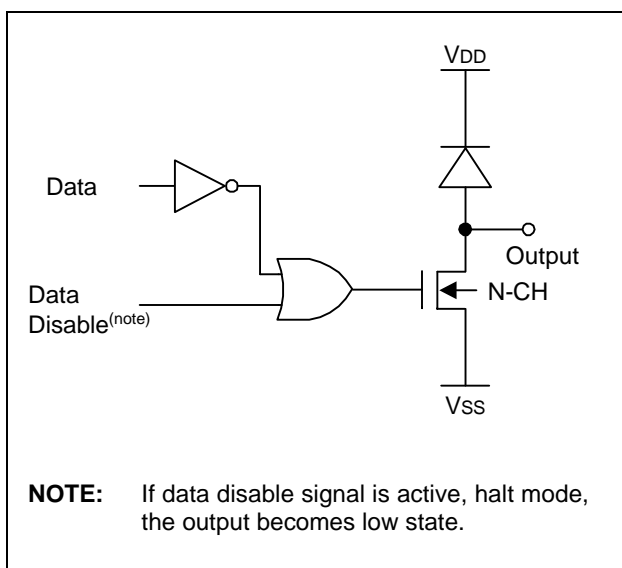**ELECTRONICS**

I/O CIRCUIT SCHEMATICS

Figure 1-4. I/O Circuit Type A

NOTE: If data disable signal is active, halt mode, the output becomes low state.

Figure 1-5. I/O Circuit Type B

NOTE: If data disable signal is active, halt mode, the output becomes low state.
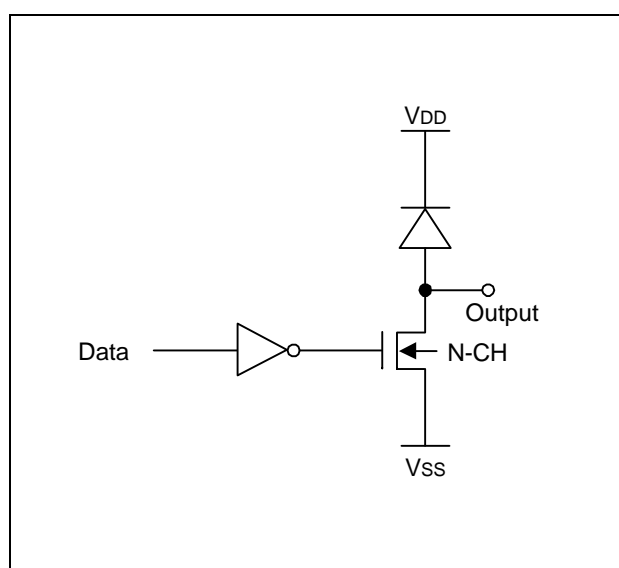
Figure 1-6. I/O Circuit Type C

Figure 1-7. I/O Circuit Type D

Table 1-3. Absolute Maximum Ratings

Parameters	Symbols	Ratings	Units
Supply Voltage	V_{DD}	-0.3 to 6	V
Input Voltage	V_I	-0.3 to $V_{DD} + 0.3$	V
Output Voltage	V_O	-0.3 to $V_{DD} + 0.3$	V
Soldering Temperature	T_{SLD}	260 (10 sec)	°C
Storage Temperature	T_{STG}	-55 to 125	°C

Table 1-4. DC Characteristics

(V_{DD} = 3 V, T_A = 25 °C)

Parameters		Symbols	Test Conditions	Min	Typ	Max	Units
Supply Voltage		V_{DD}	250kHz$\leq$ f_{OSC} $\leq$3.9MHz	1.8	3.0	3.6	V
			3.9MHz< f_{OSC} $\leq$6MHz	2.2	3.0	3.6	
Operating Temperature		T_A	$-$	-20	$-$	85	°C
High-Level Input Voltage		V_{IH1}	All input pins except X_{IN}	0.7 V_{DD}	$-$	V_{DD}	V
		V_{IH2}	X_{IN}	V_{DD}-0.3	$-$	V_{DD}	V
Low-Level Input Voltage		V_{IL1}	All input pins except X_{IN}	0	$-$	0.3 V_{DD}	V
		V_{IL2}	X_{IN}	0	$-$	0.3	V
High-Level Output Current P2.0		I_{OH1}	V_O = 2.0 V	-6.0	-9	-14	mA
Low-Level Output Current P2.0		I_{OL1}	V_O = 0.4 V	1.5	3.0	4.5	mA
Low-Level	P3 Output	I_{OL2}	V_O = 0.4 V	0.5	1.0	2.0	mA
Output	P2.1-P2.3			1.5	3.0	4.5	
Current	P2.4-P2.6			0.5	1.0	2.0	

Table 1-4. DC Characteristics (Continued)

(V_{DD} = 3 V, T_A = 25 °C)

Parameters	Symbols	Test Conditions	Min	Typ	Max	Units
High-Level Input Leakage Current	I_{LIH1}	V_I = V_{DD} All input pins except X_{IN}	–	–	3	uA
	I_{LIH2}	X_{IN}	–	3	10	
Low-level Input Leakage Current	I_{LIL1}	X_{IN}	– 0.6	– 3	– 10	
High-level Output Leakage Current	I_{LOH}	V_O = V_{DD} All output pins except P2.0	–	–	3	uA
Pull-up Resistance of Input Port	R	V_{DD} = 3 V V_I = 0 V	30	70	150	KΩ
Average Supply Current	I_{DD}	V_{DD} = 3 V Crystal/resonator Non-divide option f_{OSC} = 1 MHz	–	0.5	1.0	mA
		Dvide-8 option f_{OSC} = 6 MHz				
HALT Current	I_{DDH}	f_{OSC} = 0	–	–	1.0	uA
Clock Frequency	fxx	Crystal/ceramic	250	–	1000	kHz
Oscillator Frequency	f_{OSC}	Crystal/ceramic Non-divide option	250	–	1000	
		Crystal/ceramic Divide-8 option	2000		6000	

FUCTIONAL DESCRIPTION

Program Memory (ROM)

The S3C1840's program memory consists of a 1024-byte ROM, organized in 16 pages. Each page is 64 bytes long. (See Figure 1-10).

ROM addressing is supported by a 10-bit register made up of two sub-registers: a 4-bit Page Address register (PA), and a 6-bit Program Counter (PC).

Pages 0 through 15 (FH) can each access 64 (3FH) bytes.

ROM addressing occurs as follows: The 10-bit register selects one of the ROM's 1024-bytes. A new address is then loaded into the PC register during each instruction cycle.
Unless a transfer-of -control instruction such as JP,CALL, or RET is encountered, the PC is loaded with the next sequential 6-bit address in the page, PC + 1. In this case, the next address of 3FH would be 00H.

Only the PAGE instruction can change the Page Buffer (PB) to a specified value.

When a JP or CALL instruction is executed, and if the Status Flag is set to "1", the contents of the PB are loaded into the PA register. If the Status Flag is "0", however, the JP or CALL is executed like NOP instruction in an instruction cycle and the Status Flag is set to "1". After that, program execution proceeds.

Page-In Addressing

All instructions, including, JP and CALL, can be executed by page. (See Figure 1-8). When the Status Flag is "1", a JP or CALL causes a program to branch to its address (operand) in a page.
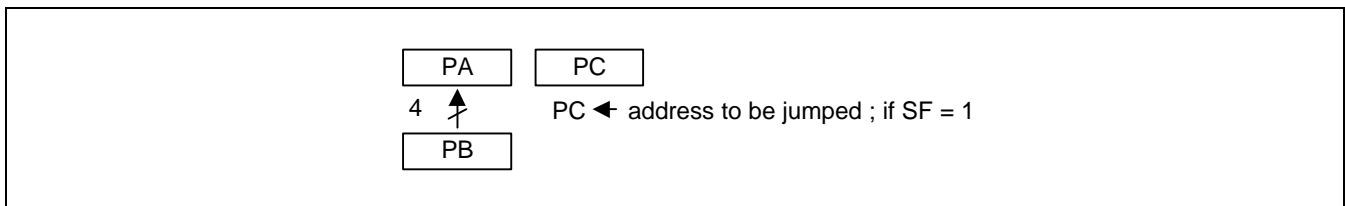
Figure 1-8. Page-In Addressing

Page-To-Page Addressing

When a PAGE instruction occurs, and if the Status Flag is "1", a JP or CALL instruction will cause a program to branch to its address (operand) across the page (See Figure 1-9).
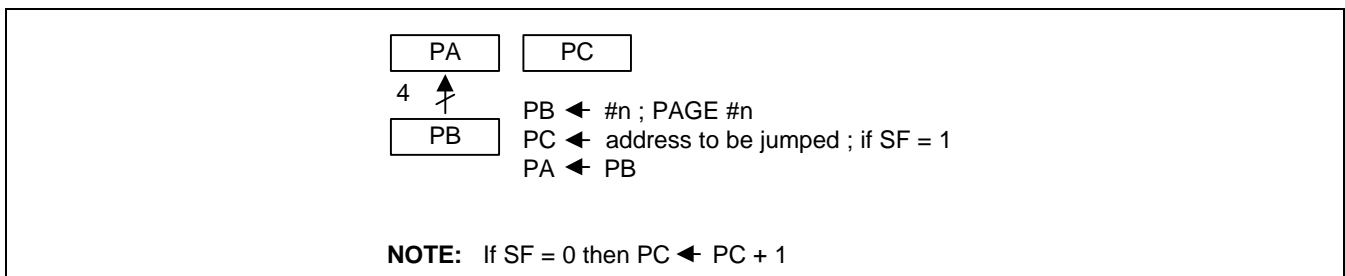
Figure 1-9. Page-to-Page Addressing

PA   PC

4-bit	0	0	6-bit
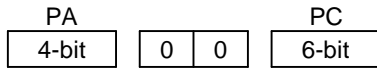
The 10-bit register points one of 1024 bytes at addresses 0000H to 0F3FH.
After reset, it points to 0FXXH for execution in the first instruction cycle. it then becomes 0F00H in the next instruction cycle.

ROM Address

000	Page 0
03F	
100	Page 1
13F	
200	Page 2
23F	
300	Page 3
33F	
400	Page 4
43F	
500	Page 5
53F	
600	

RESET Address 0F00   Page 15
0F3F
0FFF

▨ : Not built-in chip
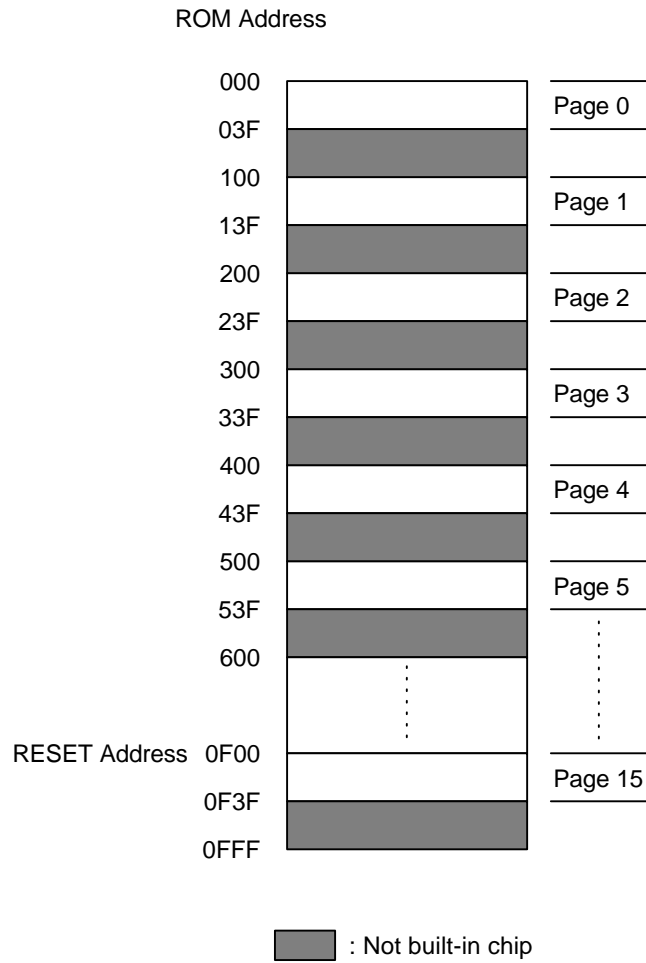
Figure 1-10. S3C1840 Program Memory Map

DATA MEMORY (RAM)

The S3C1840's data memory consists of a 32-nibble RAM which is organized into two files of 16 nibbles each (See Figure 1-11).
RAM addressing is implemented by a 7-bit register, HL.
It's upper 3-bit register (H) selects one of two files and its lower 4-bit register (L) selects one of 16 nibbles in the selected file.

Instructions which manipulate the H and L registers are as follow:

Select a file :

MOV	H,#n	;	H ← #n, where n must be 0,4
NOT	H	;	Complement MSB of H register

Select a nibble in a selected file :

MOV	L,A	;	L ← A
MOV	L,A,@HL	;	L ← M (H,L)
MOV	L,#N	;	L ← #n, where $0 \leq n \leq 0FH$
INCS	L	;	L ← L + 1
DECS	L	;	L ← L - 1
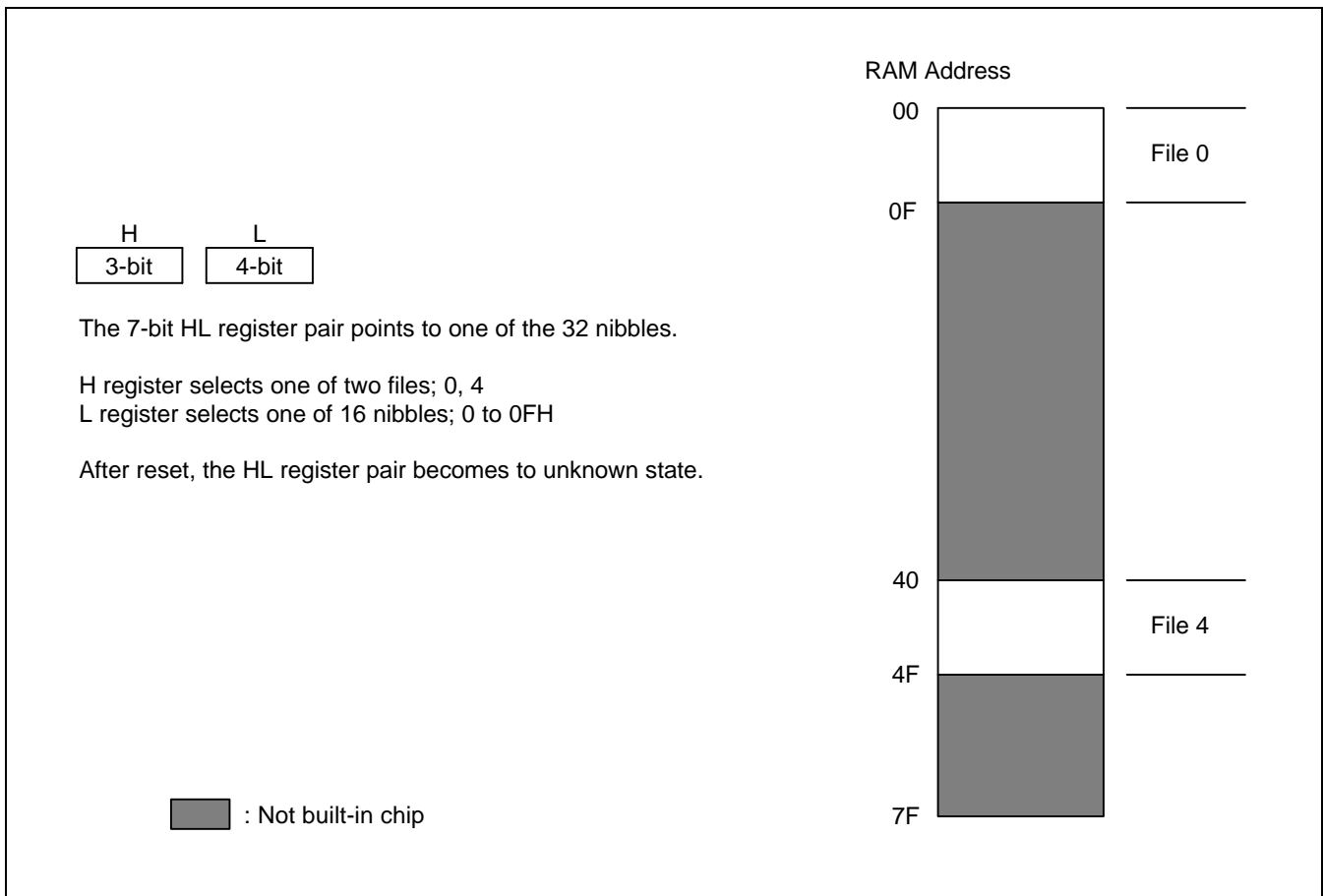
Figure 1-11. S3C1840 Data Memory Map

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REGISTER DESCRIPTIONS

Stack Register (SR)

Three levels of subroutine nesting are supported by a three-level stack as shown in Figure 1-12.

Each subroutine call (CALL) pushes the next PA and PC address into the stack. The latest stack to be stored will be overwritten and lost. Each return instruction (RET) pops the stack back into the PA and PC registers.
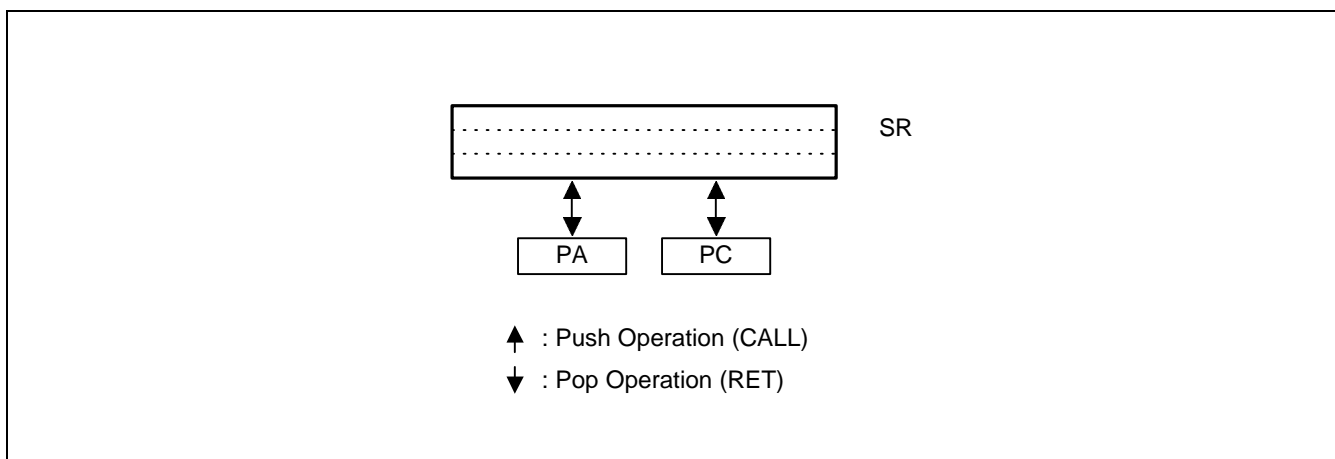
Figure 1-12. Stack Operations

Page Address Register (PA), Page Buffer Register (PB)

The Page Address Register (PA) and Page Buffer Register (PB) are 4-bit registers. The PA always specifies the current page.

A page select instruction (PAGE #n) loads the value "n" into the PB. When JP or CALL instruction is executed, and if the Status Flag (SF) is set to 1, the contents of PB are loaded into PA. If SF is "0", however, the JP or CALL is executed like NOP instruction and SF is set to "1". The contents of PB don't be loaded. Figure 1-13 illustrates this concept.
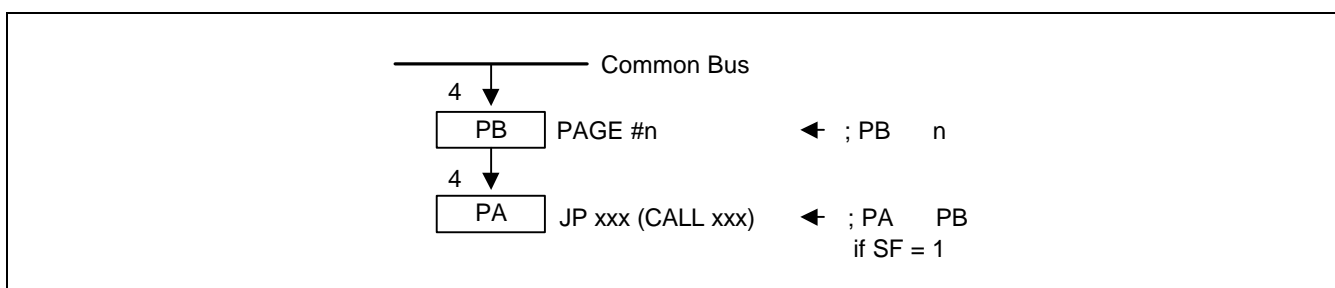
Figure 1-13. PA, PB Operations

Arithmetic Logic Unit (ALU), Accumulator (A)

The SMCS-51 CPU contains an ALU and its own 4-bit register (accumulator) which is the source and destination register for most I/O, arithmetic, logic, and data memory access operations.

Arithmetic functions and logical operations will set the status flag (SF) to "0" or "1".

Status Latch (SL)

The Status latch (SL) flag is an 1-bit flip-flop register. Only the "CPNE L,A" instruction can change the value of SL.

If the result of a "CPNE L,A" instruction is true, the SL is set to "1"; If not true, to "0".

Status Flag : SF

The Status Flag (SF) is a 1-bit flip-flop register which enables programs to conditionally skip an instruction. All instructions, including JP and CALL, are executed when SF is "1".

But if SF is "0", the program executes NOP instruction instead of JP or CALL and resets SF to "1". Then, program execution proceeds. The following instructions set the SF to "0":

- **Arithmetic Instructions**

ADDS	A, #n	;	if no carry
ADDS	A,@HL	;	if no carry
INCS	A,2HL	;	if no carry
INCS	A	;	if no carry
INCS	L	;	if no carry
SUBS	A,@HL	;	if no carry
DECS	A,@HL	;	if no carry
DECS	A	;	if no carry
DECS	L	;	if no carry

- **Compare Instructions**

CPNE	@HL,A	;	if M(H,L) = (A)
CPNZ	@HL	;	if M(H,L) = 0
CPNE	L,#n	;	if (L) = #
CPNE	L,A	;	if (L) = (A)
CPNE	A,@HL	;	if (A) > M(H,L)
CPNZ	P0	;	if (P0) = 0
CPBT	@HL,b	;	if M (H,L,b) $\neq$ 1

- **Data Transfer Instructions**

MOV	@HL+,A	;	if no carry
MOV	@HL_,A	;	if borrow

- **Logical Instructions**

NOTI	A	;	if (A) $\neq$ 0 after operation

INPUT PORTS : P0, P1

The P0 and P1 input ports have internal pull-up 30-150 kΩ resistors, (See I/O circuit type A), each multiplexed to a common bus (See Figure 1-14). If the P2.13 pin is programmed to low, then port 0 is selected as the input port. Otherwise, if the P2.13 pin high, port 1 is selected.
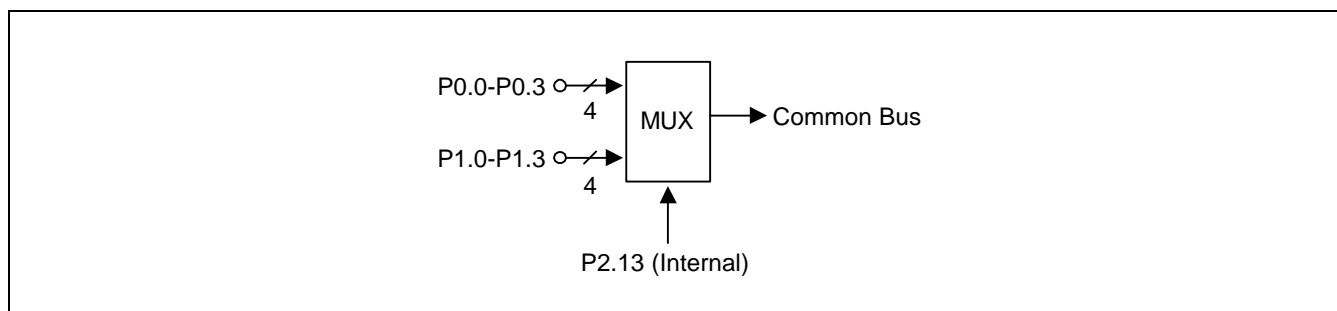
Figure 1-14. S3C1840 Input Port

OUTPUT PORTS : P2, P3

The P2 and P3 output ports can be configured as push-pull (P2.0/REM only) and open drain (P2.1-P2.6, P3.0-P3.3) as follows:

- Standard push-pull : A CMOS push-pull buffer with N-channel transistor to ground in conjunction with a P-channel transistor to V_{DD}, compatible with CMOS and TTL. (See I/O Circuit Type B).

- N-channel open drain : An N-channel transistor to ground, compatible with CMOS and TTL.
  (see I/O Circuit Type C and D).

P2.0, P2.2-P2.5 and P3.0-P3.3 pins become low state in halt mode.
The L register specifies P2 output pins (P2.0/REM-P2.6, P2.9-P2.10, P2.12, and P2.13) individually as follows:

- SETB P2.(L) : Set port 2 bits to correspond to L-register contents.

- CLRB P2.(L) : Clear port 2 bits to correspond to L-register contents.

P3 output pins P3.0-P3.3 are parallel output pins.

For the S3C1840, only the 4-bit accumulator outputs its value to the P3 port by the output instruction "OUT P3, @SL+ A" (the value of the Status Latch (SL) does not matter).

TRANSMISSION CARRIER FREQUENCY

One of four carrier frequencies can be selected and transmitted through the P2.0/REM pin by programming the internal P2.9, P2.10 and P2.0 pins (See Table 1-5). Figure 1-16 shows a simplified diagram of the various transmission circuits.

Table 1-5. Carrier Frequency Selection Table

P2.10	P2.9	Carrier Frequency of P2.0/REM Pin
0	0	fxx/12, 1/3 duty
0	1	fxx/8, 1/2 duty
1	0	fxx/12, 1/4 duty
1	1	No carrier
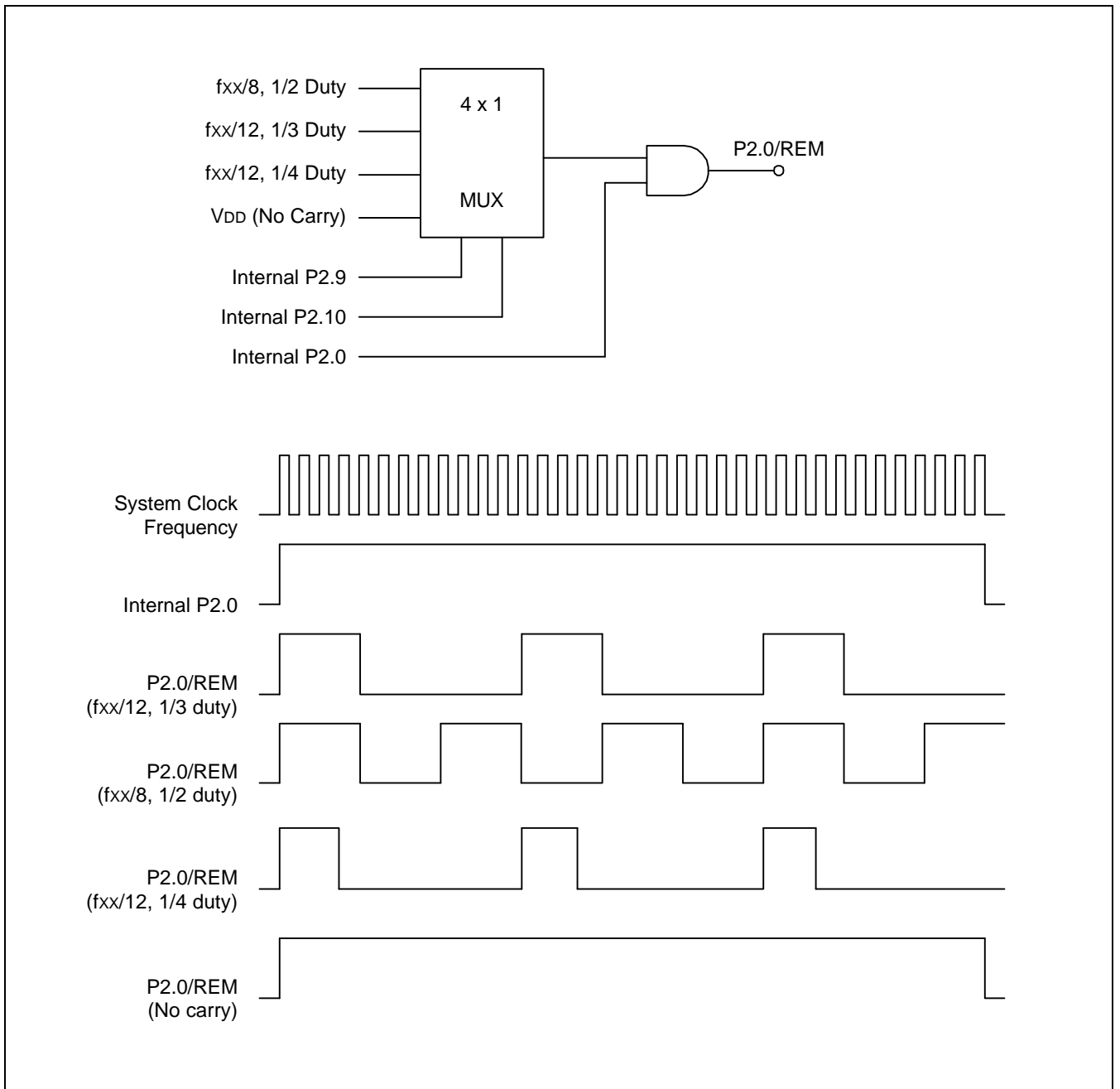
Figure 1-15. Diagram of Transmission Circuits

HALT MODE

The HALT mode is used to reduce power consumption by stopping the clock and holding the states of all internal operations fixed. This mode is very useful in battery-powered instruments. It also holds the controller in wait status for external stimulus to start some event. The S3C1840 can be halted by programming the P2.12 pin high, and by forcing P0 input pins (P0.0-P0.3) to high and P1 input pins (P1.0-P1.3) to high, concurrently (See Figure 1-16). When in HALT mode, the internal circuitry does not receive any clock signal, and all P2, P3 output pins become low states. However, P2.1 and P2.6 pins retain their programmed values until the device is re-started as follows:

- Forcing any P0 and P1 input pins to low : system reset occurs and it continues to operate from the reset address.

An oscillation stabilization time of 13 msec in fxx = 455 kHz crystal oscillation is needed for stability (See Figure 1-17).
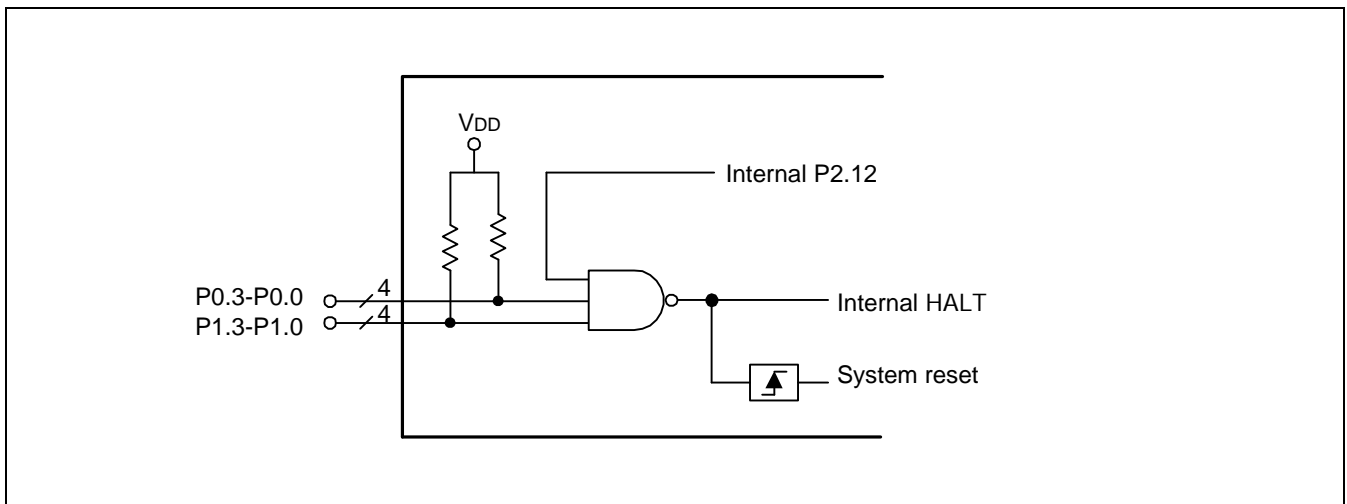
Figure 1-16. Block Diagram of HALT Logic
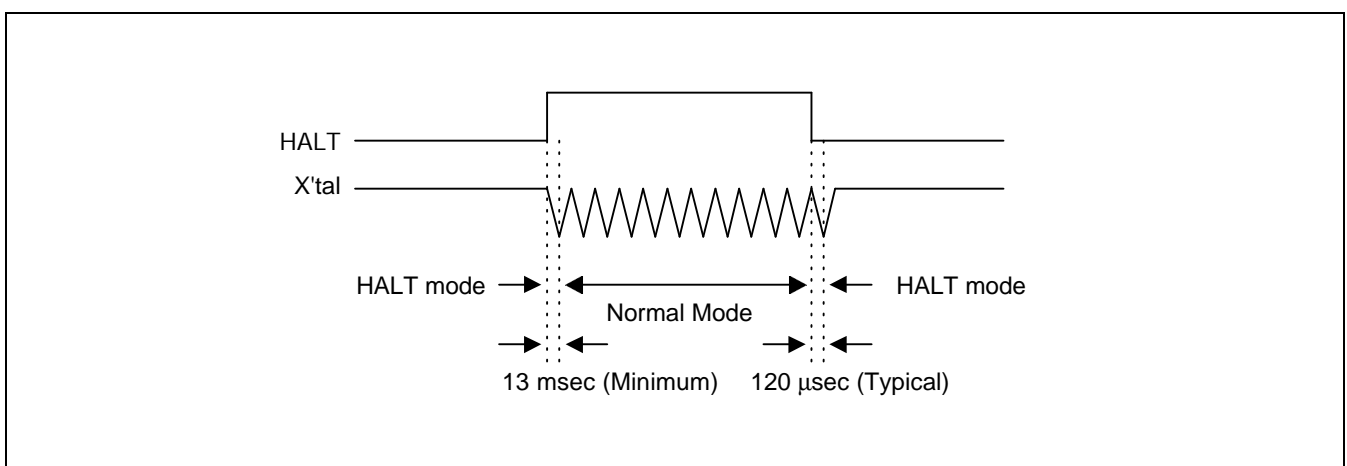
Figure 1-17. Release Timing for HALT or RESET to Normal Mode in Crystal Oscillation

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RESET

All reset operations are internal in the S3C1840. It has an internal power-on reset circuit consisting of a 7 pF capacitor and a 1 MΩ resistor (See Figure 1-18). The controller also contains an auto-reset circuit that resets the chip every 131,072 oscillator clock cycles (288 ms at a fxx = 455 kHz clock frequency). The auto-reset counter is cleared by the rising edge of a internal P2.0 pin, by HALT, or by the power-on reset pulse (See Figure 1-19). Therefore, no clocks are sent to the counter and the time-out is suspended in HALT mode. When a reset occurs during program execution, a transient condition occurs. The PA register is immediately initialized to 0FH. The PC, however, is not reset to 0H until one instruction cycle later. For example, if PC is 1AH when a reset pulse is generated, the instruction at 0F1AH is executed, followed by the instruction at 0F00H.

After a reset, approximately 13 msec is needed before program execution proceeds (assuming fxx = 455 kHz ceramic oscillation).

Upon initialization, registers are set as follows:

- PC register to 0 in next instruction cycle

- PA and PB registers to 0FH (15th page)

- SF and SL registers to 1

- HL registers to unknown state

- All internal/external output pins (P3.0-P3.3, P2.0/REM-P2.6, P2.9, P2.10, P2.12 and P2.13) to low.
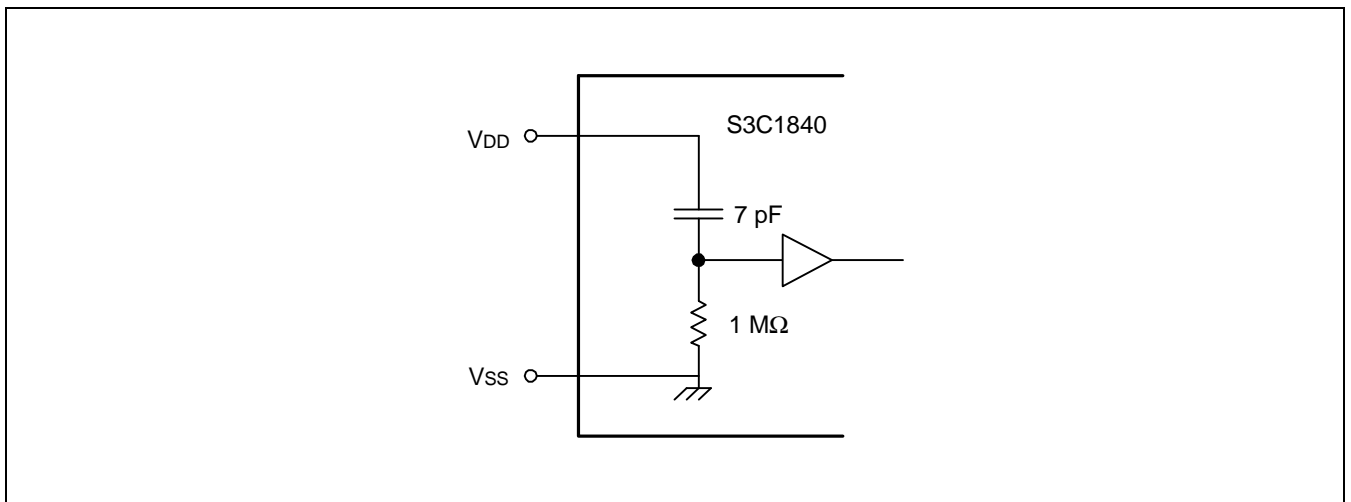
Figure 1-18. S3C1840's Power-on Reset Circuit

The Auto-Reset Counter is cleared every 131,072/fxx (288 msec if fxx is 455 KHz).
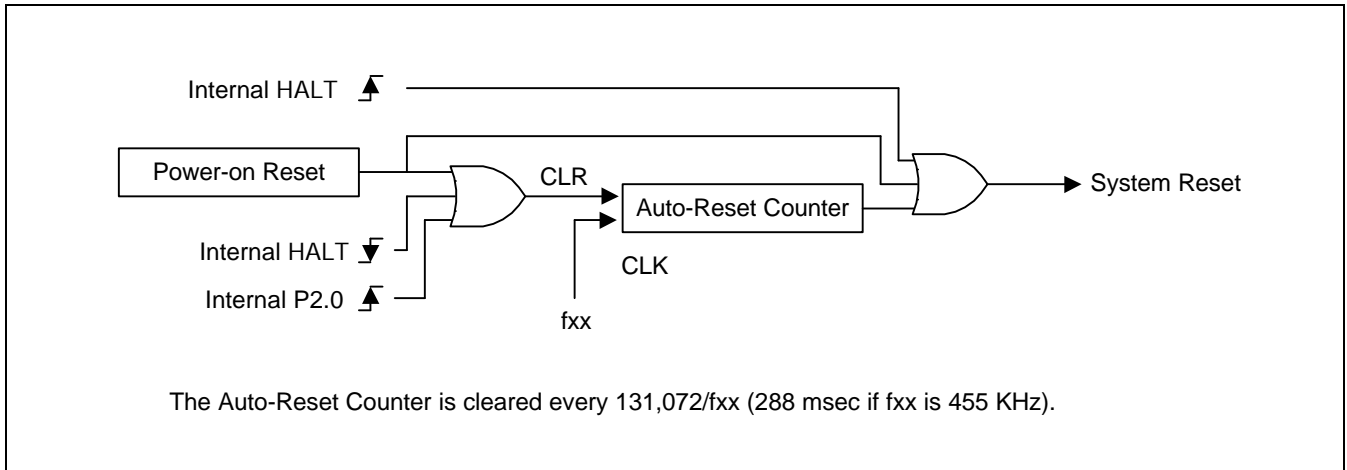
Figure 1-19. Auto Reset Block Diagram

OSC DIVIDE OPTION CIRCUIT

The OSC Divide Option Circuit provides a maximum 1MHz fxx system clock. f_{OSC} which is generated in oscillation circuit is divided eight or non-divide in this circuit to produce fxx. This dividing ratio will be chosen by mask option. (See Figure 1-20)

f_{OSC} : Oscillator clock

fxx : System clock (f_{OSC} or f_{OSC} /8)

f_{CPU}: CPU clock (f_{CPU} = fxx/6)

     1 instruction cycle clock
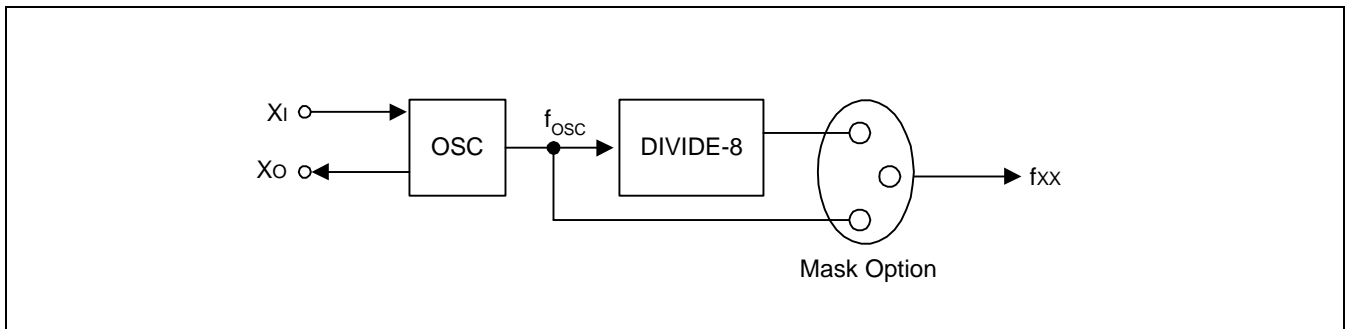
Figure 1-20. S3C1840 OSC Divide Option Circuit

PACKAGE DIMENSIONS
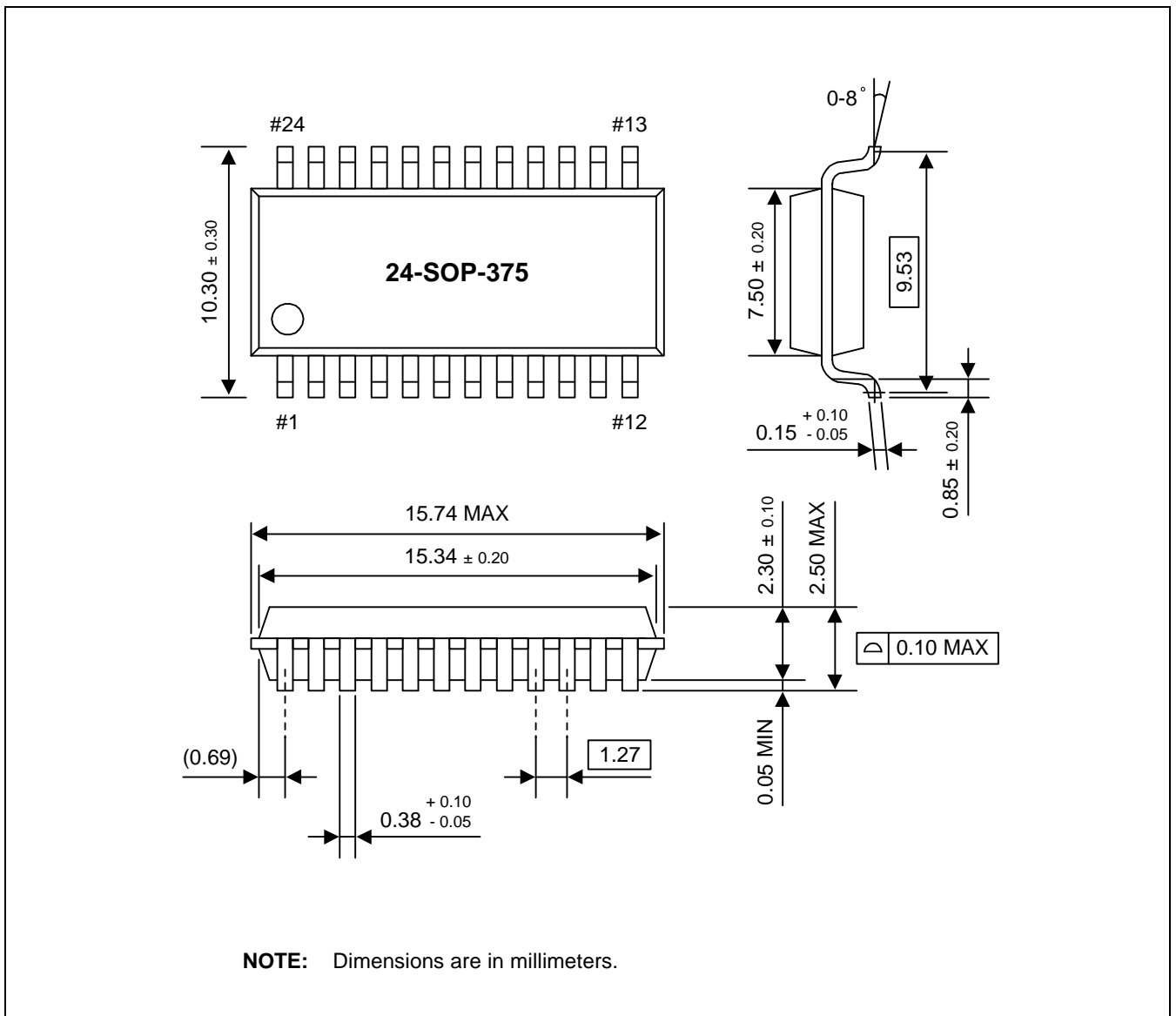
Figure 1-21. 24-SOP-375

Figure 1-22. 20-SOP-375

Dimensions visible in figure:

- #20, #11, #1, #10 (pin labels)
- 20-SOP-375
- 10.30 ± 0.30
- 0-8°
- 7.50 ± 0.20
- 9.53
- 0.203 +0.10 −0.05
- 0.85 ± 0.20
- 13.14 MAX
- 12.74 ± 0.20
- 2.30 ± 0.10
- 2.50 MAX
- 0.10 MAX
- 0.05 MIN
- (0.66)
- 1.27
- 0.40 +0.10 −0.05
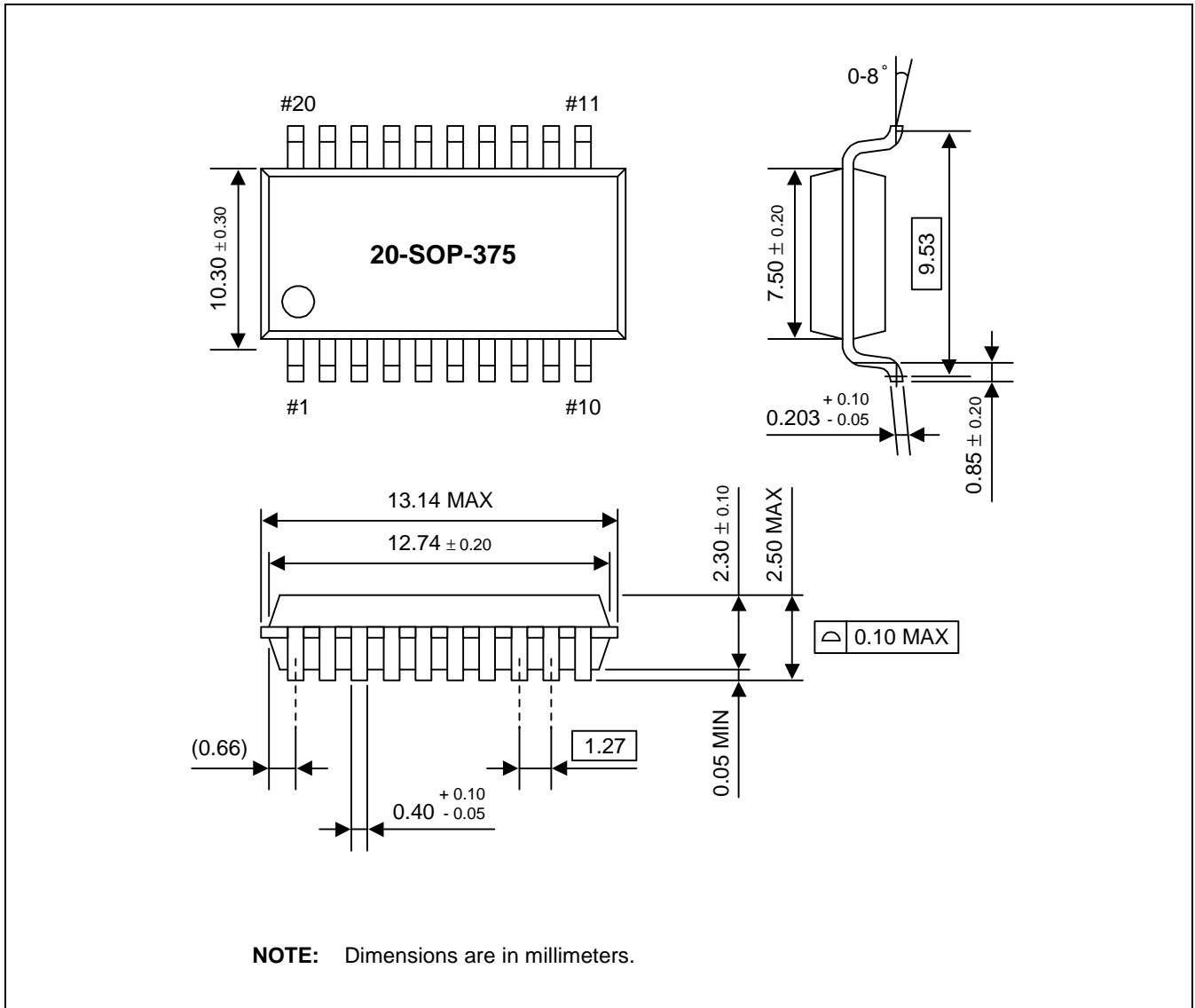
NOTE: Dimensions are in millimeters.
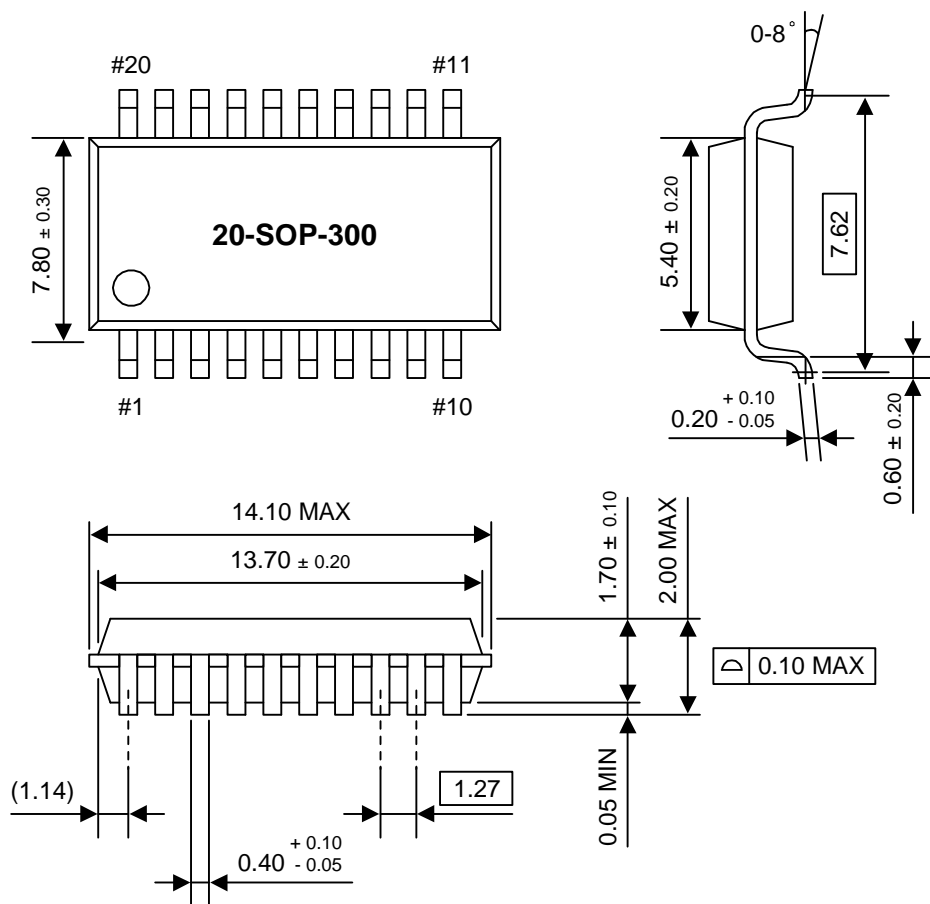
NOTE: Dimensions are in millimeters.

Figure 1-23. 20-SOP-300
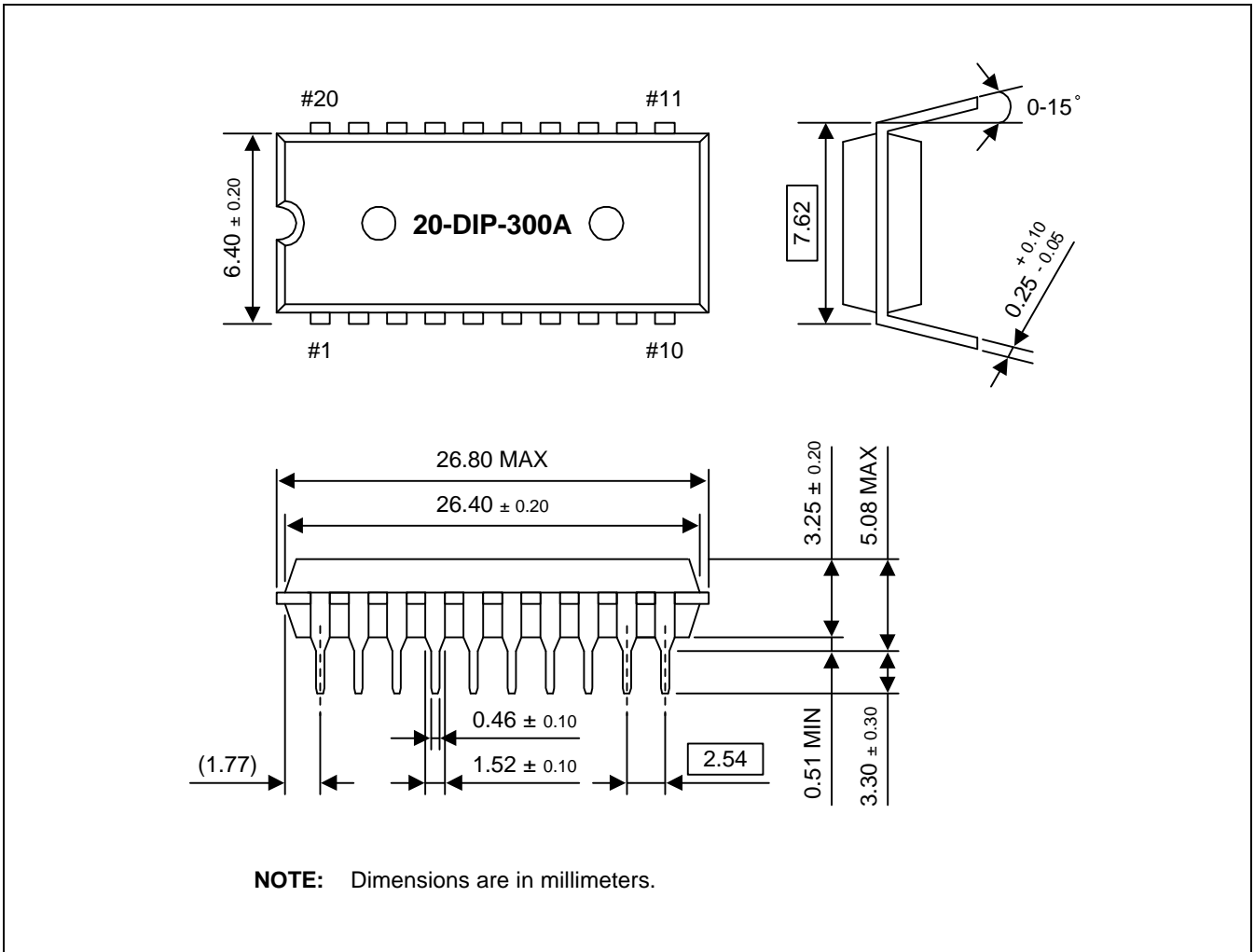
Figure 1-24. 20-DIP-300A

5. INSTRUCTION SET

INSTRUCTION SET DESCRIPTION

Abbreviations and symbols table specifies internal architecture, instruction operand and operational symbols.

As mentioned before, JP and CALL instructions are executed normally only when SF is high. If SF is low, the program executes NOP instruction instead of them and sets SF to high. And then, the program executes a next instruction. In addition, JPL and CALL are long jump and long call instructions which consists of PAGE and JP/CALL instructions.

Table 5-1. Abbreviations and Symbols

Symbol	Description	Symbol	Description
L	L register (4 bits)	SF	Status Flag
A	Accumulator (4 bits)	P3	P4-output
(L)	The contents of the L register	P0	P0 input (4 bits)
(A)	The contents of the accumulator	D	Any binary number
SL	Status latch (1 bit)	DST	Destination operand
PB	Page buffer register (4 bits)	C	Carry Flag
PA	Page address register (4bits)	SRC	Source operand
P2	P2-output	REG	Register
PC	Program counter	←	Transfer
SR	Stack register	+	Addition or increment by 1
H	H register	≤	Equal or less than
M	RAM addressed by H and L registers	( )	The complement of the contents
(H)	The contents of the H register	@	Indirect register address prefix
M (H,L)	The contents of the RAM addressed by H,L	#n	Constant n (immediate 3or 4-bit data)
b	Bit address of the RAM [(H,L)] addressed by H,L	↔	Is exchanged with
≠	Not equal to	−	Subtract or decrement by 1

Table 5-2. Instruction Set Summary

Mnemonic	Operand	Description
MOV Instructions		
MOV	L,A	Move A to register L
MOV	A,L	Move L register to A
MOV	@HL,A	Move A to indirect data memory
MOV	A,@HL	Move indirect data memory to A
MOV	L,@HL	Move indirect data memory to register L
MOV	@HL+,A	Move A to indirect data memory and increment register L
MOV	@HL-,A	Move A to indirect data memory and decrement register L
MOV	L,#n	Move immediate data to register L
MOV	H,#n	Move immediate data to register H
MOV	@HL+,#n	Move immediate data to indirect data memory and increment register L
MOVZ	@HL,A	Move A to indirect data memory and clear A
XCH	@HL,A	Exchange A with indirect data memory
PAGE	#n	Set PB register to n
Program Control Instructions		
CPNE	@HL,A	Compare A to indirect data memory and set SF if not equal
CPNZ	@HL	Set SF if indirect data memory
CPNE	L,A	Compare A to register L, set SF and SL if not equal
CPNE	L,#n	Compare immediate data to register L and set SF if not equal
CPLE	A,@HL	Set SF if A is less than or equal to indirect data memory
CPNZ	P0	Set SF if A is less than or equal to indirect data memory
CPBT	@HL,b	Test indirect data memory bit and set SF if indirect bit is one
JP	dst	Jump if SF flag is set
CALL	dst	Call subroutine if SF is set
RET		Return from subroutine
I/O Instructions		
SETB	P2.(L)	Set bit
CLRB	P2.(L)	Clear bit
IN	A,P0	Input P0 to A
OUT	P3,@SL+A	Output A to P4-PLA output port
Logical Instructions		
NOTI	A	Complement A and increment A
NOT	H	Complement MSB of H register
CLR	A	Clear
Arithmetic Instructions		
ADDS	A,@HL	Add indirect data memory to A
ADDS	A,#n	Add immediate data to A
SUBS	A,@HL	Subtract A from indirect data memory
INCS	A,@HL	Increment indirect data memory and load the result in A
INCS	L	Increment register L
INCS	A	Increment A
DECS	A	Decrement A
DECS	A,@HL	Decrement indirect data memory and load the result in A
DECS	L	Decrement register L
Bit Manipulation Instruction		
SETB	@HL.b	Set indirect data memory bit
CLRB	@HL.b	Clear indirect data memory bit

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Upper Nibble (Hex)   Lower Nibble (Hex) ─────────────▶

	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0	CPNE @HL,A	CPLE A,@HL	CPNE L,A	XCH @HL,A	DECS L	INCS L	ADDS A,@HL	DECS A,@HL	IN A,P0	NOT H	OUT P3,@SL+A		CLRB P2.(L)	SETB P2.(L)	CPNZ P0	RET
1	PAGE #n															▶
2	MOV L,A	MOV A,@HL	MOV L,@HL	MOV A,L	MOV @HL-,A	MOV @HL+,A	MOVZ @HL,A	MOV @HL,A	MOV H,#n							▶
3	SETB @HL.b	───────▶			CLRB @HL.b	───────▶			CPBT @HL.b	───────▶			SUBS A,@HL	NOTI A	INCS A,@HL	CPNZ @HL
4	MOV L,#n	────────────────────────────														▶
5									CPNE L,#n	────────────						▶
6	MOV @HL+#N	────────────────────────────														▶
7	INCS A	ADDS A,#n	───────────────▶					DECS A	ADDS A,#n	───────────────▶						CLR A
8	JP	─────────────────────────────────														▶
9	JP	─────────────────────────────────														▶
A	JP	─────────────────────────────────														▶
B	JP	─────────────────────────────────														▶
C	CALL	─────────────────────────────────														▶
D	CALL	─────────────────────────────────														▶
E	CALL	─────────────────────────────────														▶
F	CALL	─────────────────────────────────														▶

Figure5-1. KS51 Opcode Map

MOV   L,A

Binary Code:	0 0 1 0	0 0 0 0		

Description: The contents of the accumulator are moved to register L.
The contents of the source operand are not affected.

Operation: (L) ← (A)

Flags: SF : Set to one
SL : Unaffected

Example: CLR   A   ; Clear the contents of A

MOV   L,A   ; Move 0H to REG L

MOV   A,L

Binary Code:	0 0 1 0	0 0 1 1		

Description: The contents of register L are moved to the accumulator.
The contents of the source operand are not affected.

Operation: (A) ← (L)

Flags: SF : Set to one
SL : Unaffected

Example: MOV   L,#3H   ; Move 3H to REG L

MOV   A,L   ; Move 0H to A

MOV   @HL,A

Binary Code:	0 0 1 0	0 1 1 1		

Description: The contents of the accumulator are moved to the data memory whose address is
specified by registers H and L.
The contents of the source operand are not affected.

Operation: M [(H,L)] ← (A)

Flags: SF : Set to one
SL : Unaffected

Example: CLR   A   ; Clear the contents of A

MOV   H,#0H   ; Move 0H to REG H

MOV   L,#3H   ; Move 3H to REG L

MOV   @HL,A   ; Move 0H to RAM address 03H

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MOV   A,@HL

Binary Code:	0 0 1 0	0 0 0 1

Description: The contents of the data memory addressed by registers H and L are moved to accumulator.
The contents of the source operand are not affected.

Operation: $(A) \leftarrow M [(H,L)]$

Flags: SF : Set to one
SL : Unaffected

Example: Assume HL contains 04H

MOV   A,@HL   ; Move contents of RAM addressed 04H to A

MOV   L,@HL

Binary Code:	0 0 1 0	0 0 1 0

Description: The contents of the data memory addressed by registers H and L are moved to register L.
The contents of the source operand are not affected.

Operation: $(L) \leftarrow M [(H,L)]$

Flags: SF : Set to one
SL : Unaffected

Example: Assume HI contains 04H

MOV   L,@HL   ; Move contents of RAM address 4H to REG L

CPNE   L,#5H   ; Compare 5H to REG L values

JP   XX   ; jump to XX if REG L value is not 5H

JP   YY   ; Jump to YY if REG L value is 5H

MOV   @HL+,A

Binary Code:	0 0 1 0	0 1 0 1

Description: The contents of the accumulator are moved to the data memory addressed by registers H,L;
L register contents are incremented by one.
The contents of the source operand are not affected.

Operation: $M [(H,L)] \leftarrow (A), L \leftarrow L + 1$

Flags: SF : Set if carry occurs; cleared otherwise
SL : Unaffected

Example: MOV   H,#0H

MOV   L,#0FH

CLR   A

MOV   @HL+A   ; Move 0H to RAM address 0FH and increment REG L value by one

JP   PRT   ; jump to PRT, since there is a carry from increment

---

MOV   @HL-A

Binary Code:	0 0 1 0	0 1 0 0

Description: The contents of accumulator are moved to the data memory addressed by registers H,L;
L register contents are decremented by one.
The contents of the source operand are not affected.

Operation: M [(H,L)] ← (A), L ← L - 1

Flags: SF : Set if no borrow; cleared otherwise
SL : Unaffected

Example: MOV   H,#0H

MOV   L,#3H

CLR   A

MOV   @HL-,A

JP   ABC

MOV   L,#N

Binary Code:	0 1 0 0	d d d d

Description: The 4-bit value specified by n (data) is loaded into register L.
The contents of the source operand are not affected.

Operation: (L) ← #n

Flags: SF : Set to one
SL : Unaffected

Example: MOV   L,#8H   ; 8H is moved to REG L

MOV H,#n

Binary Code:	0 0 1 0	1 d d d

Description: The 3-bit value specified by n (data) is moved to register H.
The contents of the source operand are not affected.

Operation: (H) ← #n

Flags: SF : Set to one
SL : Unaffected

Example: MOV   H,#4H   ; 4H is moved into REG H

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MOV   @HL+,#n

Binary Code:	0 1 1 0	d d d d

Description: The 4-bit value specified by n (data) is moved to data memory addressed by registers H,L;
L register contents are incremented by one.
The contents of the source operand are not affected.

Operation: M [(H,L)] ← #n, L ← L + 1

Flags: SF : Set to one
SL : Unaffected

Example: MOV   H,#0H

MOV   L,#7H

MOV   @HL+,#9H   ; Move 9H to RAM address 07H and increment REG L value
by one, then REG L contains 8H

MOVZ   @HL,A

Binary Code:	0 0 1 0	0 1 1 0

Description: The contents of the accumulator are moved to the data memory addressed by registers H,L;
accumulator contents are cleared to zero.

Operation: M [(H,L)] ← (A), (A) ← 0

Flags: SF : Set to one
SL : Unaffected

Example: MOV   L,#3H

MOV   A,L

MOVZ   @HL,A   ; Move 3H to indirect RAM and clear A to zero

MOV   L,A   ; Move 0H to REG L

SETB   P2.(L)   ; Set P2.0 to 1

XCH   @HL,A

Binary Code:	0 0 0 0	0 0 1 1

Description: This instruction exchanges the contents of the data memory addressed by registers H and
L with the accumulator contents.

Operation: M [(H,L)] ↔ (A)

Flags: SF : Set to one
SL : Unaffected

Example: MOV   H,#0H

MOV   L,#6H

CLR   A   ; Clear A to zero

ADDS   A,#5H   ; Add 5H to A

XCH   @HL,A   ; Exchange 5H with contents of RAM address 06H

PAGE   #n

Binary Code:	0 0 0 1	d d d d

Description: The immediate 4-bit value specified by n (data) is loaded into the PB register.

Operation: (PB) ← #n

Flags: SF : Set to one
              SL : Unaffected

Example: PAGE   #3H   ; Move 3H to page buffer

              JP   AN   ; Jump to label AN located at page 3 if SF is one;
                                     otherwise, it is skipped

CPNE   @HL,A

Binary Code:	0 0 0 0	0 0 0 0

Description: The contents of accumulator are compared to the contents of indirect data memory; an
              appropriate flag is set if their values are not equal.
              The contents of both operands are unaffected by the comparison.

Operation: M [(H,L)] ≠ (A)

Flags: SF : Set if not equal, cleared otherwise
              SL : Unaffected

Example: CLR   A

              ADDS   A,#3H

              MOV   H,#0H

              MOV   L,#6H

              CPNE   @HL,A   ; Acc value 3H is compared to contents of RAM address 06H

              JP   OA   ; Jump to OA if values of RAM address 06H are not 3h

              JP   OB   ; Jump to OB if values of RAM address 06H are 3H

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CPNZ @HL

Binary Code:

0 0 1 1	1 1 1 1

Description: This instruction compares the magnitude of indirect data memory with zero, and the appropriate flag is set if their values are not equal, i.e., if the contents of indirect data memory are not zero.
The contents of operand are unaffected by the comparison.

Operation: M [(H,L)] ≠ 0

Flags: SF : Set if not zero, cleared otherwise
SL : Unaffected

Example: Assume the contents of RAM address are 4H

CPNZ   @HL   ; Compare 4H with zero

JP   EQ   ; Jump to EQ because the result is not equal

JP   WAIT

CPNE   L,A

Binary Code:

0 0 0 0	0 0 1 0

Description: The contents of the accumulator are compared to the contents of register L; the appropriate flags are set if their values are not equal.
The contents of both operands are unaffected by the comparison.

Operation: (L) ≠ (A)

Flags: SF : Set if not equal, cleared otherwise
SL : Set if not equal, cleared otherwise

Example: Assume REG L contains 5H, A contains 4H

CPNE   L,A   ; Compare A to REG L values

JP   K1   ; Jump to K1 because the result is not equal

JP   K2

CPNE   L,#n

Binary Code:	0 1 0 1	d d d d

Description: This instruction compare the immediate 4 bit data n with the contents of register L, and sets an appropriate flag if their values are not equal.
The contents of both operands are unaffected by the comparison.

Operation: $(L) \neq \#n$

Flags: SF : Set if not equal, cleared otherwise
SL : Unaffected

Example: CLR   A

ADDS   A,#4H

MOV   L,A

CPNE   L,#5H   ; Compare immediate data 5H to REG L values

JP   K3   ; Jump to K3 because the result is not equal

CPNE   A,@HL

Binary Code:	0 0 0 0	0 0 0 1

Description: The contents of indirect data memory are compared to the contents of the accumulator. Appropriate flags are set if the contents of the accumulator are less than or equal to the contents of indirect data memory.
The contents of both operands are unaffected by the comparison.

Operation: $(A) \leq M [(H,L)]$

Flags: SF : Set if less than or equal to, cleared otherwise
SL : Unaffected

Example: Assume RAM address holds 8H

CPLE   A,@HL   ; Compare 8H to A values

JP   MAR   ; Jump to MAR if $0H \leq A \leq 8H$

JP   BPR   ; Jump to BPR if $9H \leq A \leq 0FH$

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CPNZ   P0

Binary Code:	0 0 0 0	1 1 1 0

Description: The instruction compares the contents of Port 0 with zero. Appropriate flags are set if their values are not equal, i.e., if the contents of Port 0 are not zero.
The contents of the operand are unaffected by the comparison.

Operation: $(P0) \neq 0$

Flags: SF : Set if not zero, cleared otherwise
SL : Unaffected

Example: MOV   L,#0DH

CLRB   P2.(L)   ; Clear P2.13, i.e., select P0 input

CPNZ   P0   ; Compare P0 to zero

JP   KEYIN   ; Jump to KEYIN if $P0 \neq 0$

JP   NOKEY   ; Jump to NOKEY if $P0 = 0$

CPBT   @HL,b

Binary Code:	0 0 1 1	1 0 d d

Description: CPBT tests indirect data memory bit and sets appropriate flags if the bit value is one.
The contents of operand are unaffected by the test.

Operation: $M [(H,L)] = 1$

Flags: SF : Set if one, cleared otherwise
SL : Unaffected

Example: MOV   H,#0H

MOV   L,#0BH

CPBT   @HL,3   ; Test RAM address 0BH bit 3

JP   Q1   ; Jump to Q1 if RAM address bit 3 is 1

JP   Q2   ; Jump to Q2 if RAM address bit 3 is 0

JP   dst

Binary Code:	1 0 d d	d d d d

Description: The JP transfers program control to the destination address if the SF is one.
The conditional jump replaces the contents of the program counter with the address
indicated and transfers control to that location.
Had the SF flag not been set, control would have proceeded with the next instruction.

Operation: If SF = 1 ; PC ← (W), PA ← PB

Flags: SF : Set to one
SL : Unaffected

Example: JP   SUTIN1   ; This instruction will cause program execution to branch to the
instruction at label SUTIN; SUTIN1 must be within the current
page

CALL   dst

Binary Code:	1 1 d d	d d d d

Description: If the SF flag is set to 1, this instruction calls a subroutine located at the indicated address,
and then pushes the current contents of the program counter to the top of the stack. The
program counter value used is the address of the first instruction following the CALL ins.
The specified destination address is then loaded into the program counter and points to the
first instruction of a procedure. At the end of the procedure, the return (RET) instruction
can be used to return to the original program flow.

Operation: If SF = 1 ; SRi ← PC + 1, PSRi ← PA
PC ← I (W), PA ← PB

Flags: SF : Set to one
SL : Unaffected

Example: CALL   ACD1   ; CALL subroutine located at the label ACD1 where ACD1
must be within the current page

RET

Binary Code:	0 0 0 0	1 1 1 1

Description: This instruction is normally used to return to the previously executing procedure at the end
of a procedure entered by a CALL instruction. The contents of the location addressed by
the stack pointer are popped into the program counter. The next statement executed is that
addressed by the new contents of the program counter.

Operation: PC ← Sri, PB ← PSRi
PA ← PB

Flags: SF : Set to one
SL : Unaffected

Example: RET   ; Return from subroutine

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SETB   P2.(L)

Binary Code:		0 0 0 0	1 1 0 1	

Description: This instruction sets the Port 2 bit addressed by register L without affecting any other bits in the destination.

Operation: P2.(L) ← 1

Flags: SF : Set to one
SL : Unaffected

Example: MOV   L,#0H

SETB   P2.(L)   ; Set P2.0 to 1

CLRB   P2.(L)

Binary Code:		0 0 0 0	1 1 0 0	

Description: This instruction clears the Port 2 bit addressed by register L without affecting any other bits in the destination.

Operation: P2.(L) ← 0

Flags: SF : Set to one
SL : Unaffected

Example: MOV   L,#0H

CLRB   P2.(L)   ; Clear P2.0 to 0

IN A,P0

Binary Code:		0 0 0 0	1 0 0 0	

Description: Data present on Port n is transferred (read) to the accumulator.

Operation: (A) ← (Pn) (n = 0,1)

Flags: SF : Set to one
SL : Unaffected

Example: IN   A,P0   ; Input port 0 data to Acc

MOV   L,A

CPNE   L,#3H

JP   OX   ; Jump to OX if port 0 data ≠ 3H

JP   QP   ; Jump to QP if port 0 data = 3H

OUT   P3,@SL+A

Binary Code:	0 0 0 0	1 0 1 0

Description: The contents of the accumulator and SL are transferred to the P3 Output register.

Operation: (P3 Output register) ← (A) + (SL)

Flags: SF : Set to one
SL : Unaffected

Example: CLR   A

OUT   P3,@SL+A   ; Zero output on port 3

NOTI   A

Binary Code:	0 0 1 1	1 1 0 1

Description: The contents of the accumulator are complemented; all 1 bits are changed to 0, and vice-versa, and then incremented by one.

Operation: (A) ← (A), (A) ← (A) +1

Flags: SF : Set if the result is zero, cleared otherwise
SL : Unaffected

Example: CLR   A

ADDS   A,#7H

NOTI   A   ; Complement 7H (0111B) and increment the result by one;
the instruction NOTI A then leaves 9H (1001B) in A

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NOT H

Binary Code:		0 0 0 0	1 0 0 1	

Description: The MSB of register H is complemented,

Operation: (H) ← (H)

Flags: SF : Set to one
SL : Unaffected

Example: MOV   H,#4H

NOT   H   ; Complement 4H (100B), then it leaves 00H (000B) in REG H

CLR A

Binary Code:		0 1 1 1	1 1 1 1	

Description: The contents of the accumulator are cleared to zero (all bits set on zero).

Operation: (A) ← 0

Flags: SF : Set to one
SL : Unaffected

Example: CLR   A   ; A value are cleared to zero

ADDS A,@HL

Binary Code:		0 0 0 0	0 1 1 0	

Description: ADDS adds the contents of indirect data memory to accumulator, leaving the result in the accumulator.
The contents of the source operand are unaffected.

Operation: (A) ← M [(H,L)] + (A)

Flags: SF : Set if a carry occurred, cleared otherwise
SL : Unaffected

Example: Assume RAM address holds 5H

CLR   A   ; Clear A to zero

ADDS   A,@HL   ; This instruction will leaves 5H in A

ADDS   A,#n

Binary Code:	0 1 1 1	d d d d

Description: The specified 4-bit data n is added to the accumulator and the sum is stored in the accumulator.

Operation: (A) ← (A) + #n

Flags: SF : Set if a carry occurred, cleared otherwise
SL : Unaffected

Example:
CLR	A	; Clear A to zero
ADDS	A,#4H	; Add 4H to A, it leaves 4H in A

SUBS   A,@HL

Binary Code:	0 0 1 1	1 1 0 0

Description: SUBS subtracts the contents of accumulator from the contents of indirect data memory, leaving the result in the accumulator.
The contents of source operand are unaffected.

Operation: (A) ← M [(H,L)] - (A)

Flags: SF : Set if no borrow occurred, cleared otherwise
SL : Unaffected

Example: Assume RAM address holds 0CH
MOV	L,#8H	
MOV	A,L	
SUBS	A,@HL	; Subtract A from 0CH; it will leave 4H in A

INCS   A,@HL

Binary Code:	0 0 1 1	1 1 1 0

Description: The contents of indirect data memory are incremented by one and the result is loaded into the accumulator.
The contents of indirect data memory are unaffected.

Operation: (A) ← M [(H,L)] + 1

Flags: SF : Set if a carry occurred, cleared otherwise
SL : Unaffected

Example: Assume RAM address holds 6H
CLR	A	; Clear A to zero
INCS	A,@HL	; Increment 6H by one and leave 7H in A

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INCS   L

Binary Code: | 0 0 0 0 | 0 1 0 1 |

Description: The contents of the L register are incremented by one.

Operation: (L) ← (L) + 1

Flags: SF : Set if a carry occurred, cleared otherwise
SL : Unaffected

Example: MOV   L,#5H

INCS   L   ; Increment REG L value 5H by one

INCS   A

Binary Code: | 0 1 1 1 | 0 0 0 0 |

Description: The contents of the accumulator are incremented by one.

Operation: (A) ← (A) + 1

Flags: SF : Set if no borrow occurred, cleared otherwise
SL : Unaffected

Example: MOV   L,#5H

MOV   A,L

INCS   A   ; Increment 5H by one

DECS   A

Binary Code: | 0 1 1 1 | 0 1 1 1 |

Description: The contents of the accumulator are decremented by one.

Operation: (A) ← (A) - 1

Flags: SF : Set if a carry occurred, cleared otherwise
SL : Unaffected

Example: MOV   L,#0BH

MOV   A,L

DECS   A   ; The instruction leaves the value 0AH in A

DECS   A,@HL

Binary Code:	0 0 0 0	0 1 1 1

Description: The contents of the data memory addressed by the H and L registers are decremented by
one and the result is loaded in the accumulator.
But the contents of data memory are not affected.

Operation: $(A) \leftarrow M [(H,L)] - 1$

Flags: SF : Set if a carry occurred, cleared otherwise
SL : Unaffected

Example: Assume RAM address holds 5h

MOV   L,#0AH

MOV   A,L

DECS   A,@HL   ; Decrement the value 5H by one, and the result value 4H is
loaded in A

DECS   L

Binary Code:	0 0 0 0	0 1 0 0

Description: The contents of the L register are decremented by one.

Operation: $(L) \leftarrow (L) - 1$

Flags: SF : Set if no borrow occurred, cleared otherwise
SL : Unaffected

Example: MOV   L,#3H

DECS   L   ; This instruction leaves the value 2H in REG L

SETB   @HL,b

Binary Code:	0 0 1 1	0 0 d d

Description: This instruction sets indirect data memory bit addressed by registers H and L without
affecting any other bits in the destination.

Operation: $b \leftarrow 1$ (b = 0,1,2,3)

Flags: SF : Set to one
SL : Unaffected

Example: MOV   H,#0H

MOV   L,#5H

SETB   @HL.2   ; Set RAM address 05H bit 2 to 1

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DECS   A,@HL

Binary Code:	0 0 1 1	0 1 d d

Description: This instruction clears the indirect data memory bit addressed by registers H and L without affecting any other bits in the destination.

Operation: $b \leftarrow 1$ (b = 0,1,2,3)

Flags: SF : Set to one
                SL : Unaffected

Example: MOV   H,#0H

                MOV   L,#5H

                CLRB   @HL.3   ; Clear RAM address 05H bit 3 to zero

6. DEVELOPMENT TOOLS

SMDS

The Samsung Microcontroller Development System, SMDS is a complete PC-based development environment for S3C1840/C1850/C1860 microcontroller. The SMDS is powerful, reliable, and portable. The SMDS tool set includes a versatile debugging utility, trace with built-in logic analyzer, and performance measurement applications.

Its window-oriented program development structure makes SMDS easy to use. SMDS has three components:

— IBM PC- compatible SMDS software, all device-specific development files, and the SAMA assembler.
— Development system kit including main board, personality board, SMDS manual, and target board adapter, if required.
— Device-specific target board.

SMDS PRODUCT VERSIONS

As of the date of this publication, two versions of the SMDS are being supported:

— SMDS Version 4.8 (S/W) and SMDS Version 3.6 (H/W); last release: January, 1994.
— SMDS2 Version 5.3 (S/W) and SMDS2 Version 1.3 (H/W); last release: November, 1995.

The new SMDS2 Version 1.3 is intended to replace the older Version 3.6 SMDS. The SMDS2 contains many enhancements to both hardware and software. These development systems are also supported by the personality boards of Samsung's microcontroller series: S3C1, S3C7, and S3C8.

SAMA ASSEMBLER

The Samsung Arrangeable Microcontroller (SAM) Assembler, SAMA, is a universal assembler, and generates object code in standard hexadecimal format.

Compiled program code includes the object code that is used for ROM data and required SMDS program control data. To compile programs, SAMA requires a source file and an auxiliary definition (DEF) file with device-specific information.

TARGET BOARDS AND PIGGYBACKS

Target boards are available for S3C1840/C1850/C1860 microcontroller. All required target system cables and adapters are included with the device-specific target board.

Piggyback chips are provided to customers in limited quantities for S3C1840/C1850 microcontroller. The S3C1840/C1850 piggyback chips, PB51840-20 and PB51840/51850-24 are now available.

PB51840-20 is 20 DIP piggyback chip for 20 DIP, 20 SOP package device of S3C1840 microcontroller.
PB51840/51850-24 is 24DIP piggyback chip for 24 SOP package device of S3C1840/C1850 microcontroller.
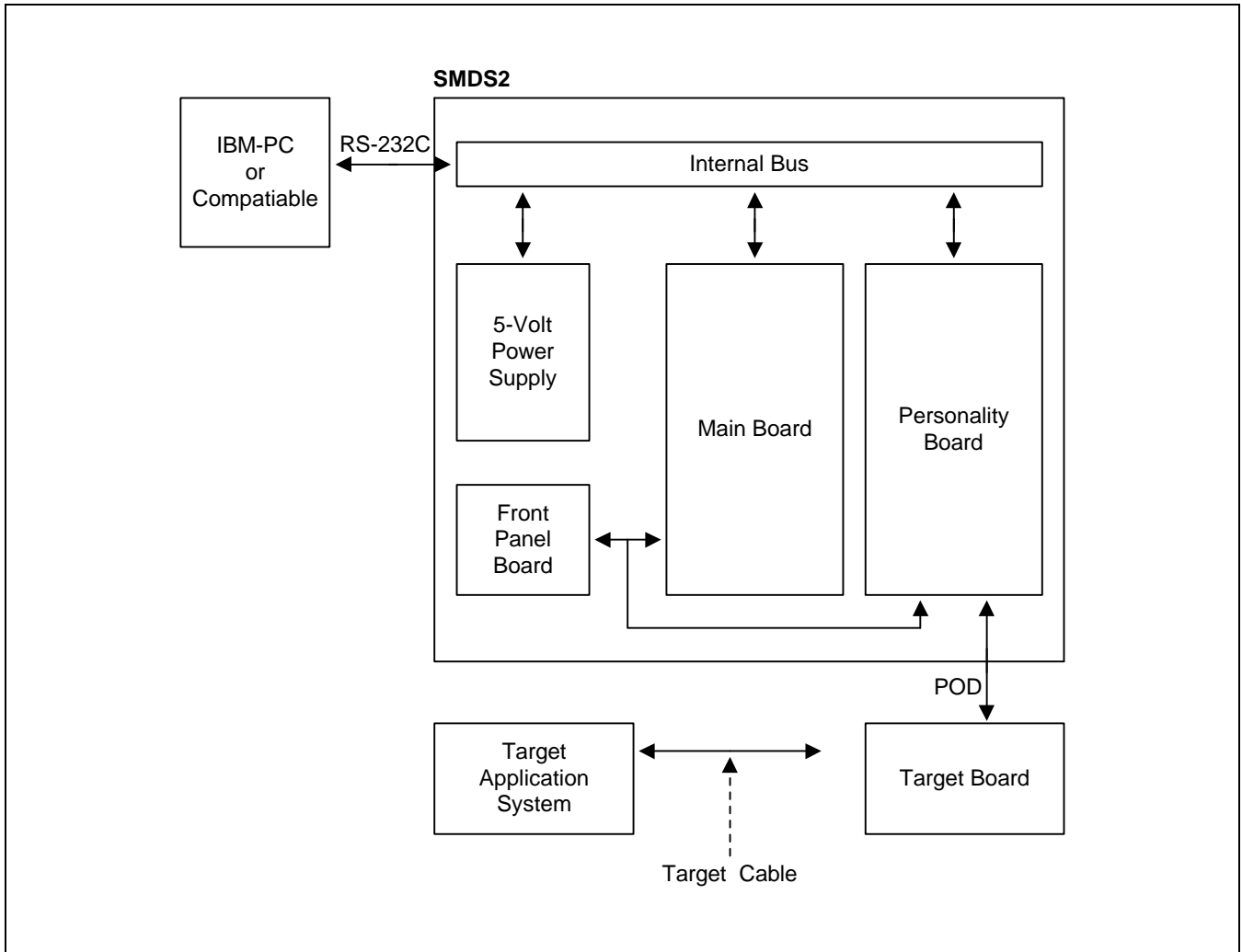
Figure 6-1. SMDS Product Configuration (SMDS2)

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TB51840/51850A TARGET BOARD

 The TB51840/51850A target board is used for the S3C1840/C1850/C1860 microcontroller. It is supported by the SMDS2 development system only.
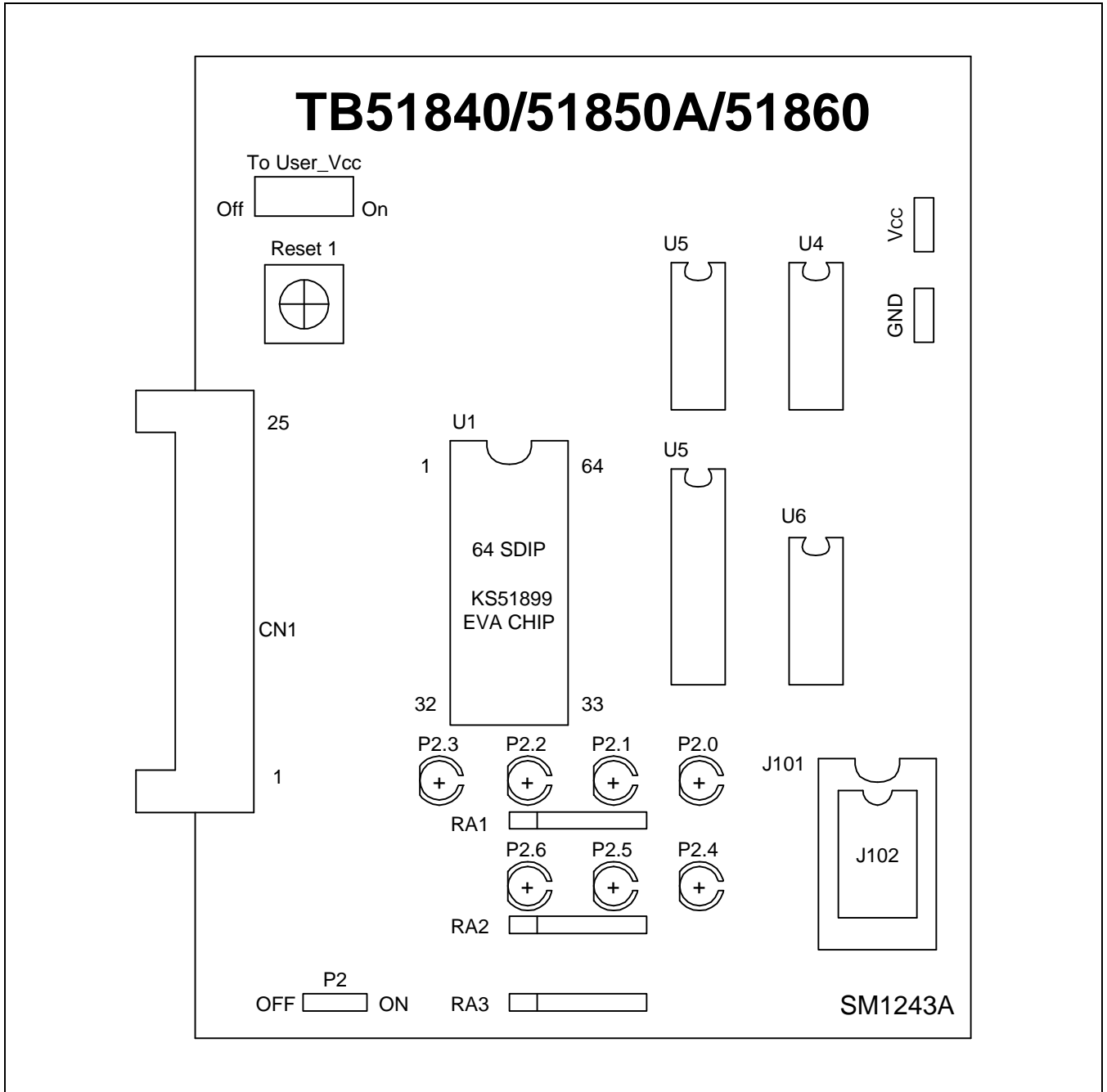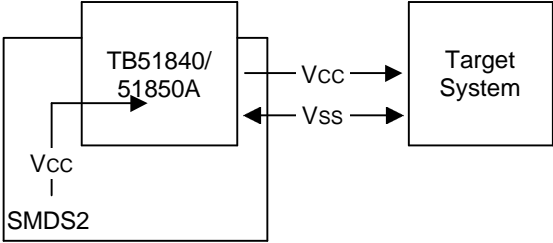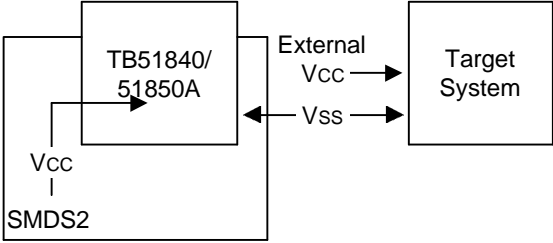
Figure 6-2. TB51840/51850A Target Board Configuration

Table 6-1. Power Selection Settings for TB51840/51950A

'To User_Vcc' Settings	Operating Mode	Comments
To User_Vcc OFF ⬭◯⬛⬛⬭ ON		The SMDS2 supplies V_{CC} to the target board (evaluation chip) and the target system.
To User_Vcc OFF ⬭◯◯⬛⬭ ON		The SMDS2 supplies V_{CC} only to the target board (evaluation chip). The target system must have its own power supply.

LED 2.0-LED 2.6:

These LEDs are used to display value of the P2.0-P2.6. It will be turn on, if the value is Low.

P2 Option Switch:

Switch ON: You can see the port value using the LED display.
Switch OFF: You can't see the port value. That is, the LED won't be turn ON by the port value.

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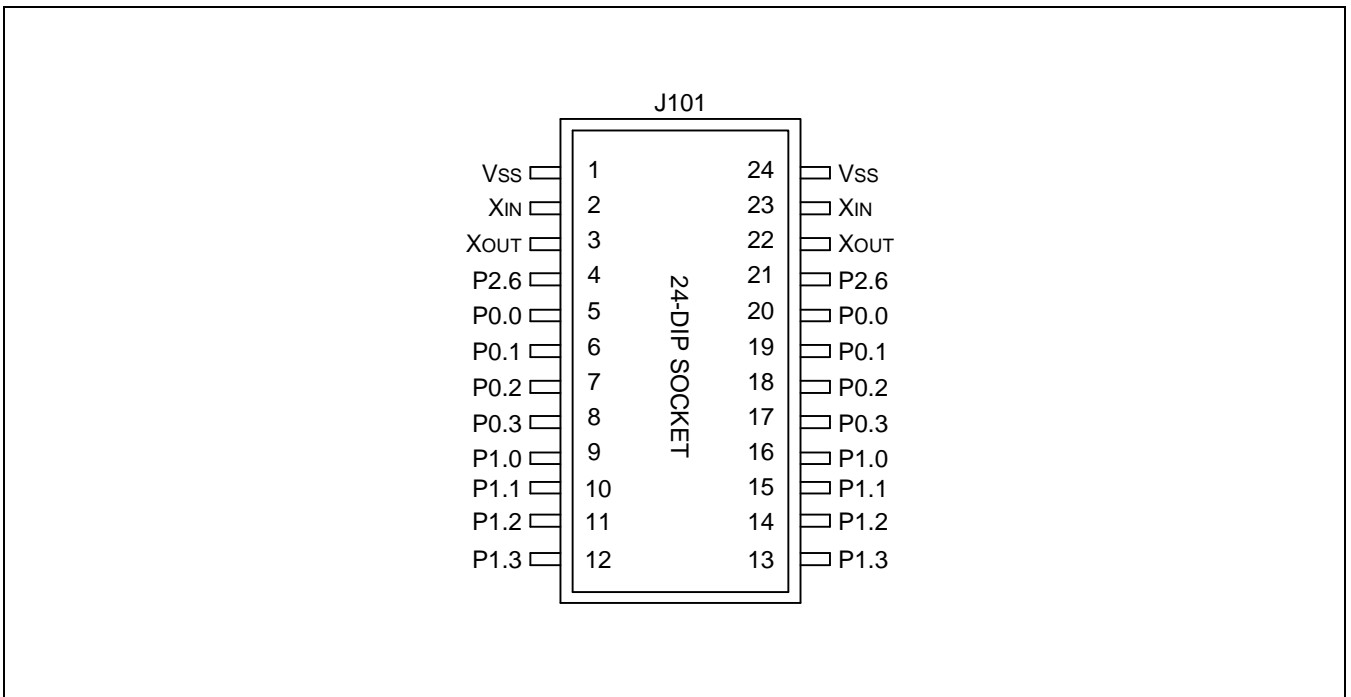
Figure 6-3. 24 DIP Socket for TB51840/51850A (S3C1840/C1850, 24 SOP)
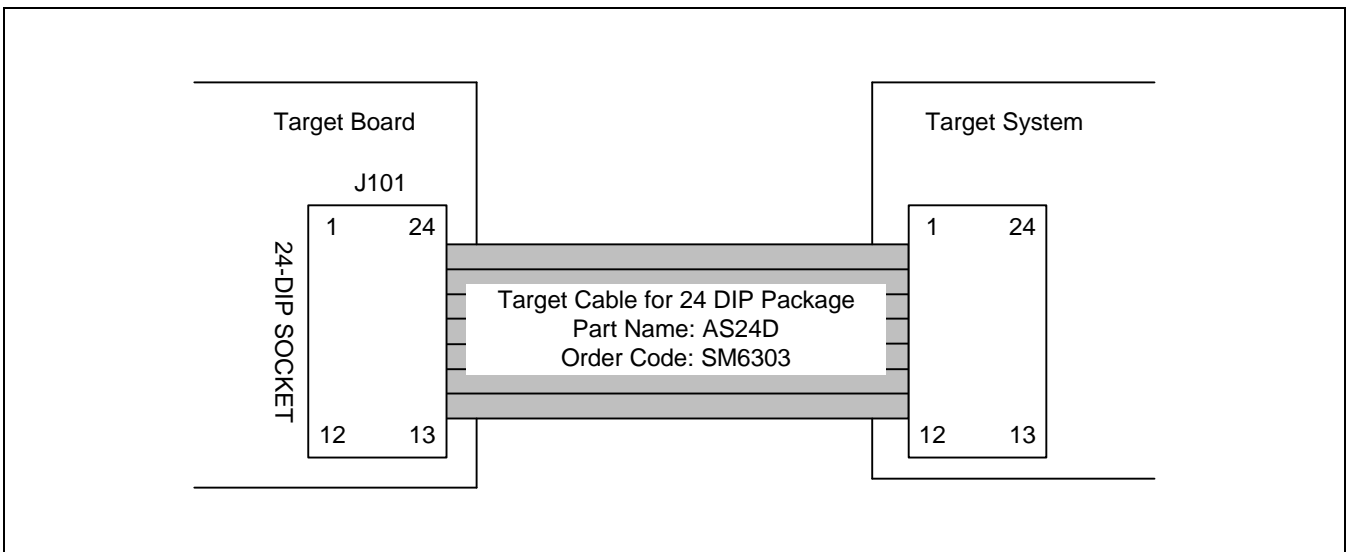
Figure 6-4. TB51840/51850A Cable for 24 DIP Package
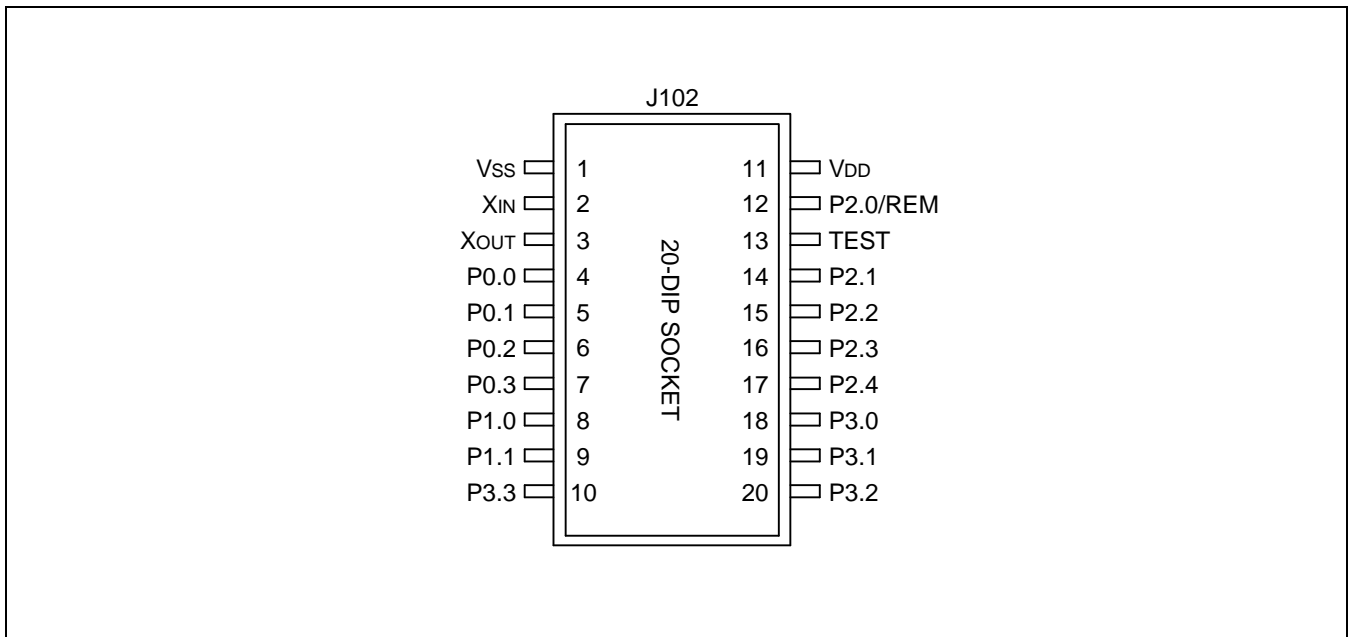
Figure 6-5. 20 DIP Socket for TB51840A (S3C1840/C1860, 20 DIP, 20 SOP)
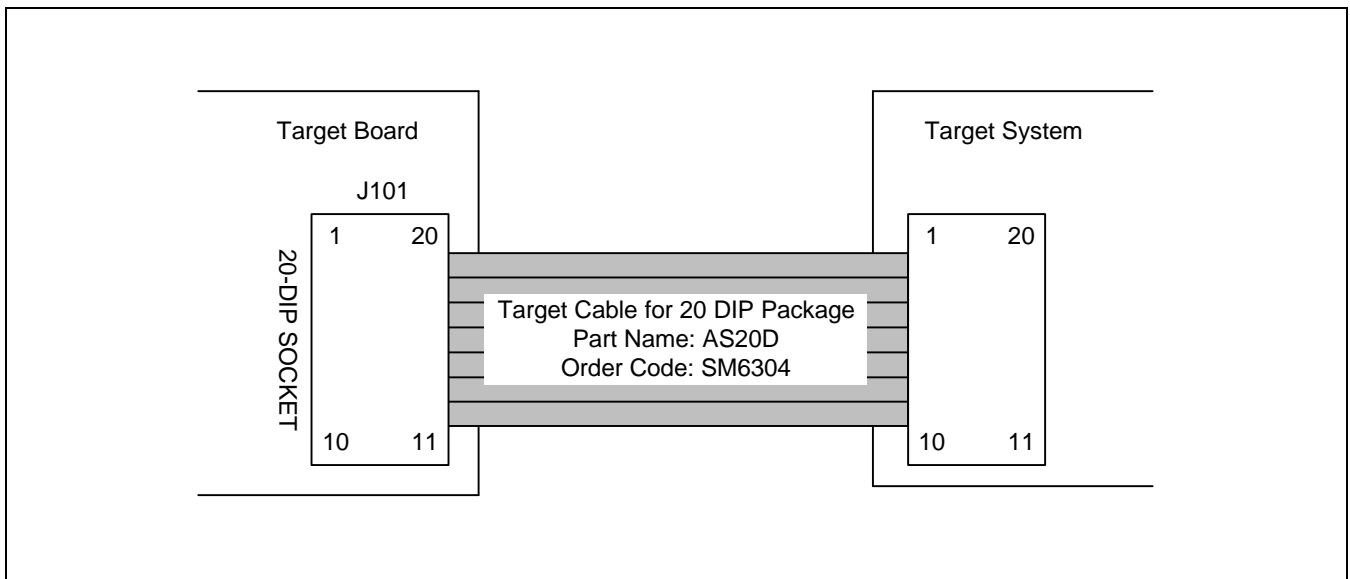
Figure 6-6. TB51840A Cable for 20 DIP Package

7. REMOTE CONTROL Tx. APPLICATION NOTE

DESCRIPTION OF THE S3C1840/C1850/C1860 MCUS

The S3C1840/C1850/C1860 4-bit single-chip CMOS microcontroller is designed using the reliable SMCS-51 CPU core with on-chip ROM and RAM. An auto-reset circuit generates a $\overline{\text{RESET}}$ pulse in regular intervals, and can be used to initiate a Halt mode release. The S3C1840/C1850/C1860 microcontroller is intended for use in small system control applications that require a low-power and cost-sensitive design solution. In addition, the S3C1840/C1850/C1860 has been optimized for remote control transmitters.

FEATURES

Table 7-1. S3C1840/C1850/C1860 Features

Feature	S3C1840	S3C1850	S3C1860
ROM	1024 bytes	1024 bytes	1024 bytes
RAM	32 x 4 bits	32 x 4 bits	32 x 4 bits
Carrier frequency	fxx/12, fxx/8, no carrier	fxx/12, fxx/8, no carrier	fxx/12, fxx/8, no carrier
Operating voltage	250 kHz $\leq f_{OSC} \leq$ 3.9 MHz 1.8 V to 3.6 V, 3.9 MHz $< f_{OSC} <$ 6 MHz 2.2 V to 3.6 V	250 kHz $\leq f_{OSC} \leq$ 3.9MHz 1.8 V to 3.6 V, 3.9 MHz $< f_{OSC} <$ 6 MHz 2.2 V to 3.6 V	250 kHz $\leq f_{OSC} \leq$ 3.9 MHz 1.8 V to 3.6 V, 3.9 MHz $< f_{OSC} <$ 6 MHz 2.2 V to 3.6 V
Low-Level Output Current P2.0 (IOL1)	**Typ. 3.0mA (at VO=0.4V)**	**Typ. 210mA (at VO=0.4V)** **Typ. 260mA (at VO=0.5V)**	**Typ. 280mA (at VO=0.4V)** **Typ. 320mA (at VO=0.5V)**
Package	**24 SOP, 20 SOP/DIP**	**24 SOP**	**20 SOP/DIP**
Piggyback	**O**	**O**	**x**
OTP	**x**	**x**	**O (S3P1860:divide-8 only)**
Tr. for I.R.LED drive	**x**	**Built-in**	**Built-in**
Power on reset circuit	**Built-in**	**Built-in**	**x**
Oscillation Start and reset circuit (OSR)	**x**	**x**	**Built-in**

Table 7-2. S3C1840/C1850/C1860 Package Types [note]

Item	24 pins	20 pins
Package	24 SOP-375	20 DIP-300A 20 SOP-300 20 SOP-375

NOTE : The S3C1850 has 24 pin package type only and S3C1860/S3P1860 has 20 pin package type only.

Table 7-3. S3C1840/C1850/C1860 Functions

	Description
Automatic reset by Halt mode release	When Halt mode is released, the chip is reset after an oscillator stabilization interval of 9 ms. (fxx = 455 kHz)
Output pin state retention function	When the system enters Halt Mode, P3.0-P3.3, P2.0, and P2.2-P2.5 go low level in 24 pins. P3.0-P3.3, P2.0, and P2.2-P2.4 go low level in 20 pins. **But the P2.0 is floating state in S3C1850/C1860. (NOTE)**
Auto-reset	With oscillation on and with no change to the IP2.0 output pin, a reset is activated every 288 ms at fxx = 455 kHz.
Osc. Stabilization time	CPU instructions are executed after oscillation stabilization time has elapsed.
Other functions	Carrier frequency generator. Halt wake-up function.

NOTE : The S3C1850 has 24 pin package type only and S3C1860 has 20 pin package type only.

RESET

The S3C1840/C1850 has three kinds of reset operations:

— POR (Power-On Reset)

— Auto-reset

— Automatic reset by Halt release

The S3C1860 has three kinds of reset operations;

— OSR (Oscillation Start and Reset)

— Auto-reset

— Automatic reset by Halt release

Power-On Reset Circuits
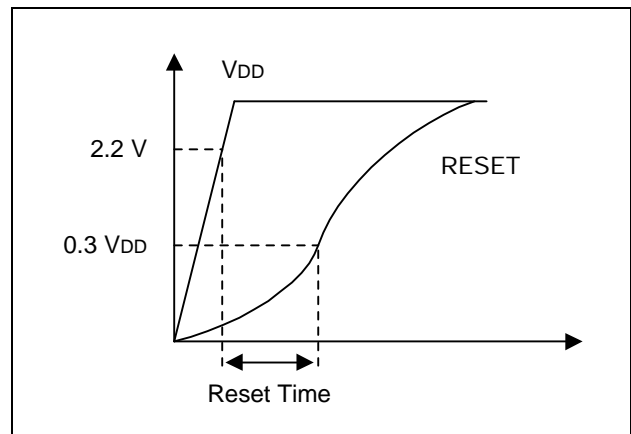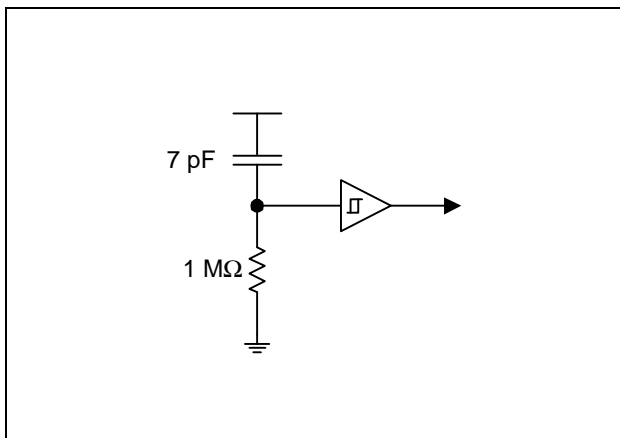
Figure 7-1. Power-On Reset Circuits

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Auto-Reset

The auto-reset function resets the CPU every 131,072 oscillator cycles (288 ms at fxx = 455 kHz). The auto-reset counter is cleared when a rising edge is detected at IP2.0, or by a $\overline{HALT}$ or $\overline{RESET}$ pulse.
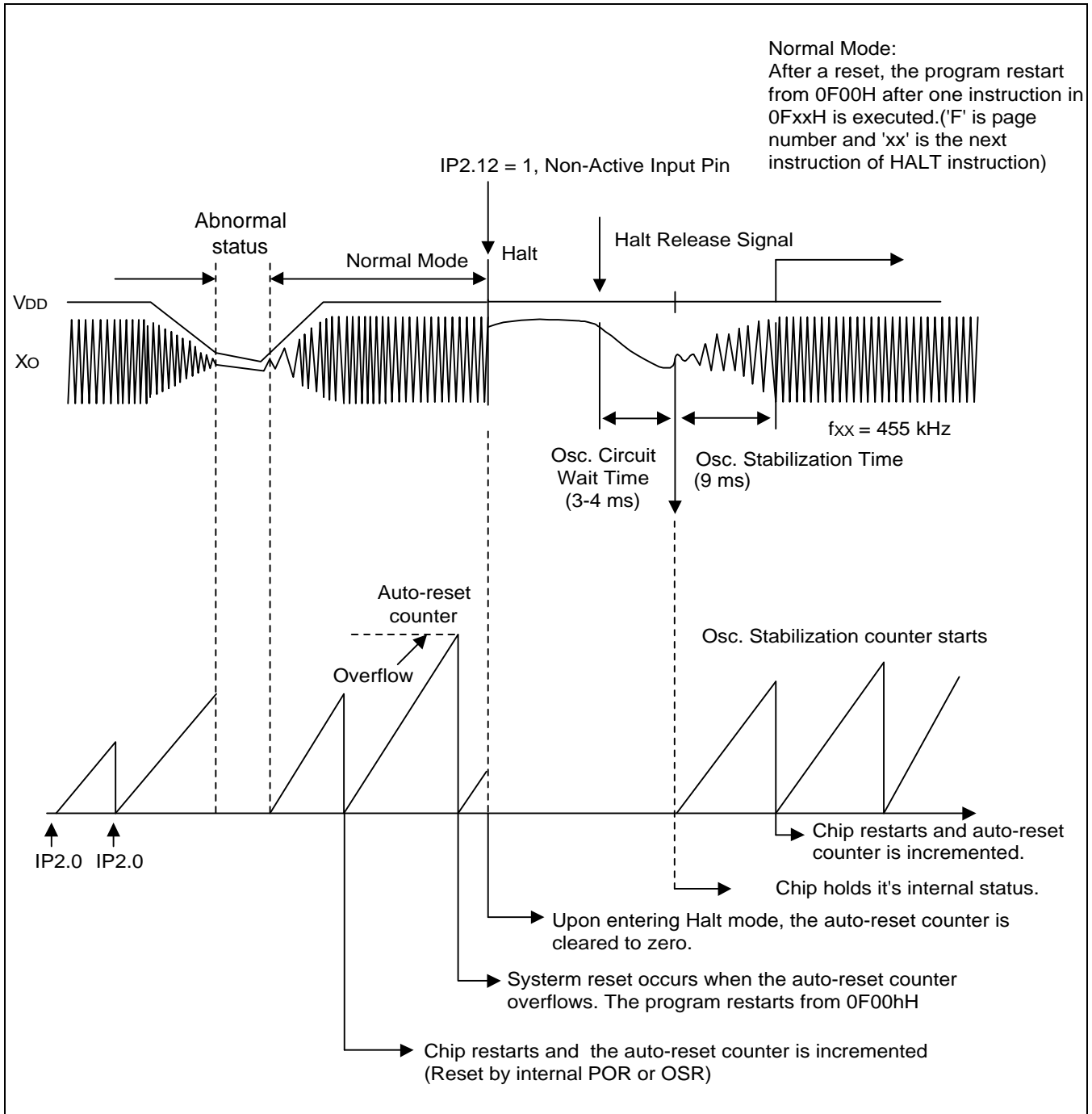
Figure 7-2. Auto-Reset Counter Function

NOTE : The OSR(Oscillation Start and reset) is not implemented for the S3C1840/C1850.

Automatic Reset by Halt Mode Release

This function resets the CPU by releasing Halt mode. The CPU is reset to its initial operating status and program execution starts from the reset address.

Halt Mode and Automatic Reset by Halt Release

Halt mode is used to reduce power consumption by stopping the oscillation and holding the internal state. Halt mode can be entered by forcing IP2.12 to high level (remaining input pins are non-active).

Before entering Halt mode, programmer should pre-set all key strobe output pins to active state even though Halt mode causes some pins to remain active.
For the 24 pins, P3.0-P3.3, P2.0, P2.2- P2.4, and P2.5 are sent low and for 20 pins, P3.0-P3.3, P2.0, P2.2-P2.4 are sent low, but the P2.0 is floating state in S3C1850/C1860.. Forcing any key input port to active state causes the clock oscillation logic to start system initialization.
At this time, the system is reset after the oscillation stabilization time elapses. A system reset causes program execution to start from address 0F00H.
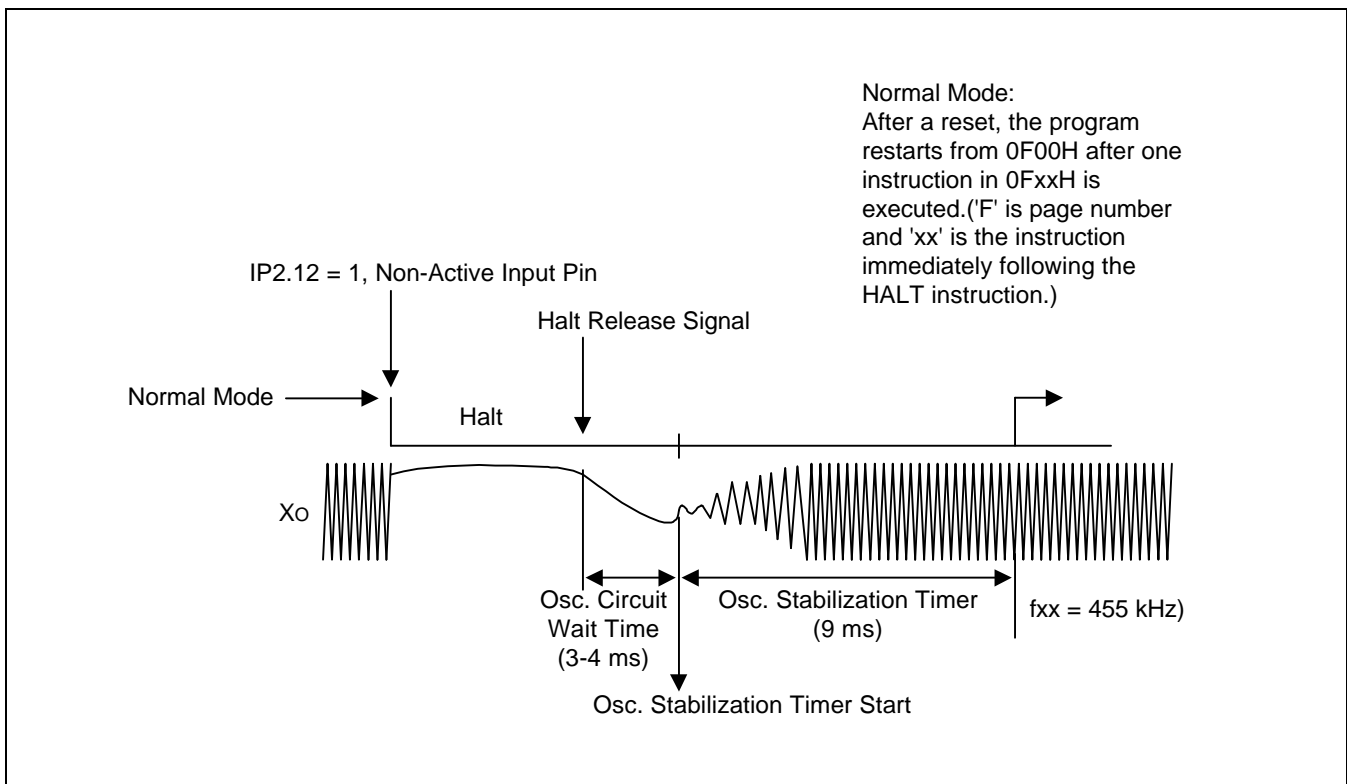
Figure 7-3. Reset Timing Diagram

HALT mode programming

The S3C1840/C1850/C1860 can enter Halt mode by setting the IP2.12 pin to high level and forcing P0 and P1 input to a normal state. If IP 2.12 is high and any input is active, the chip cannot enter Halt mode. Therefore, the next instruction is executed, which must be a clear command for IP2.12.

```
        MOV   L,#5
KEYOLO        CLRB  P2.(L)                ;  P2.5,4,3,2, ← Low
        DECS  L
        CPNE  L,#1
        JP    KEYOLO
        CLR   A                          ;  Acc. ← #0h
        OUT   P3,@SL+A                    ;  P3.0,1,2,3, ← Low
        MOV   L,#0DH
        CLRB  P2.(L)                      ;  Select the P0 input
        IN    A,P0
        INCS  A                           ;  P0 input check
        JP    .+2
        JP    KEYCHK                      ;  If any key pressed in P0, jump to KEYCHK routine
        SETB  P2.(L)                      ;  Select the P1 input
timea   IN    A,P0
        INCS  A                           ;  P1 input check
        JP    + 2
timeb   JP    KEYCHK                      ;  If any key pressed in P1, jump to KEYCHK routine
        MOV   L,#0CH                      ;  No key pressed
        SETB  P2.(L)                      ;  Halt mode
```

; When no key is pressed, the chip enters Halt mode. Pressing any key while in Halt mode causes the chip to be initialized and restarted from the reset address.
; If any key is pressed between time A and time B, the following instruction is executed.

```
        MOV   L,#0CH                      ;  These two instructions remove the condition of  re-entering

        CLRB  P2,(L)                      ;  Halt mode.
```

R E S E T **and** H A L T **Logic Diagram**
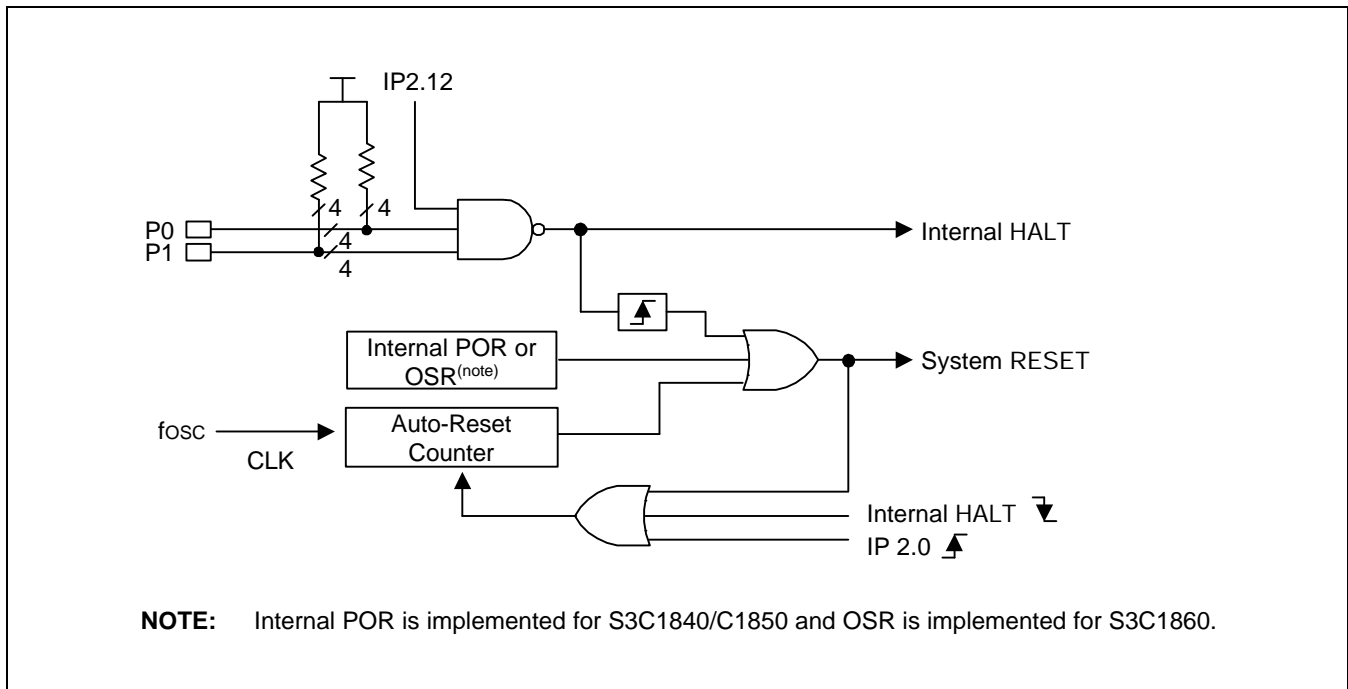
Figure 7-4. R E S E T **and** H A L T **Logic Diagram**

OUTPUT PIN DESCRIPTION

Indicator LED Drive Output

To drive the indicator LED, the programmer should use P2.1 of the S3C1840/C1850/C1860 (which have higher current drive capability than other pins) in order to retain the pre-programmed status during Halt mode. Be careful to turn on the LED when a reset signal is generated. Because a reset signal sends all of the internal and external output pins to low level, the programmer must set LED output P2.1 to high state using a reset subroutine.
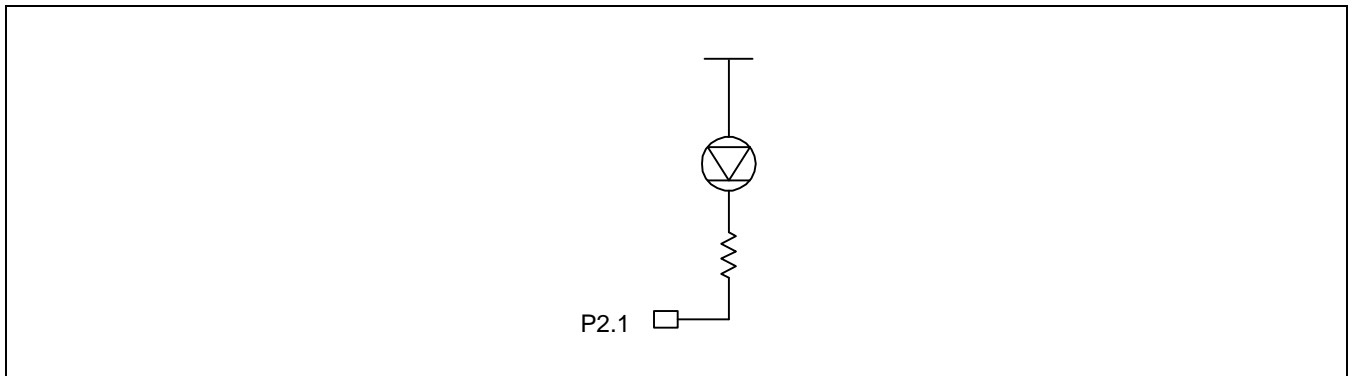
Figure 7-5. LED Drive Output Circuit

Strobe Output Option

To active the optional strobe output function for TV and VCR remocon applications, the programmer must use the option selection strobe output pin (P2.6).
This pin has lower current drive capability than other pins and retain the pre-programmed status while in Halt mode. Be careful to turn on the option strobe output pin when a reset signal is generated. Because the reset sends all internal and external output pins to low level, the option strobe output pin should always be non-active state (H-Z). The pin should be active only when you are checking option status to reduce current consumption.

Table 7-4. Strobe Output Option

Pin usage	Key Output	LED Drive	Option Selection
P3.0-P3.3, P2.2-P2.5	00	X	X
P2.1	0	00	0
P2.6	0	0	00

NOTE: X = not allowed
          0 = good
          00 = better

Output Pin Circuit Type
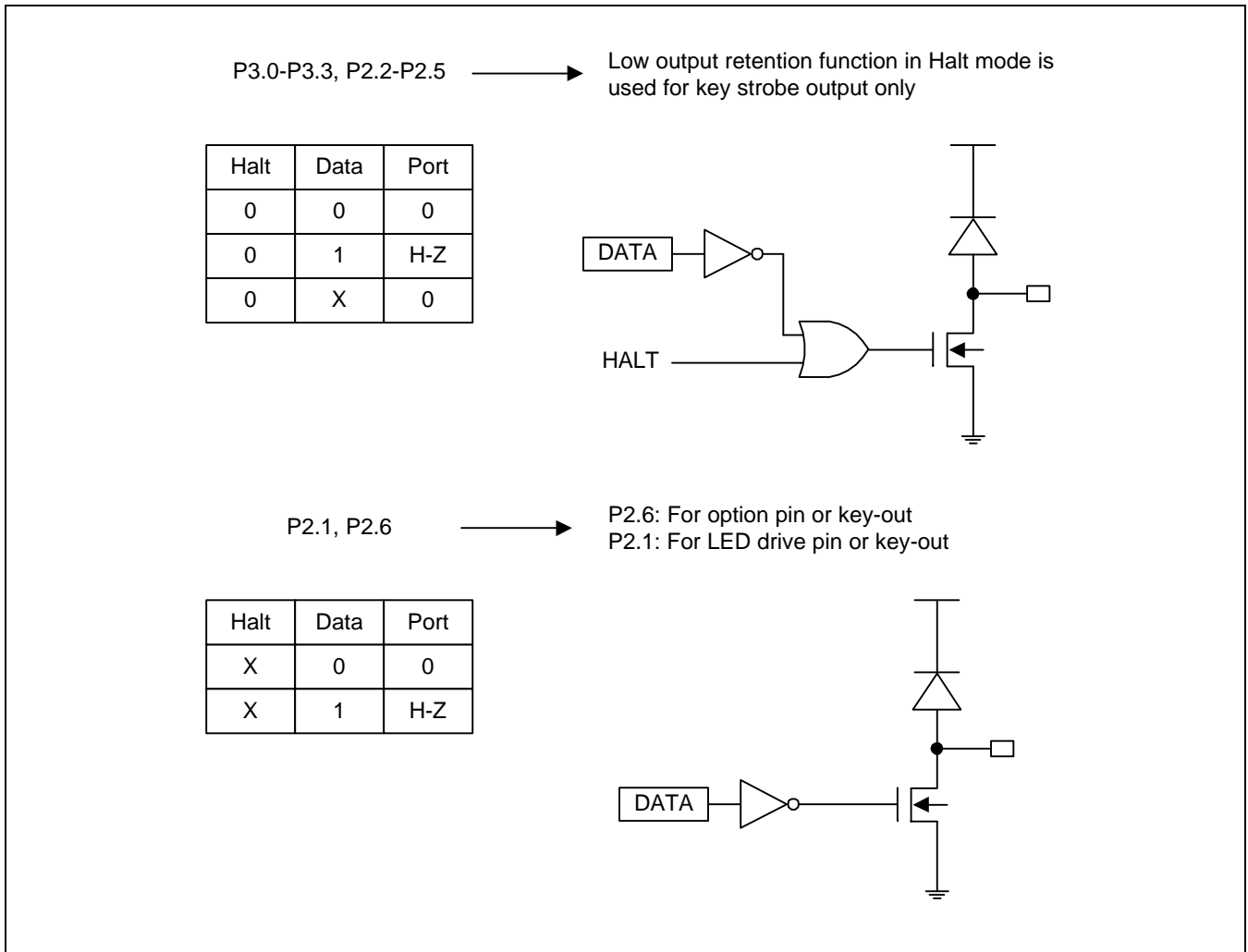
Figure 7-6. Output Pin Circuits

Soft Ware Delay Routine

To obtain a constant time value, the S3C1840/C1850/C1860 use a software delay routine (there is not an internal timer interrupt). One instruction cycle is six oscillator clocks. Using a ceramic resonator with a constant frequency, you can calculate the time delay as follows:

$$t = 6/f_{xx} \text{ Number of Instructions}$$

Where t: Elapsed time and f_{xx}: System clock.

Programming Tip

To program a 1-ms delay: 1 ms = 6/455 kHz x n, where f_{xx} = 455 kHz
Therefore, n = 75.8 = 76 instructions

```
DLY1MS      CLR         A

            ADDS        A,#0BH              ;   Two instructions

DLY         MOV         H,#0                ;   Dummy instruction

            MOV         H,#0                ;   Dummy instruction

            MOV         H,#0                ;   Dummy instruction

            MOV         H,#0                ;   Dummy instruction

            DECS        A

            JP          DLY                 ;   DLY loop: 6 instructions
```

;2 + (ACC + 1) x instructions in loop = 2 + (11 + 1) x 6 = 74

```
            CLR         A

            CLR         A                   ; Two instructions.
```

; Total number of instructions for DLY1MS is 76.

NOTE

In order to lengthen the delay time, you can use an arithmetic instruction combination of L register and Accumulator. The L register causes the address lower pointer to access RAM space and the output port pointer to control the P2 (individual/serial output) port status.

— RAM manipulation instruction: RAM address pointer.
    MOV   A,@HL   CPNE   @HL,A
    ADDS   A,@HL   SETB   @HL.b

— P2 output control instruction: P2 pointer.
    SETB   P2.(L)   CLRB   P2.(L)

PROGRAMMING GUIDELINES

When programming S3C1840/C1850/C1860 microcontroller, please follow the guidelines presented in this subsection.

PCB Artwork

For remote control applications, turning the I.R.LED on and off may cause variations in transmission current ranging from a few hundred μA to a few hundred mA. This current variation generates overshoot and undershoot noise on the power line, causing a system malfunction.
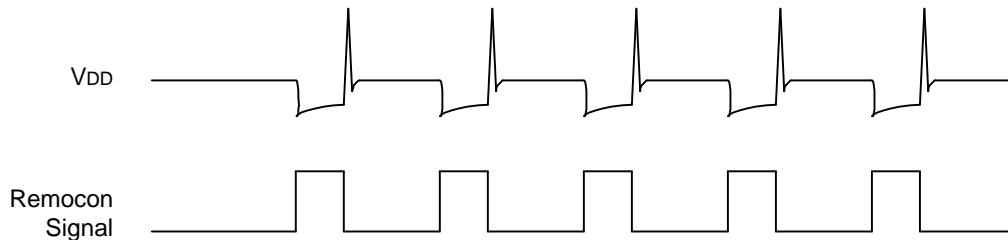
To reduce noise and to stabilize the chip's operation, we recommend that the application designer reduce overshooting of the I.R.LED drive current and design PCB for the remote controller as follows: (The noise level should be limited to around 0.5 V_{P-P}, where V_{P-P} is the peak-to-peak voltage)

— Oscillation circuit should be located as near as possible to the chip.
— PCB pattern for V_{DD}/V_{SS} should be as wide and short as possible.
— I.R.LED drive TR and I.R.LED should be located as far as possible from the chip.
— Power supply battery and power capacitor should be located as near as possible to the chip.
— The ground pattern of the TEST pin (Ground of I.R.LED drive TR) and V_{SS} pin should be separated and connected directly with the battery terminal.
— The ceramic capacitor (0.1uF or 0.01uF) and power capacitor(over 47uF) is recommended to use noise filter.
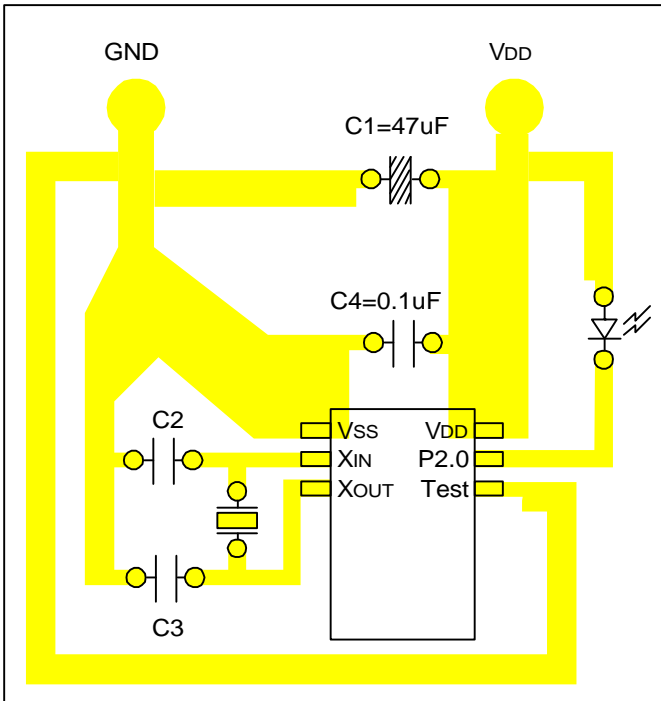
Recommended Artwork for S3C1850/C1860
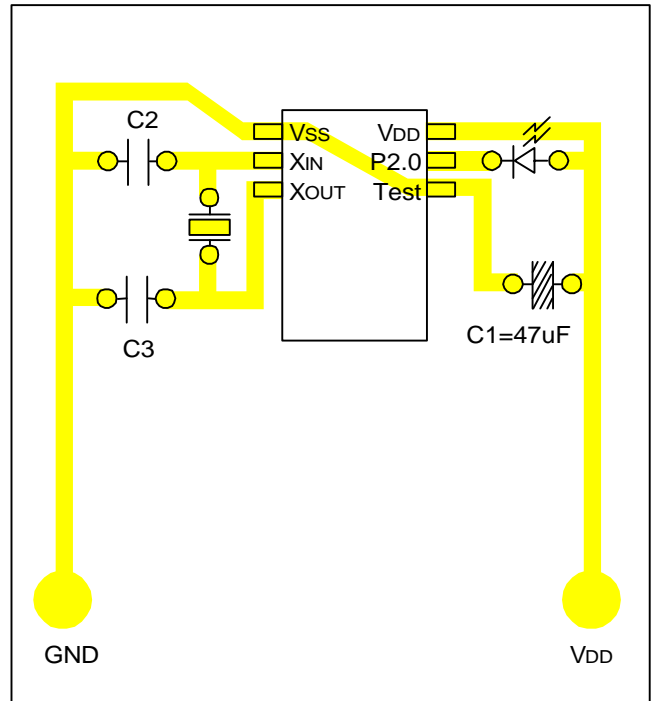
Unacceptable Artwork for S3C1850/C1860

SMDS

When a breakpoint or single-step instruction is executed in area of PAGE and JP or CALL instruction, the JP or CALL may jump to the wrong address, We therefore recommend using a JPL or CALL instruction (instead of PAGE and JP or PAGE and CALL) to avoid this problems. Note that JP and CALL are 2-byte instructions.

Programming Guidelines for Reset Subroutine

1. We recommend that you initialize a H register to either "0" or "4"

2. Do not write the instructions CALLL (PAGE + CALL) or JPL (PAGE + JP) to the reset address 0F00H. In other words, do not use a PAGE instruction at 0F00H.

3. Turn off the LED output pin.

4. To reduce current consumption, do not set the option output pin to active state.

5. Pre-set the remocon carrier frequency (to fxx/12, fxx/8, and so on) before remocon signal transmission.

6. Because the program is initialized by an auto-reset or Halt mode release, even in normal operating state, do not pre-set all RAM data. If necessary, pre-set only the RAM area you need.

7. Be careful to control output pin status because some pins are automatically changed to active state.

8. To enter Halt mode, the internal port, IP2.12, should be set to high level and all of the input pins should be set to normal state.

9. To release Halt mode, an active level signal is supplied to input pins. If pulse width is less than 9 ms at fxx = 455 kHz, nothing happens and program re-enters Halt mode. That is, the external circuit should maintain the input pulse over a 9-ms interval in order to release Halt mode. After Halt mode is released, the hardware is reset. The hardware reset sends all internal and external output pins low (except P2.0 in S3C1850/C1860) and clears the stack to zero. However, H,L and A registers retain their previous status.

10. If a rising edge is not generated at IP2.0, reset signal occurs every 288 ms at fxx = 455 kHz. To prevent an auto-reset, IP2.0 should be forced low and then high at regular intervals (within 288 ms at fxx = 455 kHz).

S3C1840 Application Circuit Example
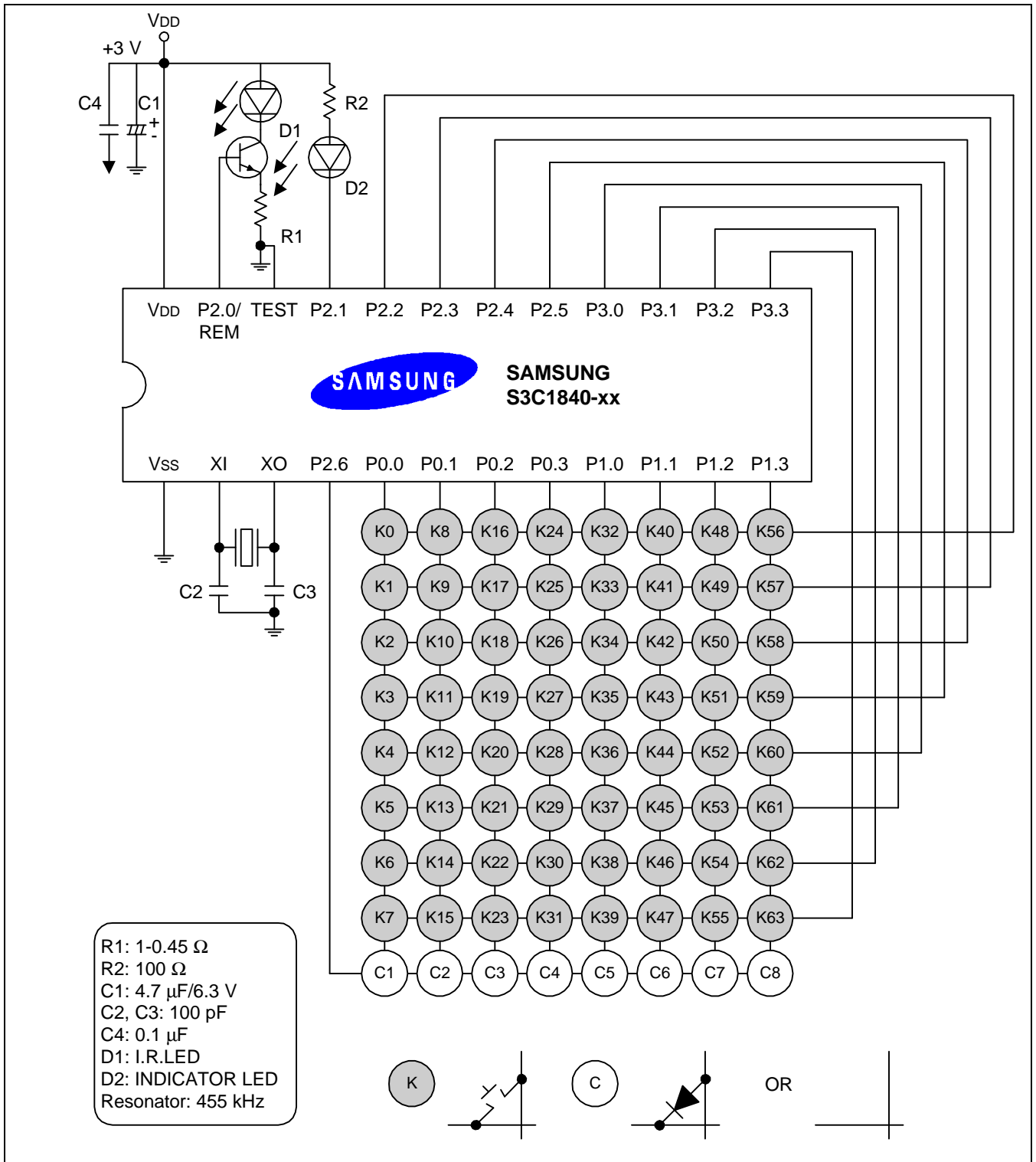
Figure 7-7. S3C1840 Applicatrion Circuit Example

S3C1850 Application Circuit Example
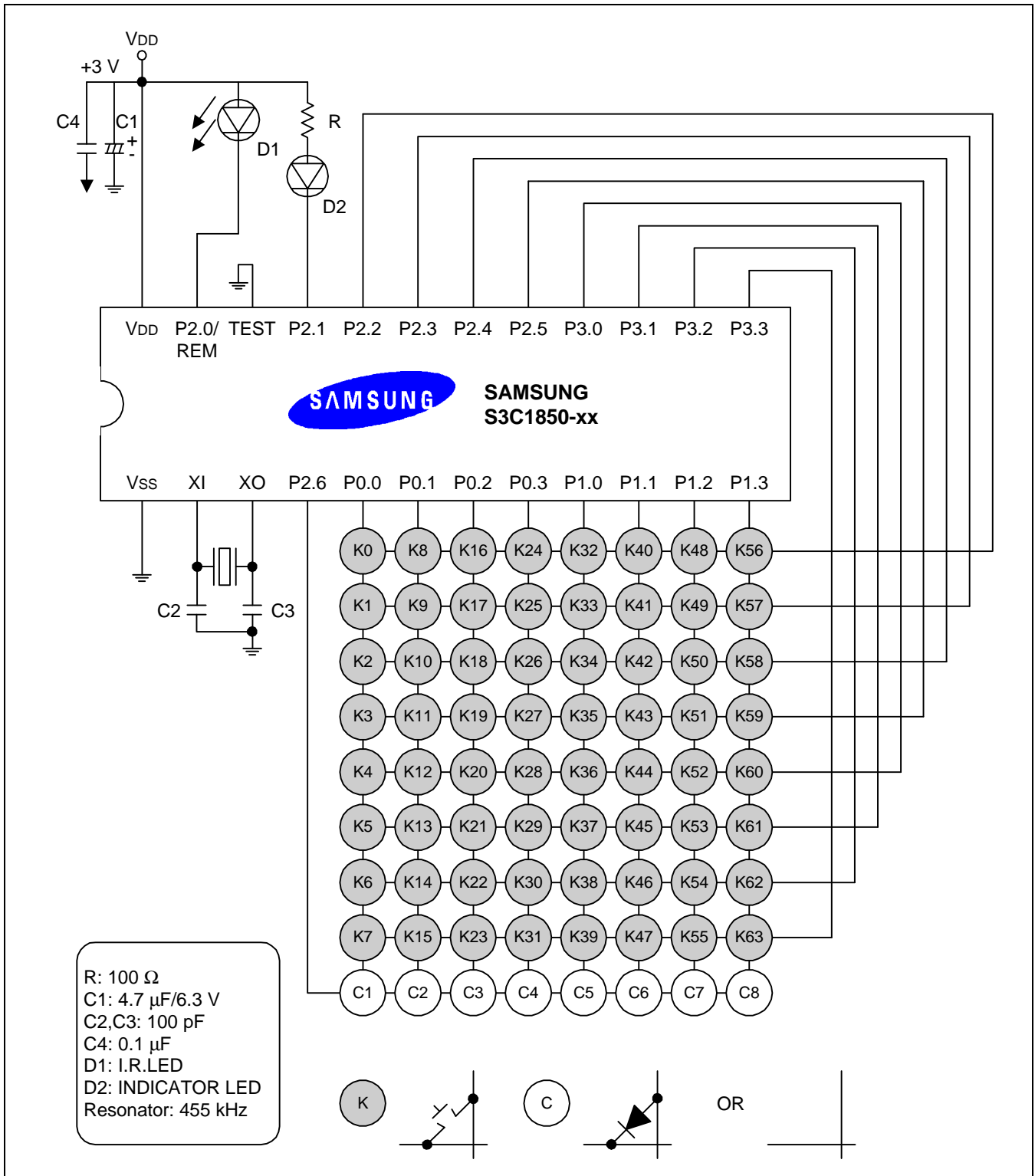
Figure 7-8. S3C1850 Application Circuit Example

S3C1860 Application Circuit Example
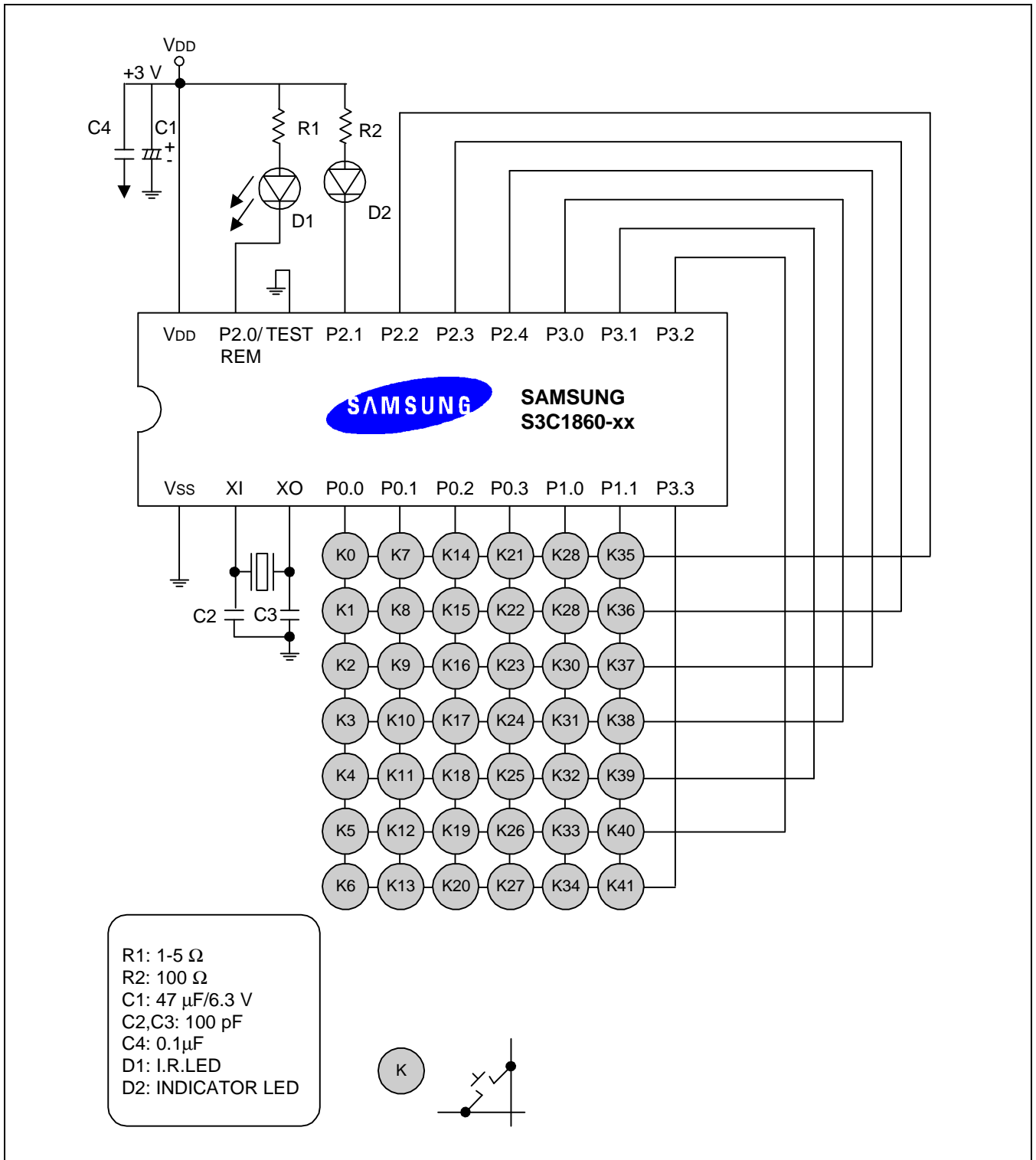
Figure 7-9. S3C1860 Application Circuit Example

Program Flowchart (This program is only apply to S3C1840)

RESET

START

All key strobe output pins are active

Any key input?   Yes

HALT

No

MAIN

All key strobe output pins are non-active

KEYSCAN

Only one key strobe pin is active

One key input?   No

Double Key & No Key

Yes

No   Debounce Time = 0?

Yes

DATCUS

Data & Custom Code Generator

SIGNAL Tx.   No   Continous key?   Yes

Transmit Two Waveforms

Transmit Repeat Waveforms

Reset Debounce Time

MAIN
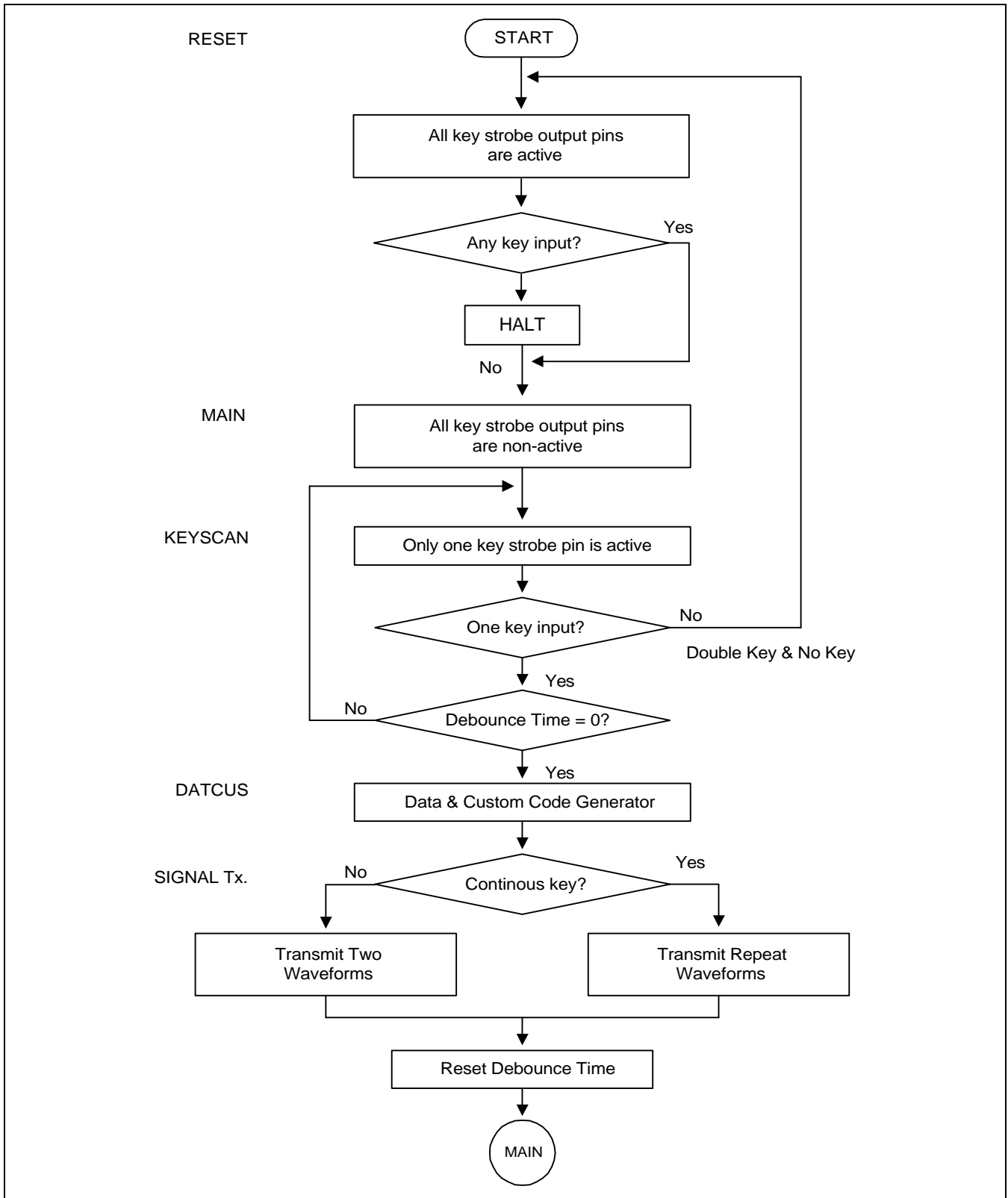
Figure 7-10. Program Flowchart 1

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S3C1840/C1850 KEYSCAN FUNCTION

Description

This program has an 8 x 9 key matrix, which consists of input P0 and P1 and output P2 and P3. Because pull-up resistors are connected, the normal state for all input pins is high level. The operating method for the keyscan function is as follows:

— All output pins remain active state (= low).

— If key is pressed, set all output pins to non-active state and rotate the pins to set only a pin to active state during debounce time.

— If key is pressed more than one or if no key is pressed, go to reset label.

— If a new key is pressed, reset debounce time, continuous flag, and key-in flag.

RAM Assignment

H register selects #0

HL ⟶ 00H   01H   05H   09H

O_INP0	N_INP0	O_INP1	N_INP1	O_OUTP	N_OUTP	I_TWICE	DEBOCNT	CONKEY	KFLG

O_INP0:   The old value of P0

N_INP0:   The new value of P0

O_INP1:   The old value of P1

N_INP1:   The new value of P1

O_OUTP: The old value of output port

N_OUTP: The new value of output port

I_TWICE: Double number increment

DEBOCNT: Debounce time

CONKEY: Continuous key flag

KFLG: key input flag

Program Flowchart (This program is only apply to S3C1840)
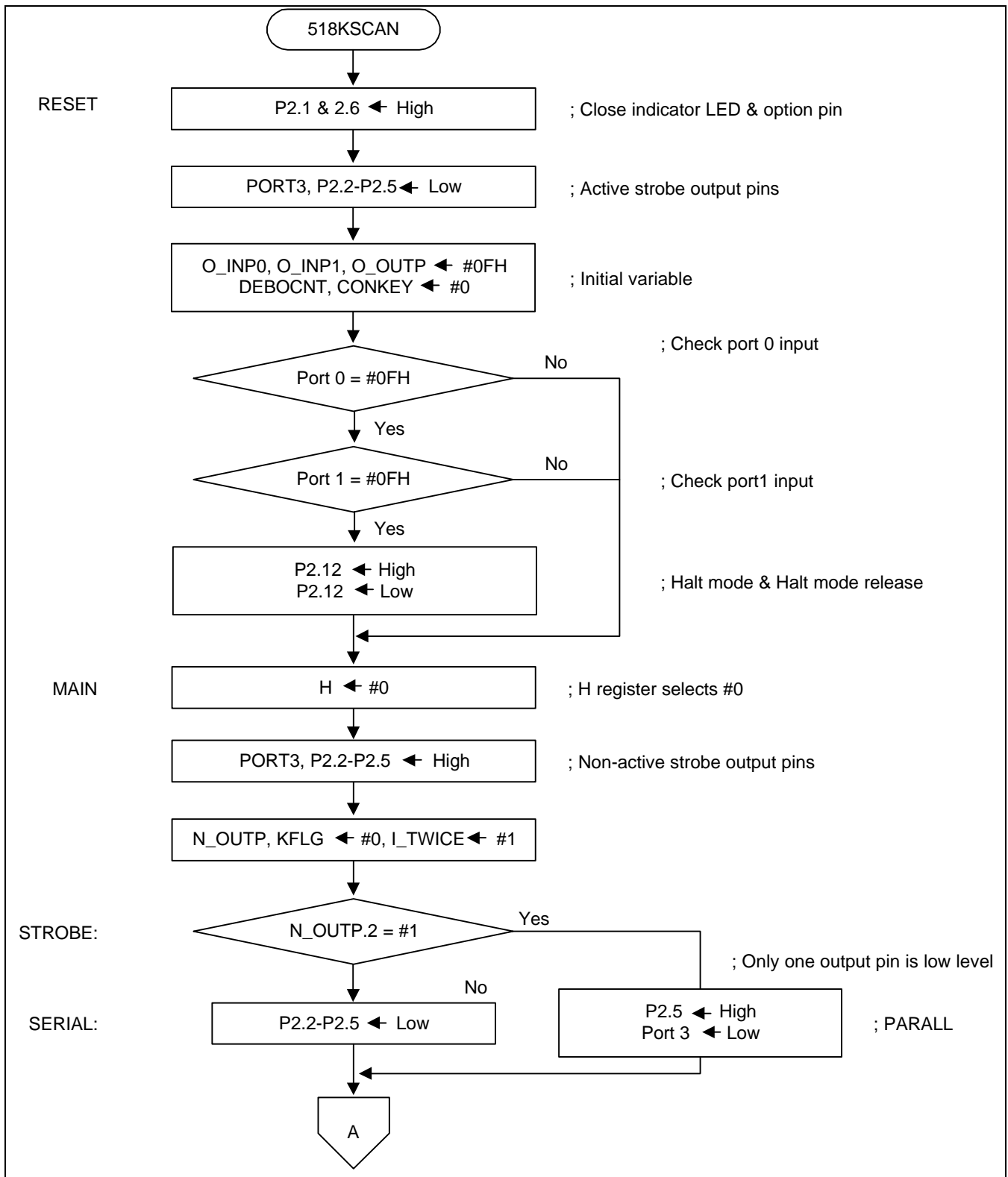
Figure 7-11. Program Flowchart 2
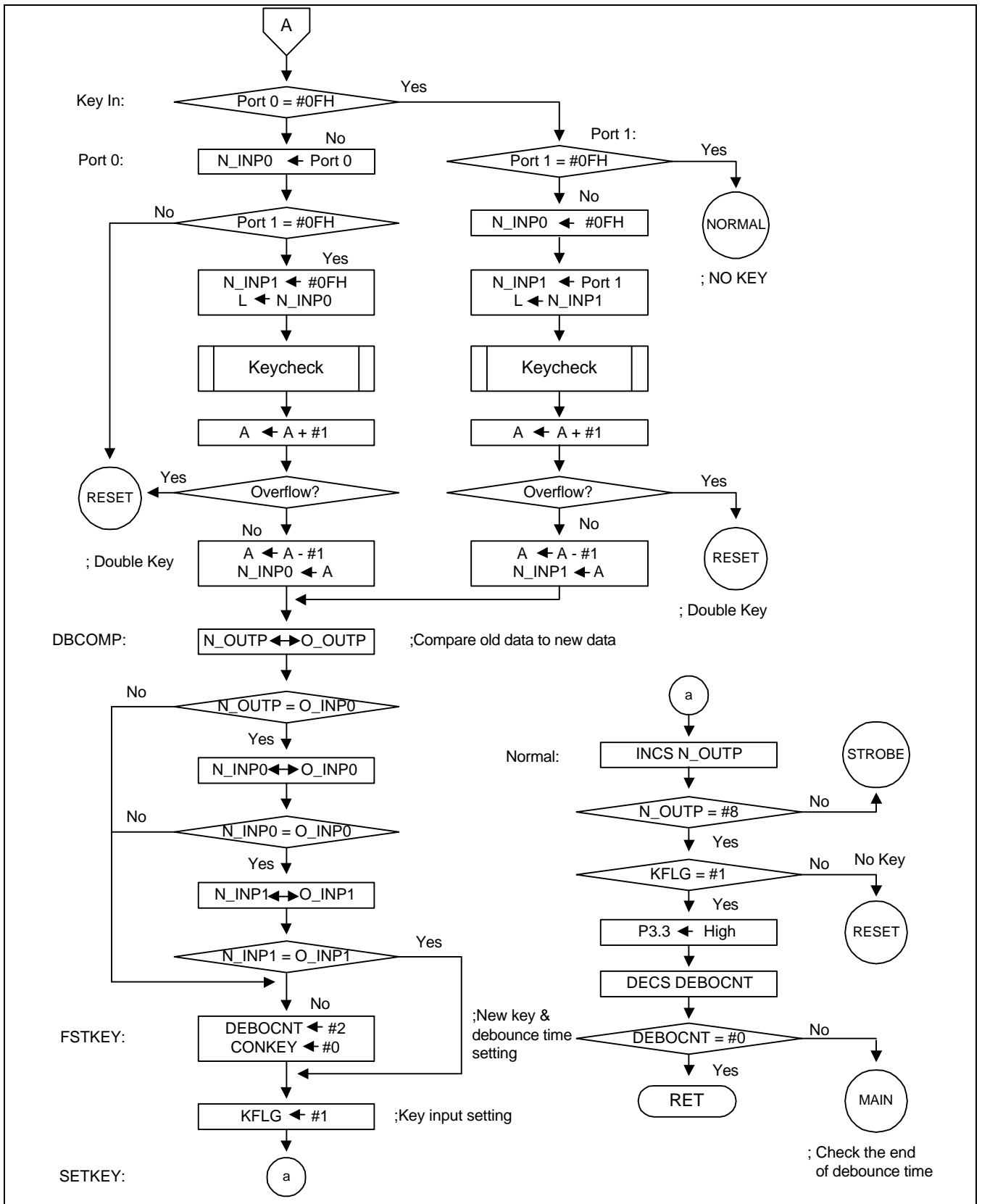
Figure 7-12. Program Flowchart 3

S3C1840/C1850 Keycheck Subroutine
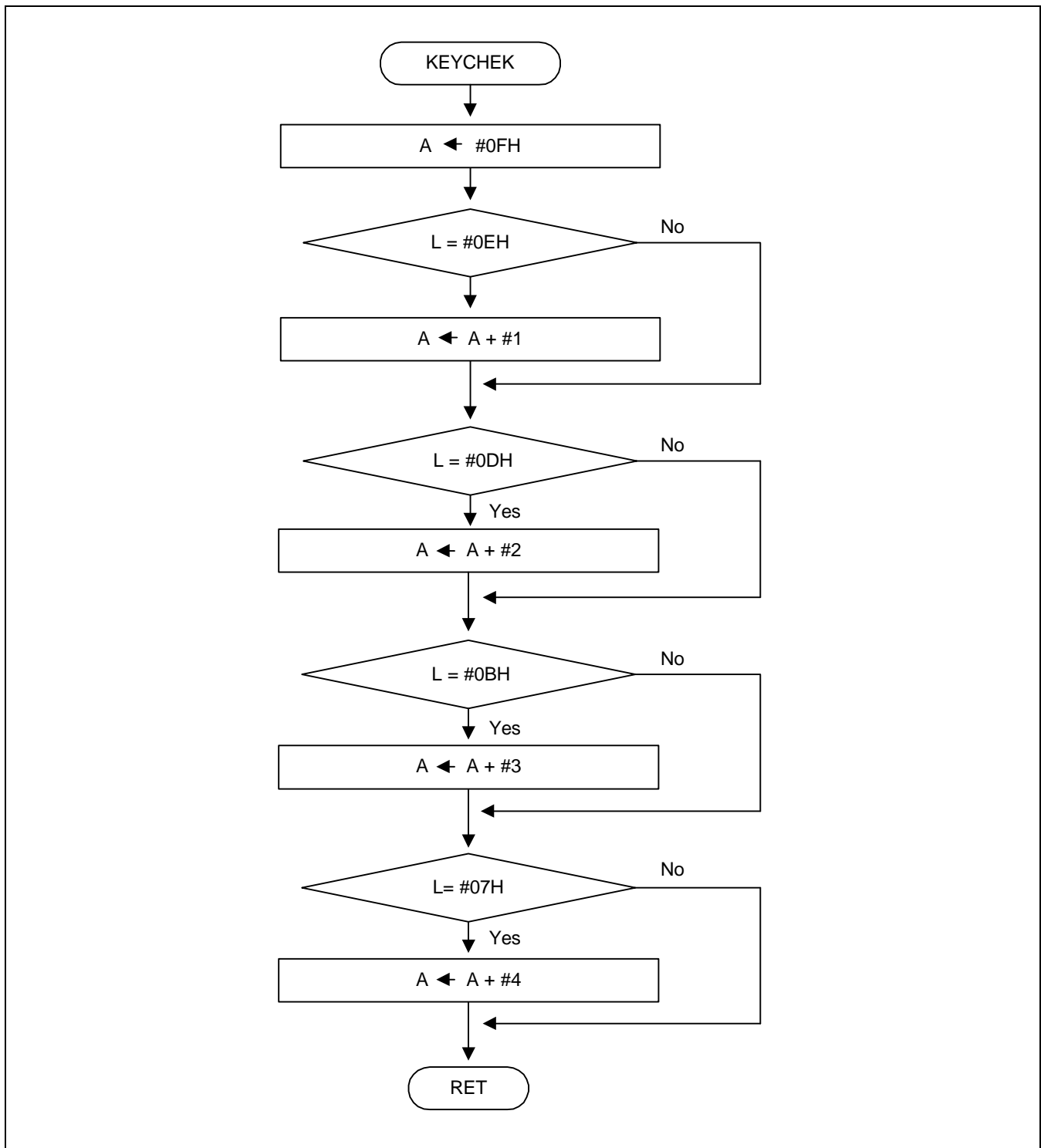
Figure 7-13. S3C1840/C1850 Keycheck Subroutine

```
;*********************************************
;
            ORG         0F00H

;*********************************************
;
; If reset occurs, PA register is immediately initialized to #0FH

RESET       MOV         L,#1                    ;   close indicator LED
            SETB        P2.(L)                  ;
            MOV         L,#6                    ;   non-select P2.6
            SETB        P2.(L)                  ;

PRTCLR      CLR         A                       ;
            OUT         P3,@SL + A              ;   low all the output ports
            MOV         L,#5                    ;   (except P2.0, P2.1, P2.6)
            CLRB        P2.(L)                  ;
            DECS        L                       ;
            CPNE        L,#1                    ;
            JP          .-3                     ;

;;; initial all of the variables ---------------------------------------------
;;; → input ports are connected with pull-up resistor
;;; → Therefore, normal state → high
            MOV         H,#0                    ;   H register selects file #0
            MOV         L,#O_INP0               ;   port0 is #0fh
            MOV         @HL+,#0FH
            MOV         L, #O_INP1              ;   port1 is #0fh
            MOV         @HL +,#0FH
            MOV         L, #O_OUTP              ;   the strobe out is #0fh
            MOV         @HL+,#0FH
            MOV         L,#DEBOCNT              ;   debounce count is #0
            MOV         @HL+,#0
            MOV         L,#CONKEY               ;   continuous key is #0
            MOV         @HL+,#0

;;; check each input port (=key input) ----------------------------------
            MOV         L,#0DH                  ;   check port0
            CLRB        P2.(L)                  ;
            IN          A,P0                    ;
            MOV         L,A                     ;
            CPNE        L,#0FH                  ;
            JP          DELAYP0                 ;
            MOV         L,#0DH                  ;   check port1
            SETB        P2.(L)                  ;
            IN          A,P0                    ;
            MOV         L,A                     ;
            CPNE        L,#0FH                  ;
            JP          J_MAIN                  ;

;;; halt mode, after halt mode release, go to reset -----------------
            MOV         L,#0CH
            SETB        P2.(L)                  ;   halt mode
            CLRB        P2.(L)                  ;   halt mode release
            JP          RESET
```

```
PRTSET    CLR       A                    ;
          ADDS      A,#0FH               ; high all the output ports
          OUT       P3,@SL+A             ; (P3, P2.2-P2.5)
          MOV       L,#5                 ;
          SETB      P2.(L)               ;
          DECS      L                    ;
          CPNE      L,#1                 ; If P2.0 is high, data Tx.
          JP        .- 3                 ; and auto reset counter clear
          RET

DELAYP0   MOV       H #0                 ; for the match of delay time
          MOV       H #0                 ;
          MOV       H #0                 ;
          MOV       H #0                 ;
          MOV       H #0                 ;
          MOV       H #0                 ;
J_MAIN    JPL       MAIN
;
;
;
.*******************************************
;
          ORG       0000H
          JPL       RESET
.*******************************************
;
MAIN      MOV       H,#0                 ; H regisster selects file #0
                                         ; useful when continous pulse Tx.
                                         ;
          CALLL     PRTSET               ; high all the output ports

;;; initial useful variable in main routine ------------------------------------

          MOV       L,#N_OUTP            ; N_OUTP ← #0
          MOV       @HL+,#0              ;
          MOV       L,#1_TWICE           ; I_TWICE (double increment) ← #1
          MOV       @HL+,#1              ;
          MOV       L,#KFLG              ; KFLG ← #0 (input key flag)
          MOV       @HL+,#0              ;

;; select output pin by one and one --------------------------------

STROBE    MOV       L,#N_OUTP
          CPBT      @HL.2                ; If N_OUTP.2 is set, go to parall (parallel port)
          JP        PARALL               ; otherwise, go to serial (serial port)
SERIAL    MOV       L,@HL                ;
          INCS      L                    ;
          SETB      P2.(L)               ; low P2.2-P2.5
          INCS      L                    ;
          CLRB      P2.(L)               ;
          JPL       KEYIN

PARALL    MOV       L,#5                 ; high P2.5
          SETB      P2.(L)               ;
```

```
...************************************************
;''
;;; A ← #0h
;;; A ← A-1_TWICE
;;; output P3
;;; I_TWICE ← I_TWICE + I_TWICE
... .************************************************
;''' '
              CLR     A                    ;  A ← #0FH
              ADDS    A, #0FH              ;
              MOV     L, #1_TWICE          ;
              XCH     @HL,A                ;  A ← A-I_TWICE
              SUBS    A,@HL                ;
              OUT     P3,@SL+A             ;  low port3
              SUBS    A,@HL                ;
              MOV     @HL,A                ;  recover I_TWICE
              ADDS    A,@HL                ;
              MOVZ    @HL,A                ;  I_TWICE ← I_TWICE + I_TWICE
              JPL     KEYIN
...************************************************
;''
;; check double key at each port
;; if a key pressed, do adds instruction
;; otherwise, induce overflow occurrence
...************************************************
;''
KEYCHEK   CLR     A
              ADDS    A,#0FH               ;  A ← #0fh
              CPNE    L,#0EH
              JP      .+2
              ADDS    A,#1                 ;  A ← #0
              CPNE    L,#0DH
              JP      .+2
              ADDS    A,#2                 ;  A ← #1
              CPNE    L,#0BH
              JP      .+2
              ADDS    A,#3                 ;  A ← #2
              CPNE    L,#7
              JP      .+2
              ADDS    A,#4                 ;  A ← #3
              RET

;
;
; ************************************************
;
              ORG     0100H
              JPL     RESET
; ************************************************
;
KEYIN     MOV     L,#0DH
              CLRB    P2.(L)

;;; select port0 -------------------------------
              IN      A, P0
              MOV     L,A
              CPNE    L,#0FH               ;  is key pressed in port0 ?
              JP      PORT0
              JP      PORT1
```

```
PORT0     MOV       L,#N_INP0                    ;  setting at N_INP0
          MOV       @HL,A                        ;
          MOV       L,#ODH                       ;
          SETB      P2.(L)                       ;
          IN        A,P0                         ;
          MOV       L,A                          ;
          CPNE      L,#0FH                       ;
          JP        DBKEY                        ;  If also port1 input a key,
                                                 ;  it is double key
          MOV       L,#N_INP1                    ;  Only N_INP0 input
          MOV       @HL+,#0FH                    ;  but N_INP1 is set to #0fh
          MOV       L,#N_INP0                    ;
          MOV       L,@HL                        ;
          CALLL     KEYCHEK                      ;
          ADDS      A,#1                         ;
          JP        DBKEY                        ;  if overflow occurs, it is double key
          DECS      A                            ;  because input value ranges
          MOV       L,#N_INP0                    ;  from #0  to  #3
          MOVZ      @HL,A                        ;  N_INP0 ← A
          JPL       DBCOMP
```

;;; select port1 -------------------------------

```
PORT1     MOV       L,#0DH
          SETB      P2.(L)
          IN        A,P0
          MOV       L,A
          CPNE      L,#0FH                       ;  is key pressed in port 1?
          JP        .+3
          JPL       NORMAL                       ;  no key, go  to NORMAL
          MOV       L,#N_INP0                    ;  setting N_INP0  to  #0fh
          MOV       @HL+,#0FH                    ;  Only N_INP1 input
          MOV       L,#N_INP1                    ;
          MOV       @HL,A                        ;
          MOV       L,A                          ;  L ← N_INP1
          CALLL     KEYCHEK
          ADDS      A,#1                         ;  if overflow occurs, go to double key
          JP        DBKEY                        ;
          DECS      A                            ;  because input value ranges from
                                                 ;  #0  to  #3
          MOV       L,#N_INP1                    ;  N_INP1 ← A
          MOVZ      @HL,A
          JPL       DBCOMP
```

;;; if double key occurs, go to reset -------------------------------

```
DBKEY     JPL       RESET
;
;
```

```
. *********************************************
;
          ORG         0200H
          JPL         RESET

. *********************************************
;

;;; compare for the recognition of a new key----------------------

DBCOMP    MOV         H,#N_OUTP           ;  compare N_OUTP  to      O_OUTP
          MOV         A,@HL
          MOV         L,#O_OUTP
          XCH         @HL,A
          CPNE        @HL,A
          JP          FSTKEY
          MOV         L,#N_INP0           ;  compare N_INP0  to  O_INP0
          MOV         A,@HL
          MOV         L,#O_INP0
          XCH         @HL,A
          CPNE        @HL,A
          JP          FSTDLY
          MOV         L,#N_INP1           ;  compare N_INP1  to  O_INP1
          MOV         A,@HL
          MOV         L,#O_INP1
          XCH         @HL,A
          CPNE        @HL,A
          JP          FSTKEY
          JP          SETKEY

FSTDLY    MOV         H,#0                ;  for match of delay time
          MOV         H,#0
          MOV         H,#0
          MOV         H,#0
          MOV         H,#0

;;; when new key input ---------------------------

FSTKEY    MOV         L,#DEBOCNT          ;  DEBOCNT ← #2
          MOV         @HL+,#2
          MOV         L,#CONKEY           ;  CONKEY ← #0
          MOV         @HL+,#0
SETKEY    MOV         L,#KFLG             ;  KFLG ← #1
          MOV         @HL+,#1
```

```
; *********************************************
;
;;; increase N_OUTP
;;; check N_OUTP is equal to #8
;;; check no key (= DEBOCNT)
; *********************************************
;

NORMAL      MOV       L,#N_OUTP              ;  increase N_OUTP
            INCS      A,@HL
            MOVZ      @HL,A
            ADDS      A,#8                   ;  A ← #8
            CPNE      @HL,A                  ;  compare N_OUTP to A
            JP        J_STRO                 ;  go to stroble label
            MOV       L,#KFLG                ;
            CPBT      @HL.0                  ;  check key flag
            JP        ONKEY
            JPL       RESET                  ;  no key

ONKEY       CLR       A
            ADDS      A,#0FH
            OUT       P3,@SL + A             ;  set port3 to '1'
            MOV       L,#DEBOCNT             ;  decrease DEBOCNT
            DECS      A,@HL
            XCH       @HL,A
            CPNZ      @HL                    ;  compare DEBOCNT TO #0
            JP        J1_MAIN
            JPL       KEYSCAN
J1_MAIN     JPL       MAIN
J_STRO      JPL       STROBE
```

S3C1840/C1850 CODE GENERATION

Description

This program generates data code and custom code. The custom code is determined according to diodes between input ports and output pin (P2.6). The data code is as follows:

RAM ← DAT0 (D0-D3), DAT1 (D4-D7)

	D0	D1	D2	D3	D4	D5	D6	D7
KEY0	0	0	0	0	0	0	0	0
KEY1	1	0	0	0	0	0	0	0
. .				.				
KEY31	1	1	1	1	1	0	0	0
KEY32	0	0	0	0	0	0	1	0
KEY33	1	0	0	0	0	0	1	0
. .				.				
KEY63	1	1	1	1	1	0	1	0

RAM ← DAT0 (D0-D3), DAT1_0 (D4-D7)

	D0	D1	D2	D3	D4	D5	D6	D7
KEY0	0	0	0	0	0	0	0	0
KEY1	1	0	0	0	0	0	0	0
. .				.				
KEY31	1	1	1	1	1	0	0	0
KEY32	0	0	0	0	0	1	0	0
KEY33	1	0	0	0	0	1	0	0
. .				.				
KEY63	1	1	1	1	1	1	0	0

RAM Assignment

H register selects #4

HL → 40H   41H   45H   49H

CUS0	CUS1	CUS2	CUS3	DAT0	DAT1	DAT2	DAT3	DAT1_0	DAT3_0

CUS0;	Custom code (c0-c3)
CUS1:	Custom code (c4-c7)
CUS2:	The complement of CUS0
CUS3:	The complement of CUS1
DAT0:	Data code (d0-d3)]
DAT1:	Data code (d4-d7)
:	→ 32 key: 00000010, 63 key: 1111010
DAT2:	The complement of DAT0
DAT3:	The complement of DAT1
DAT1_0	Data code (d4-d7)
:	→ 32 key: 00000100, 63 key: 1111100
DAT3_0	The complement of DAT1_0

Program Flowchart
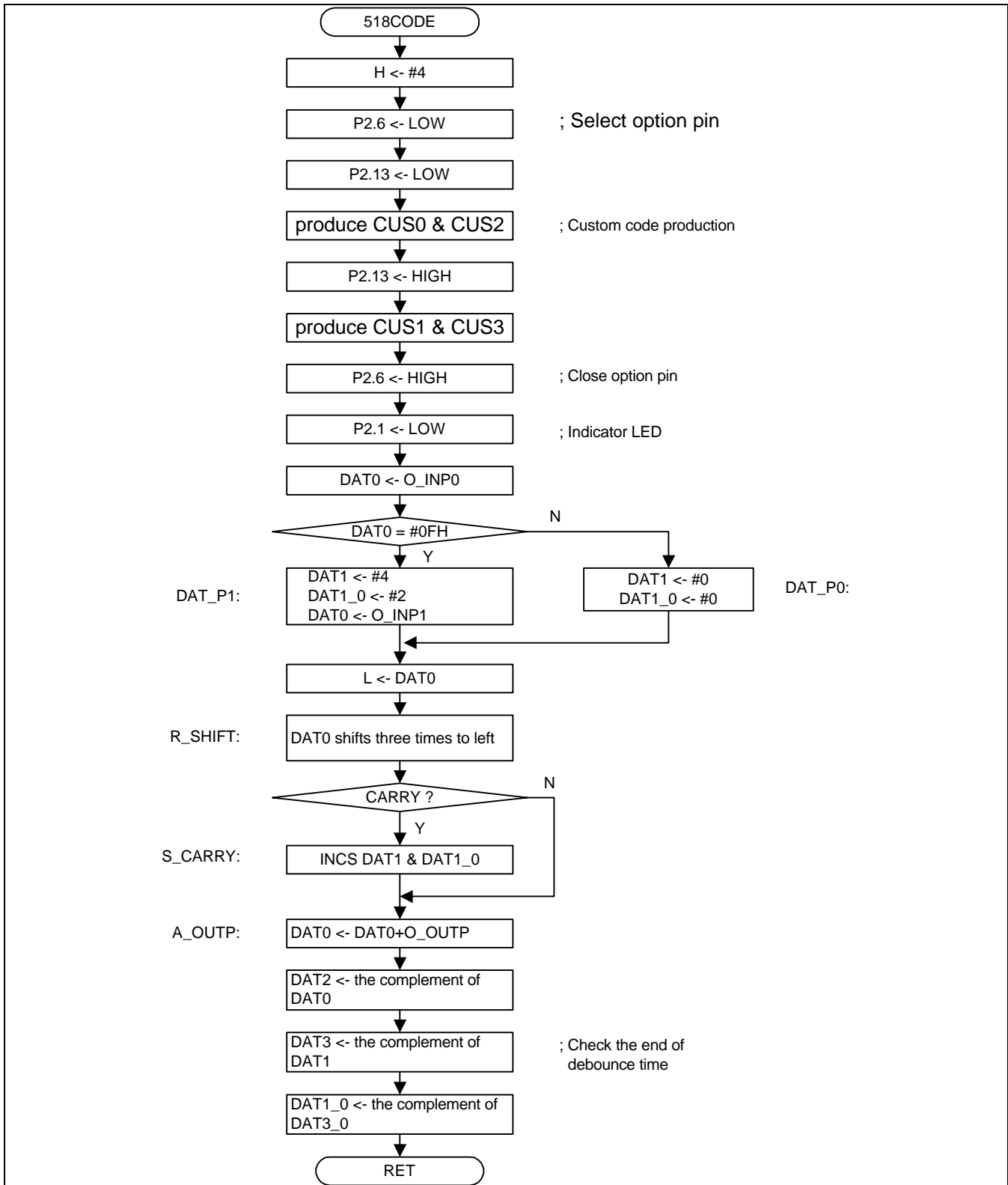
Figure 7-14. Program Flowchart 4

```
.*********************************************
;
            ORG         0300H
            JPL         RESET
.*********************************************
;
;;; select only a key -------------------------------------------

KEYSCAN   MOV         H,#4

;;; product custom code -----------------------------------------
            MOV         L,#6                ;   P2.6 ← low
            CLRB        P2.(L)              ;   check custom code
            MOV         L,#0DH              ;
            CLRB        P2.(L)              ;
            IN          A,P0                ;
            MOV         L,#CUS2             ;   CUS2 is the complement of CUS0
            MOV         @HL,A               ;
            NOTI        A                   ;
            DECS        A                   ;
            MOV         L,#CUS0             ;
            MOV         @HL,A               ;
            MOV         L,#0DH
            SETB        P2.(L)              ;   CUS3 is the complement of CUS1
            IN          A,P0                ;
            MOV         L,#CUS3             ;
            MOV         @HL,A               ;
            ADDS        A,@HL               ;
            NOTI        A                   ;
            DECS        A                   ;
            MOV         L,#CUS1             ;
            MOVZ        @HL,A               ;
            MOV         L,#6                ;   high P2.6
            SETB        P2.(L)
            MOV         L,#1                ;   the indicator LED of a key input
            CLRB        P2.(L)

;;; product data code ------------------------------------------------
            MOV         H,#0
            MOV         L,#O_INP0           ;   DAT0 ← O_INP0
            MOV         A,@HL
            MOV         H,#4
            MOV         L,#DAT0
            MOVZ        @HL,A
            ADDS        A,#0FH              ;   A ← #0fh
            CPNE        @HL,A               ;   does input key exist in port0?
            JP          DAT_P0
```

```
DAT_P1     MOV      L,#DAT1           ;   input key exists in port1
           MOV      @HL+,#04H         ;   DAT1 ← DAT1 + #4
           MOV      L,#DAT1_0
           MOV      @HL+,#02H         ;   DAT1_0 ← DAT1_0 + #2
           MOV      H,#0              ;   DAT0 ← O_INP1
           MOV      L,#O_INP1         ;
           MOV      A,@HL             ;
           MOV      H,#4              ;
           MOV      L,#DAT0           ;
           MOVZ     @HL,A             ;
           JPL      R_SHIFT           ;
DAT_P0     MOV      L,#DAT1           ;   clear DAT1 & DAT1_0
           MOV      @HL+,#0
           MOV      L,#DAT1_0
           MOV      @HL+,#0
           MOV      L,#DAT0
           MOV      H,#4              ;   delay time
           MOV      H,#4              ;
           MOV      H,#4              ;
           MOV      H,#4              ;
           MOV      H,#4              ;
           JPL      R_SHIFT
;
;
.*********************************************
;
           ORG      0400H
           JPL      RESET
.*********************************************
;
R_SHIFT    MOV      A,@HL             ;   DAT0 shifts three times to the left
           ADDS     A,@HL             ;
           MOV      @HL,A             ;
           ADDS     A,@HL             ;
           MOV      @HL,A             ;
           ADDS     A,@HL             ;
           JP       S_CARRY
           JP       N_CARRY

S_CARRY    MOV      L,#DAT1           ;if carry occurs, increase DAT1 & DAT1_0
           XCH      @HL,A             ;
           INCS     A                 ;
           XCH      @HL,A             ;
           MOV      L,#DAT1_0         ;
           XCH      @HL,A             ;
           INCS     A                 ;
           XCH      @HL,A             ;
           JP       A_OUTP
```

```
N_CARRY   MOV       H,#0                  ; if carry doesn't occur, delay time
          MOV       H,#0                  ;
          MOV       H,#0                  ;
          MOV       H,#0                  ;
          MOV       H,#0                  ;
          MOV       H,#0                  ;
          MOV       H,#0                  ;
          MOV       H,#0                  ;

A_OUTP    MOV       H,#0
          MOV       L,#O_OUTP             ;   DAT0 ← DAT0 + O_OUTP
          ADDS      A,@HL                 ;
          MOV       H,#4                  ;
          MOV       L,#DAT0
          MOV       @HL,A                 ;
          NOTI      A
          DECS      A                     ;   DAT2 ← complement of DAT0
          MOV       L,#DAT2
          MOVz      @HL,A
          MOV       L,#DAT1
          MOV       A,@HL
          NOTI      A                     ;   DAT3 ← complement of DAT1
          DECS      A
          MOV       L,#DAT3
          MOVZ      @HL,A
          MOV       L,#DAT1_0
          MOV       A,@HL
          NOTI      A
          DECS      A
          MOV       L,#DAT3_0             ;   DAT3_0 ← complement of DAT 1_0
          MOV       @HL,A
          JPL       TX
```

S3C1840/C1850 SIGNAL TRANSMISSION

Description

This program is for signal transmissions in SAMSUNG standard format. If one key is pressed, two frames are transmitted consecutively. The repeat pulse is transmitted until key-off. The frame interval is 60 ms.
Each frame consists of leader code, custom code, and data code:

— Leader code (high level for 4.5 ms and low level for 4.5 ms)

— 12-bit custom code

— 8-bit data code
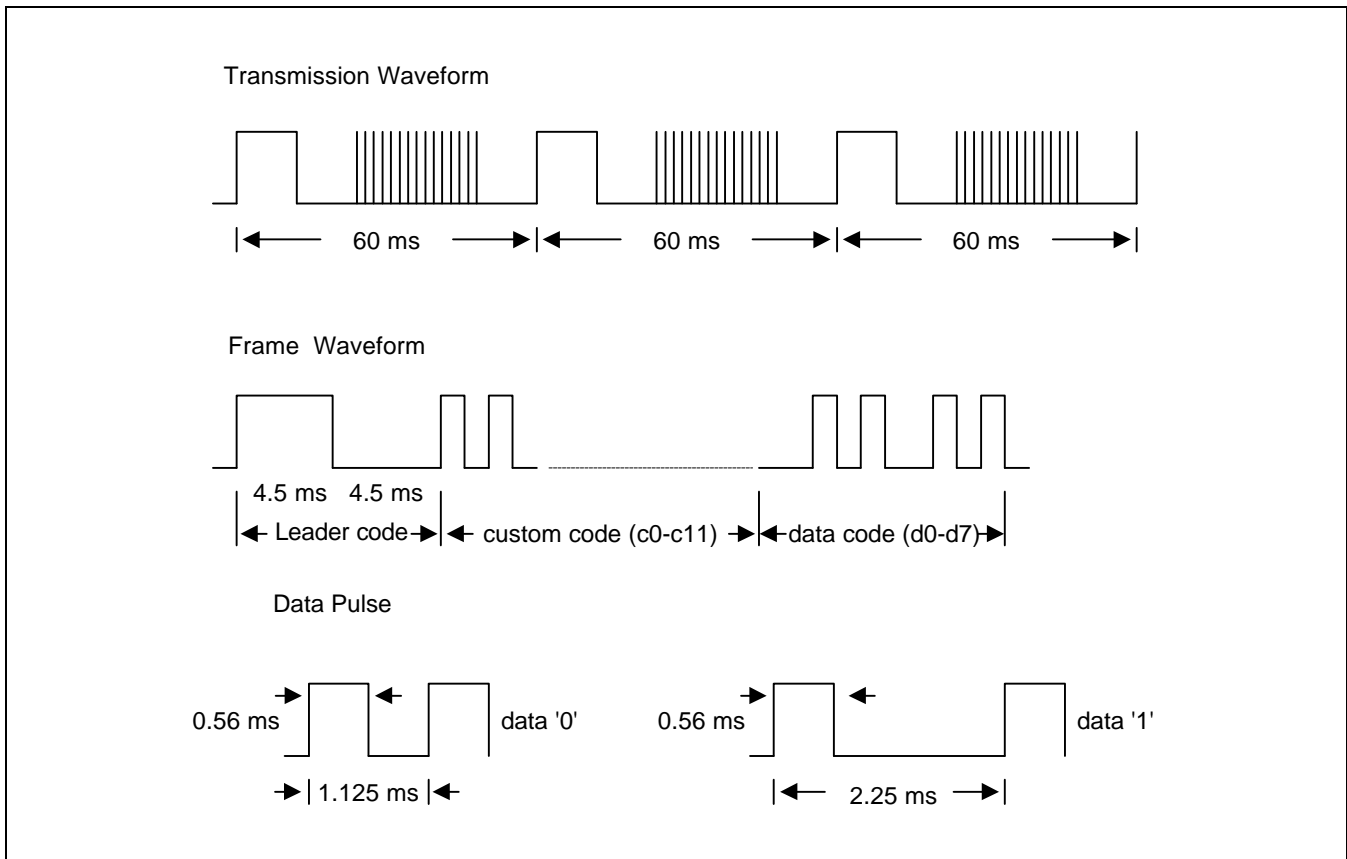
Figure 7-15. Transmission Waveforms

RAM Assignment

This part is the same as for keyscan and code generation.

S3C1840 Program Flowchart (This program is only apply to S3C1840)
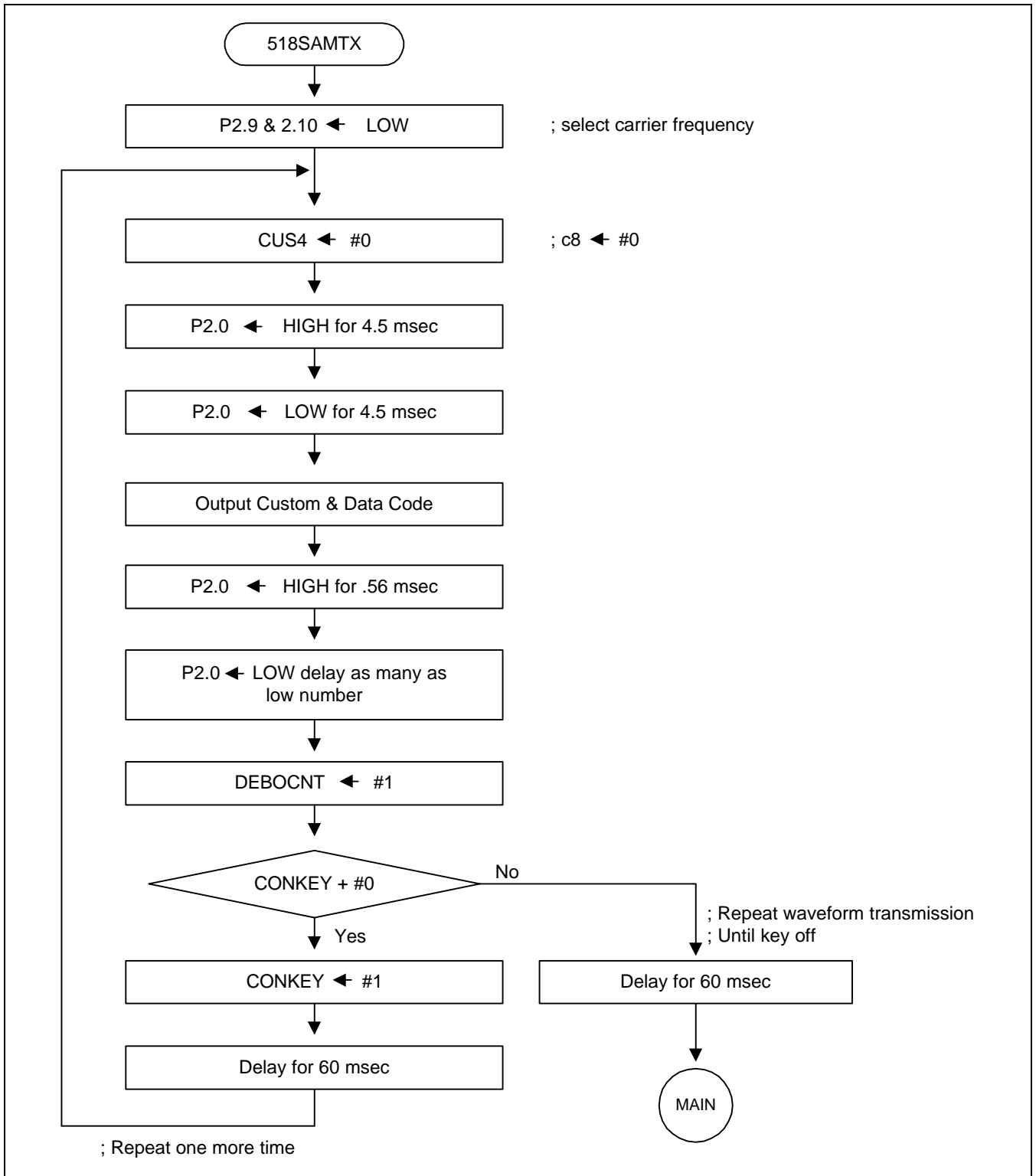
Figure 7-16. S3C1840 Program Flowchart 5

```
;*********************************************
;
            ORG         0500H
            JPL         RESET
;*********************************************
;
TX          MOV         L,#9                    ; select farrier frequency
            CLRB        P2.(L)                  ; 37.9 kHz, 1/3 duty
            MOV         L,#0AH                  ; clear P2.9 & 2.10
            CLRB        P2.(L)


SIGOUT      MOV         L,#CUS4                 ; custom code (c8-c11) ← #0
            MOB         @HL+,#0                 ; if device is KS51910, c8 ← #1
;;; output head pulse -------------------------------------------------

            MOV         L,#0                    ; high for delay time 4.5 msec
            SETB        P2.(L)
            CALLL       D4_5
            MOV         L,#0
            CLRB        P2.(L)                  ; low for delay time 4.5 msec
            CALLL       D4_5D


;;; output custom code (c0-c11) & data code (d0-d7)

            MOV         L,#CUS0                 ; custom code (c0-c3)
            CALLL       DATGEN
            MOV         L,#CUS1                 ; custom code (c4-c7)
            CALLL       DATGEN
            MOV         L,#CUS4                 ; custom code (c8-c11)
            CALLL       DATGEN
            MOV         L,#DAT0                 ; data code (d0-d3)
            CALLL       DATGEN
            MOV         L,#DAT1_0               ; data code (d4-d7)
            CALLL       DATGEN
            MOV         L,#1
            DECS        L
            JP          .-1
            MOV         L,#0                    ; EOB (end of bit)
            SETB        P2.(L)                  ; high for .56msec
            CALLL       D_560F
            MOV         L,#0
            CLRB        P2.(L)
            JPL         LOWCHEK
```

SAMSUNG
ELECTRONICS

```
;*********************************************
;
            ORG         0600H
            JPL         RESET
;*********************************************
;
;;; check low code of custom code & data code -------------------------------
LOWCHEK   MOV         L,#CUS0                        ;  custom code (c0-c3)
            CALL        LCHEK
            MOV         L,#CUS1                        ;  custom code (c4-c7)
            CALL        LCHEK
            MOV         L,#CUS4                        ;  custom code (c8-c11)
            CALL        LCHEK
            MOV         L,#DAT0                        ;  data code (d0-d3)
            CALL        LCHEK
            MOV         L,#DAT1_01                     ;  the maximum value of upper bit is #3
            MOV         A,L                            ;  data code (d4-d7)
            CALL        LCHEK_1                        ;  check from the second bit


;== notice =============================================================
; If value of DAT1_0 is greater than #3, programmer must change instruction
; CALLLCHEK_1 to other instruction such as CALLCHECK_2 or CALL
; LCHEK. And you must check the fram interval (= 60 msec)
;======================================================================

;;; re-setting debounce count to #1-------------------------------------
SETDBT    MOV         H,#0
            MOV         L,#DEBOCNT                     ;  DEBOCNT ← #1
            MOV         @HL+,#1


;--------------------------------------------------------------------------
;;; If conkey flag isn't '0', transmit repeat pulse
;;; otherwise, after setting, transmit again (two frames)
;--------------------------------------------------------------------------

CONCHEK   MOV         H,#0
            MOV         L,#CONKEY                      ;  CONKEY == #0?
            CPNZ        @HL                            ;  If CONKEY is #0, CONKEY ← #1
            JP          LJ_MAIN                        ;  transmit frame again
            MOV         @HL+,#1
            CALLL       D4_5D                          ;  time is 60 msec per frame
            CALLL       D2_25
            CALLL       D1_125
            MOV         L,#0CH
            MOV         H,#4
            MOV         H,#4
            DECS        L
            JP          .-3
            JPL         SIGOUT
```

```
;;; output repeat pulse ------------------------------------------------------
LJ_MAIN    CALL      D1_125
           JPL       MAIN
;;; output delay time as many as low numbers ----------------------------

LCHEK      MOV       A,L
           CPBT      @HL,3                    ;  if @hl.3 is low, call d2_25d.
           JP        LCHEK_2
           CALLL     D2_25D
LCHEK_2    MOV       L,A
           CPBT      @HL.2                    ;  if @hl.2 is low, call d2_25d.
           JP        LCHEK_1
           CALLL     D2_25D
LCHEK_1    MOV       L,A
           CPBT      @HL.1                    ;  if @hl.1 is low, call d2_25d.
           JP        LCHEK_0
           CALLL     D2_25D
LCHEK_0    MOV       L,A
           CPBT      @HL.0                    ;  if @hl. 0 is low, call d2_25d.
           JP        LCHEK_R
           CALLL     D2_25D
LCHEK_R RET

;
;
;
;
;
;
.*******************************************
;
           ORG       0700H
           JPL       RESET
.*******************************************
;
;; custom code & data code generation -------------------------------------
DATGEN     MOV       A,L
           CALL      D_560                    ;  high for .56 msec
           CPBT      @HL.0                    ;  if @hl.0 is high, low for 2.25 msec.
           CALL      D2_25                    ;  otherwise, low for 1.125 msec.
           CALL      D1_125
```

```
        CALL        D_560               ;   high for .56 msec
        CPBT        @HL.1               ;   if @hl.1 is high, low for 2.25 msec.
        CALL        D2_25               ;   otherwise, low for 1.125 msec.
        CALL        D1_125
        CALL        D_560               ;   high for .56 msec
        CPBT        @HL.2               ;   if @hl.2 is high, low for 2.25 msec.
        CALL        D2_25               ;   otherwise, low for 1.125 msec.
        CALL        D1_125
        CALL        D_560               ;   high for .56 msec
        CPBT        @HL.3               ;   if @hl.3 is high, low for 2.25 msec.
        CALL        D2_25               ;   otherwise, low for 1.125 msec.
        CALL        D1_125D
        RET
```

;;; delay time subroutine by programming ----------------------------------

```
D_560       MOV         L,#0
            SETB        P2,(L)
;
            MOV         L,#0CH
            MOV         H,#4
            DECS        L
            JP          .-2
            MOV         H,#4
;
            MOV         L,#0
            CLRB        P2.(L)
            MOV         L,A
            RET
D4_5D       MOV         L,#02H              ;   delay time 4.5 msec
            JP          .+2
D4_5        MOV         L,#06H
            DECS        L
            JP          -1
            MOV         L,#05H
            CLR         A
            ADDS        A,#0BH
            MOV         H,#4
D_A         DECS        A
            JP          .-2
            DECS        L
            JP          .-6
```

```
D2_25D      MOV        L,#0EH
            JP         .+2
D2_25       MOV        L,#0FH
            MOV        H,#4
            DECS       L
            JP         .-2
D1_125      MOV        L,#0AH
            JP         .+6
D1_125D     MOV        L,#08H
            JP         .+4
D_560F      MOV        L,#0BH                    ;   delay time .56 msec (for EOB)
            MOV        H,#4
            MOV        H,#4
            DECS       L
            JP         .-2
            RET
;
;
            org        0800h
            jpl        reset
            org        0900h
            jpl        reset
            org        oaooh
            jpl        reset
            org        obooh
            jpl        reset
            org        ocooh
            jpl        reset
            org        odooh
            jpl        reset
            org        oeooh
            jpl        reset
;

;****************** The END of S3C1840 SAMSUNG FORMAT TX. *************************
```